

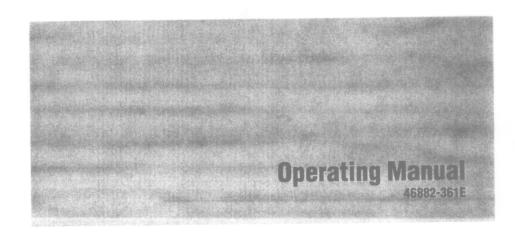
Instruments



CDMA INTERFERER MULTISOURCE GENERATOR

2026Q





CDMA INTERFERER MULTISOURCE GENERATOR

2026Q

10 kHz to 2.4 GHz

This manual applies to instruments with software issues of 2.01 and higher.

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About this manual

This manual explains how to use the 2026Q CDMA Interferer MultiSource Generator.

Intended audience

Persons engaged on work relating to equipment who have a need for accurately generated signals in the VHF and UHF spectrum.

It is assumed that the reader will be familiar with telecommunication terms used in modern communication systems.

Structure

Chapter 1 Main features and performance data
 Chapter 2 Installation details
 Chapter 3 Local operation
 Chapter 4 Source configuration, coupling and selected applications
 Chapter 5 GPIB operation with keywords and sample programs
 Chapter 6 Brief technical description
 Chapter 7 Instructions for doing acceptance testing

Document conventions

The following conventions apply throughout this manual:-

RF OUTPUT Titles marked on the instrument panel are shown in capital letters

[TRIGGER] Key titles are as shown on the key-caps in square brackets.

[Disable] Soft key titles are shown in italics in square brackets e.g. [Disable] means

the soft key adjacent to the Disable title box at the side of the menu.

RF Level Messages on the display are shown in italic letters.

Associated publications

There is one other publication covering specific aspects of this equipment:-

Service Manual (46880-077H) Covers maintenance and repair of the equipment.

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PREFACE

PATENT PROTECTION

The 2026Q CDMA Interferer Multisource Generator is protected by the following patents:

EP 0322139

GB 2214012

US 4870384

EP 0125790

GB 2140232

US 4609881

Precautions

WARNING

CAUTION

Note

These terms have specific meanings in this manual:

WARNING

information to prevent personal injury.

CAUTION

information to prevent damage to the equipment.

Note

important general information.

Hazard symbols

The meaning of hazard symbols appearing on the equipment is as follows:

Symbol

Description



General hazard

Toxic hazard

General conditions of use

This product is designed and tested to comply with the requirements of EN61010-1/IEC1010-1 'Safety requirements for electrical equipment for measurement, control and laboratory use', for Class 1 portable equipment and is for use in a pollution degree 2 environment. The equipment is designed to operate from an installation category 2 supply.

Equipment should be protected from the ingress of liquids and precipitation such as rain, snow, etc. When moving the instrument from a cold to a hot environment, it is important to allow the temperature of the instrument to stabilise before it is connected to the supply to avoid condensation forming. The instrument must only be operated within the environmental conditions specified in Chapter 1 'Performance data' in the Operating/Instruction Manual otherwise the protection provided by the equipment may be impaired.

This product is not approved for use in hazardous atmospheres or medical applications. If the equipment is to be used in a safety-related application, e.g. avionics or military applications, the suitability of the product must be assessed and approved for use by a competent person.

WARNING



Electrical hazards (AC supply voltage)

This equipment conforms with IEC Safety Class I, meaning that it is provided with a protective grounding lead. To maintain this protection the supply lead must always be connected to the source of supply via a socket with a grounded contact.

Be aware that the supply filter contains capacitors that may remain charged after the equipment is disconnected from the supply. Although the stored energy is within the approved safety requirements, a slight shock may be felt if the plug pins are touched immediately after removal.

Do not remove covers, no user serviceable parts inside. See list of Marconi Instruments Ltd International Service Centres at rear of manual.

Fuses

Note that the internal supply fuse is in series with the live conductor of the supply lead. If connection is made to a 2-pin unpolarized supply socket, it is possible for the fuse to become transposed to the neutral conductor, in which case, parts of the equipment could remain at supply potential even after the fuse has ruptured.

WARNING



Fire hazard

Make sure that only fuses of the correct rating and type are used for replacement.

If an integrally fused plug is used on the supply lead, ensure that the fuse rating is commensurate with the with current requirements of this equipment. See under 'Performance Data' in Chapter 1 for power requirements.

WARNING



Toxic hazards

Some of the components used in this equipment may include resins and other materials which give off toxic furnes if incinerated. Take appropriate precautions, therefore, in the disposal of these items.

WARNING



Beryllia

Beryllia (beryllium oxide) is used in the construction of some of the components in this equipment. This material, if incorrectly handled, could cause a danger to health - refer to the Maintenance part of the Service Manual for safe handling precautions.

WARNING



Beryllium copper

Some mechanical components within this instrument are manufactured from beryllium copper. This is an alloy with a beryllium content of approximately 5%. It represents no risk in normal use.

The material should not be machined, welded or subjected to any process where heat is involved.

It must be disposed of as "special waste".

It must NOT be disposed of by incineration.

WARNING



Heavy instrument

The weight of this instrument exceeds the 18 kg (40 lb) guideline for manual handling by a single person. To avoid the risk of injury, an assessment should be carried out prior to handling which takes account of the load, workplace environment and individual capability, in accordance with European Directive 90/269/EEC and associated National Regulations.

WARNING



Tilt facility

When the instrument is in the tilt position, it is advisable, for stability reasons, not to stack other instruments on top of it.

CAUTION

Static sensitive components

This equipment contains static sensitive components which may be damaged by handling - refer to the Maintenance part of the Service Manual for handling precautions.

Précautions

WARNING

CAUTION

Note

Les termes suivants ont, dans ce manuel, des significations particulières:

WARNING

contient des informations pour éviter toute blessure au personnel.

CAUTION

contient des informations pour éviter les dommages aux équipements.

Note

contient d'importantes informations d'ordre général.

Symboles signalant un risque

La signification des symboles liés à cet équipement est la suivante:

Symbole

Nature du risque



Risques généraux

Danger produits toxiques

Conditions générales d'utilisation

Ce produit a été conçu et testé pour être conforme aux exigences des normes EN61010-1/CEI1010-1 "Règles de sécurité pour appareils électriques de mesurage, de régulation et de laboratoire", pour des équipements Classe I portables et pour une utilisation dans un environnement de pollution de niveau 2. Cet équipement est conçu pour fonctionner à partir d'une alimentation de catégorie II.

Cet équipement doit être protégé de l'introduction de liquides ainsi que des précipitations d'eau, de neige, etc... Lorsqu'on transporte cet équipement d'un environnement chaud vers un environnement froid, il est important de laisser l'équipement se stabiliser en température avant de le connecter à une alimentation afin d'éviter toute formation de condensation. L'doit être utilisé uniquement dans les conditions d'environnement spécifiées dans "Performance data" dans le chapitre 1 du manuel d'utilisation.

Ce produit n'est pas garanti pour fonctionner dans des atmosphères dangereuses ou pour un usage médical. Si l'équipement doit être utilisé pour des applications en relation avec la sécurité, par exemple des applications militaires ou aéronautiques, la compatibilité du produit doit être établie et approuvée par une personne compétente.

WARNING



Securite electrique (tension d'alimentation alternative)

Cet appareil est protégé conformément à la norme CEI de sécurité class 1, c'est-à-dire que sa prise secteur comporte un fil de protection à la terre. Pour maintenir cette protection, le cable d'alimentation doit toujours être branché à la source d'alimentation par l'intermédiaire d'une prise comportant une borne terre.

Notez que les filtres d'alimentation contiennent des condensateurs qui peuvent encore être chargés lorsque l'appareil est débranché. Bien que l'énergie contenue soit conforme aux exigences de sécurité, il est possible de ressentir un léger choc si l'on touche les bornes sitôt après débranchement.

Ne pas enlever les capots, aucune pièce réparable ne se trouve à l'intérieur. Contacter un des Centres de Maintenance Internationaux de Marconi Instruments Ltd dans la liste jointe à la fin du manuel.

Fusibles

Notez que le fusible d'alimentation interne est en série avec la phase du câble d'alimentation. Si la prise d'alimentation comporte deux bornes non potarisées, il est possible de connecter le fusible au neutre. Dans ce cas, certaines parties de l'appareil peuvent rester à un certain potentiel même après coupure du fusible.

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WARNING



Feuergefahr

Es dürfen nur Ersatzsicherungen vom gleichen Typ mit den korrekten Spezifikationen entsprechend der Stromaufnahme des Gerätes verwendet werden. Siehe hierzu die Leistungsdaten (Performance Data) in Kapitel 1.

WARNING



Warnung vor giftigen Substanzen

In einigen Bauelementen dieses Geräts können Epoxyharze oder andere Materialien enthalten sein, die im Brandfall giftige Gase erzeugen. Bei der Entsorgung müssen deshalb entsprechende Vorsichtsmaßnahmen getroffen werden.

WARNING



Beryllium Oxid

Beryllium Oxid wird in einigen Bauelementen verwendet.

Bei inkorrekter Handhabung kann dieses Material Gesundheitsschäden verursachen. Siehe hierzu die Hinweise zur Handhabung im Service-Handbuch.

WARNING



Beryllium Kupfer

In diesem Gerät sind einige mechanische Komponenten aus Berylium Kupfer gefertigt. Dies ist eine Verbindung welche aus einem Berylliumanteil von ca. 5 % besteht. Bei normaler Verwendung besteht kein Gesundheitsrisiko.

Das Metall darf nicht bearbeitet, geschweißt oder sonstiger Wärmebehandlung ausgesetzt werden.

Es muß als Sondermüll entsorgt werden.

Es darf nicht durch Verbrennung entsorgt werden.

WARNING



Schweres Gerät

Das Gewicht dieses Geräts liegt über der 18 kg (40 lb) Grenze für Transport durch eine einzelne Person. Zur Vermeidung von Verletzungen sollten vor einem Transport die Arbeitsumgebung und die persönlichen Möglichkeiten im Verhältnis zur Last abgewogen werden, wie in der EU-Regelung 90/269/EEC und nationalen Normen beschrieben.

WARNING



Schrägstellung

Bei Schrägstellung des Geräts sollten aus Stabilitätsgründen keine anderen Geräte darauf gestellt werden.

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Precauzioni

WARNING

CAUTION

Note

Questi termini vengono utilizzati in questo manuale con significati specifici:

WARNING

riportano informazioni atte ad evitare possibili pericoli alla persona.

CAUTION

riportano informazioni per evitare possibili pericoli all'apparecchiatura.

Note

riportano importanti informazioni di carattere generale.

Simboli di pericolo

Significato dei simboli di pericolo utilizzati nell'apparato:

Simbolo

Tipo di pericolo



Pericolo generico

Pericolo sostanze tossiche

Condizioni generali d'uso.

Questo prodotto è stato progettato e collaudato per rispondere ai requisiti della direttiva EN61010-1/IEC1010-1 'Safety requirements for electrical equipment for measurement, control and laboratory use' per apparati di classe I portatili e per l'uso in un ambiente inquinato di grado 2. L'apparato è stato progettato per essere alimentato da un alimentatore di categoria II.

Lo strumento deve essere protetto dal possibile ingresso di liquidi quali, ad es., acqua, pioggia, neve, ecc. Qualora lo strumento venga portato da un ambiente freddo ad uno caldo, è importante lasciare che la temperatura all'interno dello strumento si stabilizzi prima di alimentarlo per evitare formazione di condense. Lo strumento deve essere utilizzato esclusivamente nelle condizioni ambientali descritte nel capitolo 1 'Performance Data' del manuale operativo.

Questo prodotto non è stato approvato per essere usato in ambienti pericolosi o applicazioni medicali. Se lo strumento deve essere usato per applicazioni particolari collegate alla sicurezza (per esempio applicazioni militari o avioniche),occorre che una persona o un istituto competente ne certifichi l'uso.

WARNING



Pericoli da elettricità (alimentazione c.a.)

Quest' apparato è provvisto del collegamento di protezione di terra e rispetta le norme di sicurezza IEC, classe 1. Per mantenere questa protezione è necessario che il cavo, la spina e la presa d'alimentazione siano tutti provvisti di terra.

Il circuito d'alimentazione contiene dei filtri i cui condensatori possono restare carichi anche dopo aver rimosso l'alimentazione. Sebbene l'energia immagazzinata è entro i limiti di sicurezza, purtuttavia una leggera scossa può essere avvertita toccando i capi della spina subito dopo averla rimossa.

Non rimuovere i coperchi, utilizzare solo parti di scorta originali. Vedi elenco internazionale dei Centri di Assistenza in fondo al manuale.

Fusibili

Notare che un fusibile è posto sul filo caldo del cavo di alimentazione. Qualora l'alimentazione avvenga tramite due poli non polarizzati, è possibile che il fusibile vada a protezione del neutro per cui anche in caso di una sua rottura, l'apparato potrebbe restare sotto tensione.

WARNING



Pericolo d'incendio

Assicurarsi che, in caso di sostituzione, vengano utilizzati solo fusibili della portata e del tipo prescritto.

Se viene usata una spina con fusibili, assicurarsì che questi siano di portata adeguata coi requisiti di alimentazione richiesti dallo strumento. Tali requisiti sono riportati nel cap. I "Performance data"

WARNING



Pericolo sostanze tossiche

Alcuni dei componenti usati in questo strumento possono contenere resine o altri materiali che, se bruciati, possono emettere fumi tossici. Prendere quindi le opportune precauzioni nell'uso di tali parti.

WARNING



Berillio

Berillio (ossido di berillio) è utilizzato nella costruzione di alcuni componenti di quest'apparato.

Questo materiale, se maneggiato non correttamente, può causare danni alla salute. Far riferimento ai capitoli di manutenzione del Manuale di Servizio per le precauzioni richieste.

WARNING



Rame berillio

Alcuni componenti meccanici in questo strumento sono realizzati in rame berillio. Si tratta di una lega con contenuto di berillio di circa il 5%, che non presenta alcun rischio in usi normali.

Questo materiale non deve essere lavorato, saldato o subire qualsiasi processo che coinvolge alte

Deve essere eliminato come "rifiuto speciale". Non deve essere eliminato tramite "inceneritore".

WARNING



Strumento pesante

Il peso di questo strumento supera i 18 kg (40 lb) raccomandati come limite per il trasporto manuale da parte di singola persona. Per evitare rischi di danni fisici è bene quindi considerare il carico complessivo, le condizioni del trasporto e le capacità individuali in accordo con la direttiva comunitaria 90/269/EEC e con eventuali regolamenti locali.

WARNING



Posizionamento inclinato

Quando lo strumento è in posizione inclinata è raccomandato, per motivi di stabilità, non sovrapporre altri strumenti.

Precauciones

WARNING

CAUTION

Note

Estos términos tienen significados específicos en este manual:

WARNING

contienen información referente a prevención de daños personales.

CAUTION

contienen información referente a prevención de daños en equipos.

Note

contienen información general importante.

Símbolos de peligro

Los significados de los símbolos de peligro que aparecen en los equipos son los siguientes:

Símbolo

Naturaleza del peligro



Peligro general

Aviso de toxicidad

Condiciones generales de uso

Este producto ha sido diseñado y probado para cumplir los requerimientos de la normativa EN61010-1/IEC1010-1 "Requerimientos de la normativa para equipos eléctricos de medida, control y uso en laboratorio", para equipos clase II portátiles y para uso en un ambiente con un grado de contaminación 2. El equipo ha sido diseñado para funcionar sobre una instalación de alimentación de categorías II.

Debe protegerse el equipo de la entrada de líquidos y precipitaciones como nieve, lluvia, etc. Cuando se traslada el equipo de entorno frío a un entorno caliente, es importante aguardar la estabilización el equipo para evitar la condensación. Sólo debe utilizarse el aparato en las condiciones ambientales especificadas en el capítulo 1 "Especificaciones" o "Performance Data" del Manual de Instrucciones/Manual de Operación/Funcionamiento.

Este producto no ha sido aprobado para su utilización en entornos peligrosos o en aplicaciones médicas. Si se va a utilizar el equipo en una aplicación con implicaciones en cuanto a seguridad, como por ejemplo aplicaciones de aviónica o militares, es preciso que un experto competente en materia de seguridad apruebe su uso.

WARNING



Nivel peligroso de electricidad (tensión de red)

Este equipo cumple las normas IEC Seguridad Clase 1, lo que significa que va provisto de un cable de protección de masa. Para mantener esta protección, el cable de alimentación de red debe de conectarse siempre a una clavija con terminal de masa.

Tenga en cuenta que el filtro de red contiene condensadores que pueden almacenar carga una vez desconectado el equipo. Aunque la energía almacenada está dentro de los requisitos de seguridad, pudiera sentirse una ligera descarga al tocar la clavija de alimentación inmediatamente después de su desconexión de red.

No quitar las tapas, en el interior no existen piezas reemplazables por el usuario. Vea la lista de Centros de Servicios Internacionales en la parte trasera del manual.

Fusibles

Se hace notar que el fusible de alimentación interno está enserie con el activo del cable de alimentación a red. Si la clavija de alimentación de red cuenta con sólo dos terminales sin polaridad, el fusible puede pasar a estar en serie con el neutro, en cuyo caso existen partes del equipo que permanecerían a tensión de red incluso después de que el fusible haya fundido.

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WARNING



Peligro de incendio

Asegúrese de utilizar sólo fusibles del tipo y valores especificados como recuesto.

Si se utiliza una clavija con fusible incorporado, asegúrese de que los valores del fusible corresponden a los requeridos por el equipo. Ver sección de especificaciones del capítulo 1 para comprobar los requisitos de alimentación.

WARNING



Aviso de toxicidad

Alguno de los componentes utilizados en este equipo pudieran incluir resinas u otro tipo de materiales que al arder produjeran sustancias tóxicas, Por tanto, tome las debidas precauciones en la manipulación de esas piezas.

WARNING



Berilio

Berilio (óxido de berilio) Este material es utilizado en la fabricación de alguno de los componentes de este equipo.

Si se manipulase incorrectamente podría causar daños a la salud - En la sección de mantenimiento y reparación encontrará normas de manejo de seguridad.

WARNING



Berilio-cobre

Algunos componentes mecánicos contenidos en este instrumento incorporan berilio-cobre en su proceso de fabricación. Se trata de una aleación con un contenido aproximado de berilio del 5%, lo que no representa ningún riesgo durante su uso normal.

El material no debe ser manipulado, soldado, ni sometido a ningún proceso que implique la aplicación de calor.

Para su eliminación debe tratarse como un "residuo especial". El material NO DEBE eliminarse mediante incineración.

WARNING



Instrumento pesado

El peso de este instrumento excede de los 18 Kg (40 lb), lo que debe tenerse en cuenta si va ser transportado manualmente por una sola persona. Para evitar el riesgo de lesiones, antes de mover el equipo deberá evaluar la carga, el entorno de trabajo y la propia capacidad, de acuerdo con la Directiva Europea 90/269/EEC y el Reglamento Nacional Asociado.

WARNING



Tener en cuenta con el equipo Inclinado

Si utiliza el equipo en posición inclinada, se recomienda, por razones de estabilidad, no apilar otros equipos encima de él.

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Chapter 1 GENERAL INFORMATION

Contents Introduction 1-2 Main features 1-3 Operation 1-3 Display 1-3 Frequency selection 1-3 Output 1-3 Modulation 1-3 Incrementing 1-4 Frequency sweep 1-4 Memory 1-4 Programming 1-4 Calibration data 1-5 Spectral purity 1-5 Calibration 1-5

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Fig 1-1	2026Q simplified block diagram

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Introduction

The 2026Q CDMA Interferer Multisource Generator is a purpose-built instrument for testing CDMA hand-set and base station equipment. It features two synthesized RF signal sources with both independent and combined RF outputs. An RF input is provided which enables the output from a radio test set (or external RF signal generator) to be combined with the two internal signal sources. The combined RF output provides a path to and from the radio under test and an appropriate CDMA radio test set. Each signal source covers the frequency range 10 kHz to 2.4 MHz, whilst the combined path covers the range 800 MHz to 2.0 GHz.

It is designed to produce a fully calibrated combined RF output containing any combination of internally generated interference signals from its two RF sources, together with a calibrated signal path for a radio test set transmit output. A return path from the transceiver back to the radio test set receiver input is also provided through the instrument (see Fig. 1-1 below).

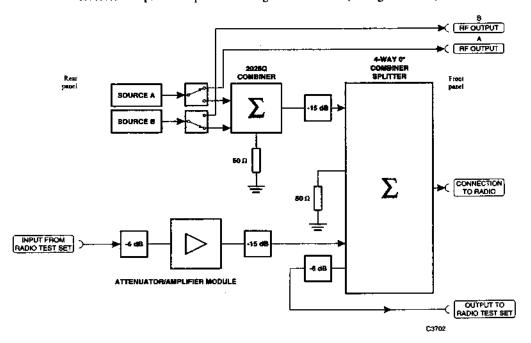


Fig 1-1 2026Q simplified block diagram

The instrument provides frequency hand-offs without RF switching which allows a CDMA receiver to be tested for sensitivity in the presence of dual tone interference and in accordance with IS95A. This is specifically aimed at testing the receiver's ability to successfully hand off to other radio channels and between cellular and PCS bands. The interfering signals are combined without the need for any RF switching mechanism that would otherwise affect the test result.

The 2026Q is configured to ensure high levels of isolation between each of the transmit and receive paths between the radio test set, the interfering signal sources and the transceiver under test.

Path loss test data is supplied with the instrument for the frequency bands 865 to 895 MHz and 1750 to 1990 MHz. Drift influences within these bands is minimal ensuring a level accuracy of better than ±0.25 dB. The frequency response across each of these bands is flat to within ±0.1 dB, thus minimising the need for additional system calibration.

The 2026Q used as a multisource signal generator offers as standard two signal sources in one instrument, each of which is a fully functional modulated signal generator. Each source can either be routed to its own individual RF output or switched to the input of an RF combiner

network before being fed to a separate combined RF output. Both sources cover the full frequency range of 10 kHz to 2.4 GHz with an output power of between -137 and +24 dBm.

Each signal source can be controlled independently in frequency and level, and each has its own amplitude, frequency, phase, FSK and pulse modulation capability. All parameters can be entered from the front panel keyboard and a rotary control can be used to adjust most settings.

The instrument is provided with built-in tests specifically for use with two or three combined sources such as for amplifier and receiver intermodulation tests and receiver selectivity tests. The sources may be locked together, offset in frequency (additionally with a harmonic or sub-harmonic relationship) as well as level.

Microprocessor control ensures that the instrument is flexible and easy to use and allows programming by the General Purpose Interface Bus (GPIB) or RS-232 serial bus. The GPIB is designed to IEEE Standard 488.2 and is a means of sending commands to an instrument, via a data bus, from a remote controller or personal computer. The instrument can therefore be used manually or as part of a fully automated test system.

Main features

Operation

Selection of parameters on the screen may involve one or more of the numeric, hard or menu selection keys or the rotary control knob. Parameters may be set to specific values by numeric key entry, while values may be varied in steps of any size using the $\{ \frac{1}{2} \} [\hat{\mathbf{u}}]$ keys or altered by moving the control knob, set to a particular sensitivity.

Display

The display is a dot matrix liquid crystal panel, with backlighting. Display contrast and brightness may be varied to accommodate differing lighting conditions and the setting saved in memory.

Frequency selection

Carrier frequency is either selected directly via the keyboard or remotely via the interfaces. Frequency resolution is 1 Hz across the complete frequency range of 10 kHz to 2.4 GHz. A series of carrier frequencies can be stored in non-volatile memory for recall when required.

Output

Peak RF output levels from each signal source of up to +24 dBm can be set up to 1.2 GHz (+20 dBm up to 2.4 GHz) by direct keyboard entry with a resolution of 0.1 dB down to -137 dBm. The peak output level from the combiner is -13 dBm, 800 MHz to 2 GHz. RF ON/OFF keys are provided to disable each individual output as well as the combined output.

A choice of level units is available to the user and provision is made for the conversion of units (for example, dBm to μV) by a simple keypress.

An electronic trip protects each independent signal source output against reverse power of up to 50 W. This prevents damage to output circuits when RF transmitter or DC power supply is accidentally applied to an RF OUTPUT connector.

To facilitate testing of receiver squelch systems, an attenuator hold function allows control of the RF output without introducing RF level drop-outs from the step attenuator.

Modulation

Comprehensive amplitude, frequency and phase modulations are available. Pulse modulation can be applied to the carrier from an external pulse source. The instrument also produces FSK modulated outputs. An internal modulation oscillator is provided, having a frequency range of 0.01 Hz to 20 kHz. Sine, triangle and square waveforms are available. The oscillator is capable of generating one or two modulation tones simultaneously in one modulation channel. A BNC connector on the front panel offers access to the internal LP signal as well as providing an input

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for external modulation signals to be combined with the internal signals. These sources can be combined to give a number of modulation modes. The pulse modulation can be used in combination with the other forms of modulation.

The frequency modulation range provides a 1 dB bandwidth of typically 100 kHz and provides FM deviation of 0 to 100 kHz. AC or DC coupled FM can be selected. Phase modulation is provided with a 3 dB bandwidth of 10 kHz and deviation range of 0 to 10 radians.

Amplitude modulation with a 1 dB bandwidth of typically 30 kHz and with modulation depths of up to 99.9% is available with a resolution of 0.1%. Pulse modulation is available as standard with typical rise and fall times of less than 10 µs and 40 dB on/off ratio.

The instrument also accepts one or two logic level inputs to produce a 2-level or 4-level FSK modulated output. The required FM deviation is set by keyboard entry.

The external input voltage required for specified modulation is 1 V RMS (1.414 V peak). To accommodate other signal levels, Automatic Level Control (ALC) can be selected which provides correctly calibrated modulation for inputs between 0.75 and 1.25 V RMS.

A modulation ON/OFF soft key simplifies the testing of signal to noise ratio.

Incrementing

All major parameters can be incremented or decremented in step sizes entered via keyboard entry or remotely. If no step size is entered for a parameter, the steps are preset to 1 kHz for carrier frequency, 1 kHz for modulation oscillator, 1 kHz for FM deviation, 0.1% for AM depth, 0.01 rad for 1 dB for output level.

In addition, the rotary control knob can be used to vary the parameter with the sensitivity of the knob being changed by means of the $[\times 10]$ and [+10] keys.

Control knob operation can be assigned for the adjustment of one parameter, while another parameter is adjusted by the increment and decrement keys. By this means two parameters e.g. carrier frequency and RF level, can be simultaneously adjusted.

Frequency sweep

The sweep capability of the instrument allows comprehensive testing of systems. Four parameters are used to specify sweep; start, stop, step size and time per step, all of which may be specified by the user. The sweep can be paused at any time and the frequency and level manually altered. During the sweep the RF level can be altered using the rotary control. Sweep triggering can be single shot or continuous and can be initiated directly or on the detection of a trigger. The triggering signal may either be programmed or from a TTL signal applied to the rear panel TRIGGER 1 input. When frequency coupling is enabled, the coupled sources will track with the swept source.

Memory

The instrument provides both non-volatile and volatile memory for storing instrument settings. The non-volatile memory provides 100 full instrument settings and 100 settings of carrier frequency only. The volatile memory (RAM) also provides 100 instrument settings. Any one of the non-volatile instrument settings can be selected as the power-up setting for the instrument.

Software protection

To prevent accidental interference with the contents of internal memories, internal data is protected.

Programming

A GPIB interface is fitted so that all functions are controllable via the interface bus which is designed to the IEEE Standard 488.2. The instrument can function both as talker and listener. The instrument also has an RS-232 interface which uses the common GPIB command set to

control the instrument and also allow new software upgrades or applications to be downloaded into the instrument.

Calibration data

All alignment data is digitally derived. Realignment can be undertaken, without removing covers, by protected front panel functions or via the GPIB interface.

Spectral purity

With an SSB phase noise performance of typically -121 dBc/Hz at 20 kHz offset from a 1 GHz carrier, these instruments can be used for both in-channel and adjacent channel receiver measurements. Harmonically related signals and non-harmonics are typically better than -30 dBc and -60 dBc respectively.

Calibration

This instrument has a recommended two year calibration interval after which it should be returned for recalibration (for addresses refer to 'Addresses' section at end of manual).

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Performance data

Carrier frequency

Individual outputs:

10 kHz to 2.4 GHz with a resolution of 1 Hz.

Combined output:

800 MHz to 2.0 GHz.

Accuracy:

As frequency standard.

RF output

Range

Individual outputs:

-137 dBm to +24 dBm (output power above +20 dBm is uncalibrated for

frequencies above 1.2 GHz).

Combiner output:

-137 dBm to -13 dBm.

Maximum output is reduced by 5 dB when pulse modulation is selected and/or by up to 6 dB when AM is selected dependent upon set AM

Resolution:

0.1 dB or 3 digits for linear units.

RF level units:

Units may be set to μV , m V, EMF or PD; dB relative to 1 μV , 1 m V, EMF or PD; or dBm. Conversion between dB and linear units may be achieved by pressing the appropriate units key (dB or V, mV, μV). The output level can be normalised for 75 Ω operation with an external impedance converter (applies to all outputs simultaneously).

Accuracy:

Individual outputs:

(Over a temperature range of

17°C to 27°C)

Output level	10 kHz to 1.2 GHz	1,2 GHz to 2,4 GHz
<6 dBm >6 dBm* Temperature coefficient	±0.8 dB ±1.0 dB <±0.02 dB/°C	±1.6 dB ±2.0 dB <±0.04 dB/°C

^{*}Accuracy is unspecified below 30 kHz for levels >6 dBm.

Combined output:

(over a temperature range 17°C to 27°C)

±0.75 dB, 865 MHz-895 MHz;

±0.75 dB, 1750 MHz-1990 MHz

For output levels from -35 dBm to -20 dBm:

Temperature coefficient: <±0.01 dB/°C up to 1.2 GHz; <±0.02 dB/°C above 1.2 GHz.

Attenuator hold:

Inhibits operation of the step attenuator from the level at which the key is

enabled. Usable for a level reduction of at least 10 dB. Typical

accuracy ±3 dB.

VSWR

Individual outputs:

For output levels <-5 dBm output VSWR is less than 1.5:1

for carrier frequencies up to 1.2 GHz and <1.7:1

for carrier frequencies up to 2.4 GHz.

Output connector

50 Ω type-N connectors to MIL 390123D.

Output protection

Individual outputs:

Protected against the application of reverse power to the output connector for levels up 50 W from 50 Ω or 25 W from a source VSWR of 5:1. Protection circuit can be reset from the front panel or via the

GPIB interfaces.

Radio Connections

Path loss

RADIO:

INPUT FROM RADIO YEST SET to CONNECTION TO

Typically

14 dB, 865 to 895 MHz:

15 dB, 1750 to 1990 MHz.

A mean calibration value subject to a frequency response of <±0.1 dB across the associated band is supplied with each instrument. A measurement uncertainty of ±0.25 dB applies to each path loss.

CONNECTION TO RADIO to

OUTPUT TO PADIO TEST SET: Typically

13.5 dB

Isolation

>40 dB from CONNECTION TO RADIO to INPUT FROM RADIO TEST

SET with OUTPUT TO RADIO TEST SET terminated.

VSWB

CONNECTION TO RADIO:

<1.35:1.865 to 1990 MHz.

INPUT FROM RADIO TEST <1.2:1, 865 to 895 MHz; SET:

<1.35:1, 1750 to 1990 MHz.

Maximum safe power

CONNECTION TO RADIO; +33 dBm.

OUTPUT TO RADIO TEST

+33 dBm.

SET: SET

INPUT FROM RADIO TEST +19 dBm.

Spectral purity

Harmonics.

Individual outputs:

Typically better than -30 dBc for RF levels up to +6 dBm, typically better

than -25 dBc for RF levels up to +18 dBm (+14 dBm above 1.2 GHz).

Combined output:

Typically better than -30 dBc for RF levels up to -36 dBm, typically better

than -25 dBc for RF levels up to -13 dBm.

Non-harmonics:

Better than -70 dBc for carrier frequencies up to 1 GHz; better than -64 dBc for carrier frequencies above 1 GHz; better than -60 dBc for carrier frequencies above 2 GHz.

Isolation:

Better than 80 dB between individual outputs in use.

Better than 60 dB from a used individual output to the CONNECTION TO

RADIO.

Intermodulation: At an RF output level of -22 dBm at the CONNECTION TO RADIO:

Frequency:

2-tone intermodulation:

800 MHz to 2 GHz -75 dBc

Intermodulation levels reduce with reducing RF levels.

<4.5 Hz RMS in a 300 Hz to 3.4 kHz unweighted bandwidth at a carrier Residual FM:

frequency of 1 GHz.

Residual FM (typical) <1 Hz at 249 MHz; <2 Hz at 501 MHz; <3 Hz at 1001 MHz; <6 Hz at 2001 MHz.

SSB phase noise:

Better than -124 dB/Hz at 20 kHz offset from a 470 MHz carrier. Typically better than -121 dB/Hz at 20 kHz offset from a 1 GHz carrier.

RF leakage:

<0.5 µV at the carrier frequencies into a two-turn 25 mm diameter loop

25 mm from the surface of the signal generator.

Modulation

FM, AM or phase modulation can be applied to the carriers generated by each signal source from independent internal or external modulation sources. The internal modulation sources are capable of generating two simultaneous signals into any one of the modulation channels. Each Internal and external modulation source can be simultaneously enabled to produce combined amplitude and frequency (or phase) modulation. Pulse modulation can be applied to each of the carriers from external pulse sources. The pulse modulation can be used in combination with the other forms of modulation. 2-level or 4-level FSK modulation can be applied to each carrier using data from an external source.

Frequency modulation

Deviation range: 0 to 100 kHz. Resolution: 3 digits or 1 Hz.

Bandwidth (1 dB):

DC to 100 kHz (DC coupled); 10 Hz to 100 kHz (AC coupled); 20 Hz to 100 kHz (AC coupled with ALC).

Accuracy:

±5% at 1 kHz modulation rate

Carrier error:

<1% of the set frequency deviation when DC coupled.

Distortion:

<1% at 1 kHz rate for deviations up to 100 kHz, typically 0.3% at 1 kHz

rate for deviations up to 10 kHz.

(For carrier frequencies below 50 MHz; less than 3% at 1 kHz rate and

deviations up to 100 kHz.}

Group delay:

<5 μs to 100 kHz.

FSK

Modes:

2-level or 4-level FSK.

Data source:

External data via rear panel 25-way D-type connector.

Frequency shift:

Settable up to ±100 kHz.

Accuracy:

As FM deviation accuracy.

Timing jitter:

±3.2 us.

Filter:

8th order Bessel, -3 dB at 20 kHz.

Phase modulation

Rance:

0 to 10 radians.

Resolution:

3 digits or 0.01 radians.

Bandwidth (3 dB):

100 Hz to 10 kHz.

Accuracy:

±5% at 1 kHz modulation rate.

Distortion:

<3% at 10 radians at 1 kHz. Typically 0.5% for deviations up to 1 radian at 1 kHz.

Amplitude modulation

(for carrier frequencies <500 MHz,

usable to 1.5 GHz) Range:

0 to 99.9%.

Bandwidth (1 dB):

DC to 30 kHz (DC coupled); 10 Hz to 30 kHz (AC coupled);

20 Hz to 30 kHz (AC coupled with ALC).

Resolution:

Accuracy*

±5% of set depth at 1 kHz rate. Temperature coefficient <0.02% per °C.

(over temperature range 17°C to 27°C.):

*For output levels not exceeding +14 dBm (-22 dBm at the combiner

output).

Distortion*:

<1.5% at 1 kHz rate for modulation depths up to 30%; <2.5% at 1 kHz rate for modulation depths up to 80%.

*For output levels not exceeding +14 dBm (-22 dBm at the combiner

ΦM on AM:

Typically 0.1 radians at 30% depth at 470 MHz.

Pulse modulation

Carrier frequency range:

32 MHz to 2.4 GHz, usable to 10 MHz.

RF level range:

Maximum guaranteed output is reduced by 5 dB when pulse modulation is

selected

RF level accuracy:

Maximum additional uncertainty is ±0.5 dB.

Input:

Front panel BNC connector with an input impedance of $10\,k\,\Omega$ nominal. A logical '1' (3.5 to 5 V) turns the carrier on, a logical '0' (0 to 1 V) turns the

carrier off. Maximum safe input is ±15 V.

On-off ratio:

Better than 40 dB;

better than 45 dB below 1.2 GHz.

Rise and fall time:

<10 µs. <1 dB.

Overshoot Modulation oscillator

The internal modulation oscillator on each signal source is capable of generating one or two modulation tones simultaneously in one modulation

channel.

Frequency range:

0.01 Hz to 20 kHz.

Resolution:

0.01 Hz

Distortion:

<0.1% at 1 kHz.

Sine wave frequency response:

Typically 1 dB DC to 20 kHz.

Waveforms:

Sine to 20 kHz, triangle or square wave to 3 kHz.

Square wave jitter <6.4 µs on any edge

Output:

The modulation oscillator signal is available from the external modulation input/output connector at a nominal level of 2 V RMS EMF from a 600 $\,\Omega$ source impedance. This signal is not available when the connector is

being used as an input.

External modulation input

Input level:

A front panel external modulation input/output BNC connector is provided. 1 V RMS (1.414 V peak) sine wave for set deviation. Maximum safe input

is ±15 V.

Input impedance:

Modulation ALC:

Levels the applied external modulation over the range 0.75 to 1.25 V RMS. High and low indicators in display indicate when the input is

outside levelling range.

Sweep mode

Any or all of the sources may be set to a carrier frequency sweep mode. The sweeps are defined by entry of the start, stop and step frequencies. A common step time can be set from 50 ms to 10 s per step. A common trigger input at a rear panel BNC connector may be used to trigger a step or a complete sweep. Sweep can also be set to continuous.

Frequency standard

The carrier frequency and internal modulation frequency are synthesized

from either an internal reference oscillator or an external reference.

10 MHz OCXO. Internal standard:

> <±2.5 in 10⁷ per year. Aging rate:

<±5 in 109 per day after 2 months continuous use.

Temperature stability: Warm- up time:

Better than ±5 in 10⁸ over the temperature range 0 to 55°C. Within 2 in 107 of final frequency 10 minutes after switch on at a

temperature of 20°C.

External input:

Requires an input of 220 mV RMS to 1.8 V RMS into 1 k Ω on rear panel

BNC connector. Input frequency can be 1 MHz or 10 MHz.

External output:

Rear panel BNC socket provides an output of 10 MHz at a nominal level

of 2 V pk-pk into 50 Ω.

Calibration interval

Recommended 2 years. Realignment can be accomplished by GPIB control or from the front panel. There are no mechanical adjustments

required for realignment.

Remote control

GPIR:

All standard signal generator functions except the supply switch are

remotely programmable.

Canabilities:

Complies with the following subsets as defined in IEEE Std 488.1; SH1,

AH1, T6, TE0, L4, LE0, SR1, RL1, PP0, DC1, DT1, C0, E2.

RS-232:

All standard signal generator functions except the supply switch are remotely programmable.

Connector is 9-way male D-type, baud rate 300 to 9600 bit per second. Handshake hardware is DTR, RTS, CTS and DSR, and software is XON

and XOFF

Electrical interface is to EIA-232-D.

Auxiliary port connector

A rear panel auxiliary port connector provides inputs for FSK operation.

Electromagnetic compatibility

Conforms with the protection requirements of Council Directive 89/336/EEC.

Complies with the limits specified in the following standards: EN55011 Class B CISPR 11

AS/NZS 2064.1/2 AS/NZS 4252.1

EN50082-1

IEC 801-2,3,4

EN60555-2

IEC 555-2

Safety This instrument is designed to comply with the requirements of

EN61010-1/IEC1010-1, for Class 1 portable equipment and is for use in a pollution degree 2 environment. The equipment is designed to operate

from an installation category 2 supply.

Rated range of use

(over which full specification is met unless otherwise indicated).

Temperature

0°C to +55°C.

Humidity

Up to 93%.

Altitude

Up to 3050 m (10,000 ft).

Conditions of storage and transport

Temperature

-40°C to +71°C.

Humidity

Up to 93% at 40°C.

Altitude

Up to 4570 m.

Power requirements

47 to 63 Hz at 90 to 132 V, or 188 to 264 V at 380 VA maximum.

Dimensions and weight

Height Width 177 mm

419 mm

Depth 488 mm Weight <20 kg

Versions, options and accessories

When ordering please quote the full ordering number information.

Ordering numbers	Versions
2026Q	800 MHz to 2 GHz CDMA Interferer MultiSource Generator
	Supplied with
46882-361E	Operating manual (this manual).
-	AC power supply lead (see 'Power cords', Chap. 2).
	Optional accessories
54311-208Z	$50/75$ Ω adapter.
46880-077H	Service manual.
43129-189U	GPIB lead assembly, 1.5 m.
46884-649V	RS-232 cable, 9-way female to 25-way female, 1.5 m.
46884-650F	RS-232 cable, 9-way female to 9-way female, 1.5 m.
46884-293H	Rack mounting kit (with slides) for rack cabinets with depths from 480 to 680 mm.
46884-294E	Rack mounting kit (with slides) for rack cabinets with depths from 680 to 840 mm.
46884-931W	Rack mounting kit containing front mounting brackets only.
46662-614M	Soft carrying case.

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Declaration of Conformity

We:

Marconi Instruments Limited

Longacres House Norton Green Road

Stevenage

Hertfordshire SG1 2BA

England

as the manufacturer of the apparatus listed, declare under our sole responsibility that the product(s):

Title:

CDMA Interferer/Multisource Generator

Model:

2026Q

to which this declaration relates are in conformity with the following standards or other normative documents:

Safety:

EN 61010-1:1993 (IEC 1010-1:1990)

EMC:

EN 55011:1991 Class B

EN 50082-1:1992 EN 60555-2:1987

and therefore conforms with the protection requirements of Council Directive 89/336/EEC relating to electromagnetic compatibility and Council Directive 73/23/EEC relating to safety requirements.

Issued on: 4th. September 1997

Authorised by:

Alan Smithies.

Alan Smithies

Product Liability Manager

Chapter 2 INSTALLATION

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WARNING

Initial visual inspection

After unpacking the instrument, inspect the shipping container and its cushioning material for signs of stress or damage. If damage is identified, retain the packing material for examination by the carrier in the event that a claim is made. Examine the instrument for signs of damage; do not connect the instrument to a supply when damage is present, internal electrical damage could result in shock if the instrument is turned on.

Mounting arrangements

Excessive temperatures may affect the performance of the instrument. Completely remove the plastic cover, if one is supplied over the case, and avoid standing the instrument on or close to other equipment which is hot.

CAUTION

Installation requirements

Ventilation

This instrument is forced air cooled by a fan mounted on the rear panel. Air must be allowed to circulate freely through the ventilator grills located on the side and underside of the instrument. Before switching on the instrument, ensure that the fan outlet on the rear panel is not restricted (i.e. clearance of at least 75 mm at the rear, 25 mm at each side, 15 mm on the underside). Failure to provide adequate clearances will increase internal temperatures and reduce the instrument reliability, so that its performance may not meet specification.

Class I power cords (3-core)

General

When the equipment has to be plugged into a Class II (ungrounded) 2-terminal socket outlet, the cable should either be fitted with a 3-pin Class I plug and used in conjunction with an adapter incorporating a ground wire, or be fitted with a Class II plug with an integral ground wire. The ground wire must be securely fastened to ground. Grounding one terminal on a 2-terminal socket will not provide adequate protection.

In the event that a moulded plug has to be removed from a lead, it must be disposed of immediately. A plug with bare flexible cords is hazardous if engaged in a live socket outlet.

Power cords with the following terminations are available from Marconi Instruments Ltd. Please check with your local sales office for availability.

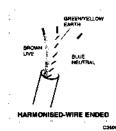
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This equipment is provided with a 3-wire (grounded) cordset which includes a moulded IEC 320 connector for connection to the equipment. The cable must be fitted with an approved plug which, when plugged into an appropriate 3-terminal socket outlet, grounds the case of the equipment. Failure to ground the equipment may expose the operator to hazardous voltage levels. Depending upon the destination country, the colour coding of the wires will differ:-

Wire ended

Country	IEC 320 plug type	Marconi part number
Universal	Straight through	23424-158
Universal	Right angled	23424-159

	North America	Harmonised
Line (Live)	Black	Brown
Neutral	White	Blue
Ground (Earth)	Green	Green/Yellow

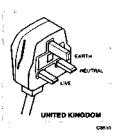


British

Country	IEC 320 plug type	Marconi part number
United Kingdom	Straight through	23422-001
United Kingdom	Right angled	23422-002

The UK lead is fitted with an ASTA approved moulded plug to BS 1363.

A replaceable 13 A fuse to BS 1362 is contained within the plug. This fuse is only designed to protect the lead assembly. Never use the plug with the detachable fuse cover omitted or if the cover is damaged.

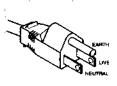


The fuse(s) or circuit breaker to protect the equipment is fitted at the back of the equipment.

North American

Country	IEC 320 plug type	Marconi part number
North American	Straight through	23422-004
North American	Right angled	23422-005

The North American lead is fitted with a NEMA 5-15P (Canadian CS22.2 No 42) plug and carries approvals from UL and CSA for use in the USA and Canada.



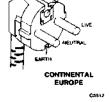
U.S./CANADA/KOREA

C35

Continental Europe

Country	IEC 320 plug type	Marconi part number
Europe	Straight through	23422-006
Europe	Right angled	23422-007

The Continental European lead is fitted with a right angle IEC83 standard C4 plug (CEE 7/7) which allows it to be used in sockets with either a male earth pin (standard C 3b) or side earth clips (standard C 2b) the latter is commonly called the German 'Schuko' plug. In common with other Schuko style plugs, the plug is not polarized when



fitted into a Schuko socket. The lead carries approvals for use in Austria, Belgium, Finland, France, Germany, Holland, Italy, Norway and Sweden. Note that this plug will not fit Italian standard CEI 23-16 outlets. The lead should not be used in Denmark given that the earth connection will not be made.

Français

Le câble d'alimentation d'Europe Continentale est muni d'un connecteur mâle à angle droit type CEI83, standard C4 (CEE 7/7), qui peut être utilisé dans une prise femelle à ergot de terre (standard C 3b) ou à clips latéraux (standard C 2b), cette dernière étant communément appelée prise "Schuko" allemande. De la même façon que les autres connecteurs de type Schuko, celui-ci n'est pas polarisé lorsqu'il s'adapte à une prise femelle Schuko. Ce câble d'alimentation est homologué en Allemagne, Autriche, Belgique, Finlande, France, Hollande, Italie, Norvège et Suède. A noter que ce connecteur n'est pas compatible avec les prises de courant italiennes au standard CEI 23-16. Ce câble ne doit pas être utilisé au Danemark à cause du défaut de connexion de masse.

Deutsch

Das kontinentaleuropäische Netzkabel ist mit einem rechtwinkeligen Stecker nach IEC83 C4 (CEE7/7) Standard versehen, welcher sowohl in Steckdosen mit Erde-Stift (Standard C 3b) oder seitlichen Erdeklemmen, im allgemeinen "Schukosteckdose" genannt, paßt. Üblicherweise ist der Schukostecker bei Verwendung in Schukosteckdosen nicht gepolt. Dieses Netzkabel besitzt Zulassung für Österreich, Belgien, Finnland, Frankreich, Deutschland, Holland, Italien, Norwegen und Schweden.

Hinweis: Dieser Schukostecker paßt nicht in die italienischen Standardsteckdosen nach CEI 23-16 Norm. Dieses Netzkabel sollte nicht in Dänemark verwendet werden, da hier keine Erdeverbindung hergestellt wird.

Español

El cable de alimentación tipo Europeo Continental dispone de una clavija C4 normalizada IEC83 (CEE 7/7) que permite su utilización tanto en bases de enchufe con toma de tierra macho (tipo C 3b) o con toma de tierra mediante contactos laterales (tipo C 2b) que, en este último caso, suele denominarse "Schuko". Al igual que cualquier otra clavija tipo Schuko, las conexiones a red no están polarizadas cuando se conectan a una base tipo Schuko. El cable lleva autorización para su uso en Austria, Bélgica, Finlandia, Francia, Alemania, Holanda, Italia, Noruega y Suecia. Observe que este cable no se adapta a la norma italiana CEI 23-16. El cable no debe utilizarse en Dinamarca en el caso de no efectuarse conexión a tierra.

Italiano

I cavi d'alimentazione per l'Europa continentale vengono forniti terminati con una spina ad angolo retto del tipo C4 secondo lo standard IEC83 (CEE 7/7) che può essere usato in prese in cui la terra può essere fornita o tramite connettore maschio (C 3b) o tramite clips laterali (C 2b), quest'ultima comunemente detta di tipo tedesca "Schuko". Questa spina, quando collegata ad una presa Schuko, non è polarizzata.

Il cavo può essere usato in Austria, Belgio, Finlandia, Francia, Germania, Olanda, Norvegia, Svezia ed Italia. E' da notare che per l'Italia questo non risponde allo standard CEI 23-16.

Questa spina non dovrebbe invece essere usata in Danimarca in quanto non realizza il collegamento di terra.

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Goods-in checks

The following goods-in check verifies that the instrument is functioning correctly, but does not verify conformance to the listed specification. To verify that the instrument conforms to the specification given in Chapter 1, refer to Chapter 7, 'Acceptance testing'.

- (1) Ensure that the correct fuse is fitted (accessible from the rear panel) and connect the instrument to the supply.
- (2) Switch on and check that a display is present.
- (3) If the instrument appears to be completely dead, carry out the following: Check that the mains power supply line is providing power to the instrument. Check that the mains fuses have not blown.

Connecting to supply

Ensure that the AC supply is correctly connected to the POWER SUPPLY socket. For supplies in the range 90 - 132 V and 188 - 264 V the PSU automatically selects the appropriate range. There is no manual voltage range selection provided.

Fuse

For the AC voltage range of 90 - 264 V the fuse rating is 4 A-T (time lag). The AC fuse is a cartridge type measuring $20 \text{ mm} \times 5 \text{ mm}$.

The fuse-holder is integral with the rear panel 3-pin supply plug. For access to change the fuse, use a screwdriver to lever out the holder.

General purpose interface bus (GPIB)

The GPIB interface built into the instrument enables the signal generators to be remotely controlled to form part of an automatic measuring system.

GPIB cable connection

Connection to other equipment which has a 24-way connector to IEEE Standard 488 is made using the rear panel GPIB 1 socket. For this purpose, the GPIB cable assembly, available as an optional accessory, (see Chap. 1 'Accessories') may be used. A second socket, GPIB 2, may be fitted as an option (not yet implemented).

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GPIB connector contact assignments

The contact assignments of the GPIB cable connector are as given in the table below and shown in Fig. 2-1.

Contact	Function	Contact	Function
1	Data I/O 1	13	DataI/O 5
2	Data I/O 2	14	DataI/O 6
3	Data I/O 3	15	Datal/O 7
4	Data I/O 4	16	Datal/O 8
5	EOI	17	REN
6	DAV	18	Pair with 6
7	NRFD	19	Pair with 7
8	NDAC	20	Pair with 8
9	IFC	21	Pair with 9
10	SRQ	22	Pair with 10
11	ATN	23	Pair with 11
12	Ground shield	24	Logic ground

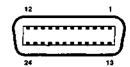


Fig. 2-1 GPIB connector contact assignments (viewed from rear of instrument)

IEEE to IEC conversion

An optional IEEE to IEC adapter is also available (see Chap. 1 'Optional Accessories') for interfacing with systems using a 25-way bus connector to IEC Recommendation 625. The method of use is shown in Fig. 2-2.

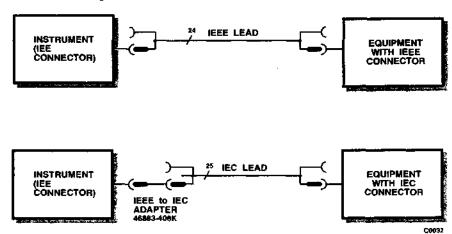


Fig. 2-2 IEEE to IEC conversion

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Interface bus connection

The cables for the interface bus use special male-female connectors at both ends. This allows several connectors to be stacked one on top of another permitting several cables to be connected to the same source and secured by a lockscrew mechanism. Too large a stack, however, may form a cantilevered structure which might cause damage and should be avoided. The piggyback arrangement permits star or linear interconnection between the devices with the restriction that the total cable length for the system must be:-

- (1) No greater than 20 m (65 ft).
- (2) No greater than 2 m (6 ft) times the total number of devices (including the controller) connected to the bus.

RS-232 interface

The RS-232 interface built into the instrument is used to reprogram the internal flash memory, and may also be used to control the instrument using the common GPIB command set.

RS-232 connector

The rear panel male D-type RS-232 connector is shown in Fig. 2-3.



Fig. 2-3 RS-232 connector (viewed from rear of instrument)

The pin-outs for the 9-way RS-232 connector are shown below:

Contact		Signal
1	DCD	Data carrier detect
2	RXD	Receive data
3	TXD	Transmit data
4	DTR	Data terminal ready
5	SG	Signal ground
6	DSR	Data set ready
7	RTS	Request to send
8	CTS	Clear to send
9	RI	Ring indicator

The RS-232 interface can be connected to a personal computer's AT connector using a null-modem cable. A suitable cable is available from Marconi Instruments - see 'Versions, options and accessories' in Chap. 1.

Auxiliary port connector

The rear panel 25-way female D-type AUXILIARY PORT connector is shown in Fig. 2-4. This is used for FSK operation.

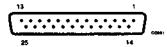


Fig. 2-4 25-way AUXILIARY PORT connector

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FSK operation

Data for FSK operation are carried on the contacts of the AUXILIARY PORT as shown by Table 2-1 below. The unused contacts are left unconnected.

Table 2-1 Auxiliary port contact assignments

CONTACT	FUNCTION	
14	Source A - FSK A	
15	Source A - FSK B	
16	Source B - FSK A	
17	Source B - FSK B	
18	Source C - FSK A	
19	Source C - FSK B	
12	0 V	

The frequency shifts produced by the applied data are as shown in Table 2-2 below for 2FSK and in Table 2-3 below for 4FSK.

Table 2-2 Auxiliary port inputs for 2FSK

	FSK A	FSK B		
SOURCE A	pin 14	pin 15		
SOURCE B	pin 16	pin 17	SHIFT	
SOURCE C	pin 18	pin 19		
LOGIC LEVELS	1	*0	+D	
	0	*0	-D	

where D is the set deviation value.

Table 2-3 Auxiliary port inputs for 4FSK

	F\$K A	FSK B	
SOURCE A	pin 14	pin 15	
SOURCE B	pin 16	pin 17	SHIFT
SOURCE C	pin 18	pin 19	i
LOGIC LEVELS	1	0	+D
	1	1	+D/3
	0	1	-D/3
	0	0	-D

where D is the set deviation value.

^{*}Tie FSK B as 0 or leave floating.

Rack mounting

The instrument, which is normally supplied for bench mounting, may be mounted in a standard 19 inch rack (see Chap. 1 'Optional Accessories'). There are two slide rack mounting kits to accommodate different depths of cabinet. These kits include full fitting instructions. A rack mounting kit without slides is also available which contains front panel mounting brackets only.

CAUTION

Routine safety testing and Inspection

In the UK the 'Electricity at Work Regulations' (1989) section 4(2) places a requirement on the users of equipment to maintain it in a safe condition. The explanatory notes call for regular inspections and tests together with a need to keep records.

The following electrical tests and inspection information is provided for guidance purposes and involves the use of voltages and currents that can cause injury. It is important that these tests are only performed by competent personnel.

Prior to carrying out any inspection and tests the equipment must be disconnected from the mains supply and all external signal connections removed. All tests should include the equipment's own supply lead, all covers must be fitted and the supply switch must be in the 'ON' position.

The recommended inspection and tests fall into three categories and should be carried out in the following sequence:

- 1. Visual inspection
- 2. Earth bonding test
- 3. Insulation resistance test.

1. Visual inspection

A visual inspection should be carried out on a periodic basis. This interval is dependant on the operating environment, maintenance and use, and should be assessed in accordance with guidelines issued by the Health and Safety Executive (HSE). As a guide, this equipment, when used indoors in a relatively clean environment, would be classified as 'low risk' equipment and hence should be subject to safety inspections on an annual basis. If the use of the equipment is contrary to the conditions specified, you should review the safety re-test interval.

As a guide, the visual inspection should include the following where appropriate:

Check that the equipment has been installed in accordance with the instructions provided (e.g. that ventilation is adequate, supply isolators are accessible, supply wiring is adequate and properly routed).

- The condition of the mains supply lead and supply connector(s).
- The correct rating and type of supply fuses.
- · Security and condition of covers and handles.
- Check the presence and condition of all warning labels and markings and supplied safety information.
- · Check the wiring in re-wireable plugs and appliance connectors.
- Check the cleanliness and condition of any ventilation fan filters.
- Check that the mains supply switch isolates the equipment from the supply.
- Check the supply indicator functions (if fitted).

If any defect is noted this should be rectified before proceeding with the following electrical tests.

2. Earth bonding tests

Earth bonding tests should be carried out using a 25 A (12 V maximum open circuit voltage) DC source. Tests should be limited to a maximum duration of 5 seconds and have a pass limit of $0.1~\Omega$ after allowing for the resistance of the supply lead. Exceeding the test duration can cause damage to the equipment. The tests should be carried out between the supply earth and exposed

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case metalwork, no attempt should be made to perform the tests on functional earths (e.g. signal carrying connector shells or screen connections) as this will result in damage to the equipment.

3. Insulation tests

A 500 VDC test should be applied between the protective earth connection and combined live and neutral supply connections with the equipment supply switch in the 'on' position. It is advisable to make the live/neutral link on the appliance tester or its connector to avoid the possibility of returning the equipment to the user with the live and neutral poles linked with an ad-hoc strap. The test voltage should be applied for 5 seconds before taking the measurement.

Marconi Instruments Ltd., employ reinforced insulation in the construction of their products and hence a minimum pass limit of 7 M Ω should be achieved during this test.

Where a DC power adapter is provided with the equipment the adapter must pass the 7 M Ω test limit.

We do not recommend dielectric flash testing during routine safety tests. Most portable appliance testers use AC for the dielectric strength test which can cause damage to the supply input filter capacitors.

4. Rectification

It is recommended that the results from the above tests are recorded and checked during each repeat test. Significant differences between the previous readings and measured values should be investigated.

If any failure is detected during the above visual inspection or tests, the equipment should be disabled and the fault should be rectified by an experienced Service Engineer who is familiar with the hazards involved in carrying out such repairs.

Safety critical components should only be replaced with equivalent parts, using techniques and procedures recommended by Marconi Instruments Ltd.

The above information is provided for guidance only. Marconi Instruments Ltd. design and construct their products in accordance with International Safety Standards such that in normal use they represent no hazard to the operator. Marconi Instruments Ltd. reserve the right to amend the above information in the course of continuing its commitment to product safety.

Cleaning

Before commencing any cleaning, switch off the instrument and disconnect it from the supply. The exterior surface of the case may be cleaned using a soft cloth moistened in water. Do not use aerosol or liquid solvent cleaners.

Cleaning the LCD window

To prevent damage to the LCD window, care should be taken not to scratch the surface during use and also when cleaning. The LCD window should be cleaned by wiping a slightly damp, soft, lint-free cloth gently over the surface.

Putting into storage

If the instrument is to be put into storage, ensure that the following conditions are maintained:

Temperature range:

-40 to 70°C

Humidity:

Less than 93% at 40°C

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Introduction

This chapter explains how to:

- Set up the multisource generator to produce a typical basic signal.
- Select the main operating parameters; carrier frequency, output level and type of modulation.
- Use the full range of supporting facilities.

Conventions

The following conventions are used in this chapter:

RF OUTPUT Titles marked on the instrument panel are shown in capital letters

[UTIL] Hard key titles are shown in square brackets.

[Disable] Soft key titles are shown in italics in square brackets, e.g. [Disable] means the

soft key adjacent to the Disable title box at the side of the menu.

RF Level Messages appearing on the screen are shown in italics.

Front panel controls and connectors

Parameters are selected by means of hard keys, which have their function printed on them, soft keys, which do not have any notation, a numerical key pad and a rotary control knob, see Fig. 3-1 below. The hard keys have functions which do not change, whereas the soft key functions are determined by the menu which is being displayed. The numerical keys are used to set parameters to specific values which can also be varied in steps of any size by using the $[\mathbb{0}][\mathbb{0}]$ keys or the rotary control knob.

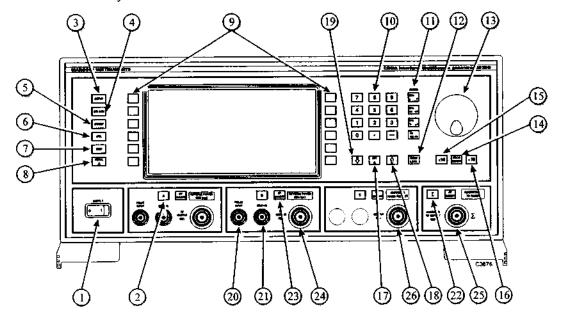


Fig. 3-1 2026Q front panel

		•
1	SUPPLY	Switches the AC supply voltage on and off.
2	[A], [B]	This key is repeated for each signal source. It selects A or B as the current signal source for parameter display and adjustment.
3	[SETUP]	Displays the Setup Menu used for signal source configuration and for selecting an application mode.
4	[SIG GEN]	Displays the main, Sig Gen, menu.
3	[SWEEP]	Displays the Sweep Control screen for the current source.
6	[UTIL]	Displays the Utilities Selection Menu.
7	[MEM]	Displays the Memory Store/Recall Menu.
(8)	[TOTAL Δ]	Displays the Total Shift Menu for the current source.
9	Soft keys	Twelve function keys change notation as the menus change.
10)	Numerical key pad	For entering the value of a selected parameter. Minus sign and decimal point are included.
11)	[ENTER]/Units keys	Determine the units of the set parameters and also used to terminate a numerical entry.
(2)	[KNOB LOCK]	Pressing this key assigns control knob operation to the currently selected function.
13)	Control knob	When enabled by the [KNOB ON/OFF] key, adjusts the value of the selected parameter.
14)	[KNOB ON/OFF]	Enables or disables the control knob.
<u>(15)</u>	[×10]	When control knob enabled, decreases knob resolution by a factor of 10.
16)	[÷10]	When control knob enabled, increases knob resolution by a factor of 10.
17)	[SET Δ]	Displays the Steps Menu for the current source.
18)	[t]	Increments the value of the selected parameter.
(19)	[û]	Decrements the value of the selected parameter.
20)	PULSE INPUT	$10~k\Omega$ BNC connector (fitted to each signal source) which accepts a pulsed input.
21)	MOD I/O	100 k Ω BNC connector (fitted to each signal source) which allows an external modulating signal to be applied. Also provides a modulation oscillator output from a 600 Ω source impedance.
22	[Σ]	Displays the Combiner Summary.
23)	[RF ON/OFF]	Enables or disables the associated signal source RF OUTPUT or the CONNECTION TO RADIO output connector.
24)	RF OUTPUT	$50~\Omega$ type-N connector (fitted to each signal source). Protected against the application of reverse power of up to $50~W_\odot$
25)	CONNECTION TO RADIO	$50~\Omega$ type-N connector for connection to the radio under test. Note that maximum reverse power at this connector is $0.5~W_{\odot}$
26)	OUTPUT TO RADIO TEST SET	$50\;\Omega$ type-N connector. Enables a signal to be fed out from the combiner to the radio test set.

Rear panel connectors

The rear panel connectors are shown in Fig. 3-2 below.

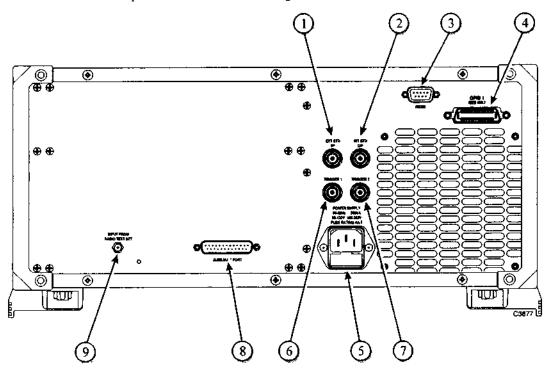


Fig. 3-2 2026Q rear panel

① EXT STD I/P	BNC connector for the input of an external standard frequency of either 1 MHz or 10 MHz.
② INT STD O/P	BNC connector for the output of the internal 10 MHz standard.
③ RS232	9-way RS-232 connector used for remote control of the instrument as well as to reprogram the internal flash memory. For contact allocation see 'RS-232 connector' in Chapter 2.
4 GPIB 1	24-pin socket accepts standard IEEE connector to allow remote control of the instrument.
POWER SUPPLY	3-pin plug integral with fuse holder. Mates with AC supply lead socket.
TRIGGER 1	BNC connector which is used for sweep triggering.
7 TRIGGER 2	Reserved.
AUXILIARY PORT	25-pin socket. Can accept external data to modulate each of the internal sources for 2-level or 4-level FSK. For contact allocation see 'Auxiliary port connector' in Chapter 2.
INPUT FROM RADIO TEST SET	50 Ω SMA connector. Enables a signal to be fed into the combiner from a radio test set or an external signal generator.

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First time use

First time users can quickly become familiar with the principles of control and display by carrying out the following exercise, which demonstrates how to set up on one of the signal sources, a typical basic signal having the following parameters:

Carrier frequency:

100 MHz,

Output level:

10 dBm,

Frequency modulation:

100 kHz deviation at 500 Hz mod.

Switching on

Before switching the instrument on, check that the power supply is connected and ensure that no external signal sources are connected.

Switch on by means of the SUPPLY switch and check that the display is similar to that shown in Fig. 3-3 below. This shows the Sig Gen menu as it appears during normal operation.

If the default display shown in Fig. 3-3 is not obtained, a previous user may have set the instrument to switch on with one of the user memories recalled, rather than using the default factory settings.

To reset to the factory settings press the [UTIL] hard key followed by the soft key sequence [Power Up Options] [Factory Power Up] [EXIT]. Then switch off and switch back on again.

Observe that the Sig Gen menu appears on the display showing the default parameters for FM, and that the panel for the A signal source is highlighted at the bottom left of the screen. This indicates that these parameters apply only to the A source.

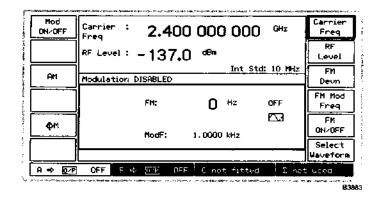


Fig. 3-3 2026Q sig gen menu in normal operation showing default display (with the A source panel highlighted)

Display

Before entering any parameters it will be found useful to look at the effect that pressing various keys has on the display for the Sig Gen menu. This is the main display and it is divided into a number of fields as shown in Fig. 3-4 below.

Signal source field

This field, at the bottom of the display, is divided into four panels, one each for three signal sources (the third, c, source is not fitted) and one for the combiner. When a source panel is highlighted, all the parameters shown on the screen apply to that source i.e. when the A panel is highlighted, the displayed carrier frequency, RF level, modulation etc., apply only to the A source. The selected signal source can be changed using the [A] and [B] hard keys.

The RF output from a source may be directed to its own output socket, or re-routed via the combiner (either alone or in combination with other sources) to the combiner output socket. Signal sources are combined using a menu accessed via the [SETUP] hard key.

The designation $A \rightleftharpoons O/P$ shows that the A source output is directed to the RF OUTPUT socket for the A source. When $A \rightleftharpoons \Sigma$ is displayed it shows that the A source output is directed to the combiner.

When no signal source is connected to the combiner the combiner panel shows Σ not used. In this instrument not fitted is always shown against source designator C.

When one or more sources are connected via the combiner to the CONNECTION TO RADIO socket, the combiner panel displays this information by showing either $\Sigma = A$ or $\Sigma = A + B$.

Note that the signal source field is displayed in all modes.

Carrier frequency field

This shows the current carrier frequency setting for the selected signal source. This field is controlled by the [Carrier Freq] soft key.

When the frequency of the selected source is coupled to another source (i.e. it tracks it), an arrow is shown together with the other source's identity. In Fig. 3-4 for example, the B source is shown coupled to the A source by the A source panel being highlighted and $\Rightarrow B$ being shown in the carrier frequency field.

RF level field

This shows the current RF level setting for the selected signal source. This field is controlled by the [RF Level] soft key.

When the level of the selected source is coupled to another source, an arrow is shown together with the other source's identity (as for frequency coupling).

Frequency standard field

The type of standard is shown in this field together with its frequency. Frequency standard selection is made from a menu accessed via the [UTIL] hard key.

This field also displays Atten Lock when the attenuator lock function is enabled.

Modulation state field

Here the modulation state is shown as either *ENABLED* or *DISABLED*. This is controlled by the *[Mod ON/OFF]* key which switches all internal modulation on or off. When pulse modulation is selected, *Pulse ON* or *OFF* is shown (an additional soft key *[Pulse ON/OFF]* also appears).

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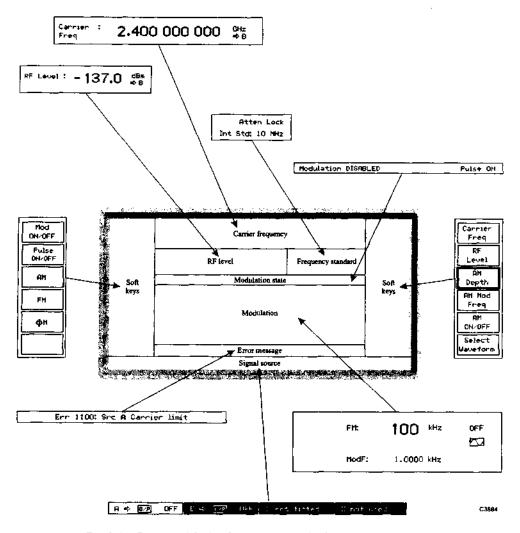


Fig. 3-4 Division of the Sig Gen menu (main display) into fields

Modulation field

This field shows all the current modulation settings for the selected signal source: type of modulation; modulation deviation/depth; modulation frequency; waveform type (shown graphically); modulation ON or OFF.

The type of modulation is selected by the (FM), (AM) and (ϕM) keys. Only 2 of the 3 keys are shown at any time. This is because the display will already be showing the parameters for the omitted selection key.

Modulation deviation/depth is selected by the [FM Devn], [AM Depth] and [\phiM Devn] keys.

Modulation frequency is selected using the [FM Mod Freq], [AM Mod Freq] and [φM Mod Freq] keys and the value is shown on the screen against ModF:.

The type of waveform (sine, triangle or square) is obtained from a menu after pressing the [Select Waveform] key. For external modulation this key is replaced by the [Select Coupling] key.

Internal modulation switching is controlled by the [FM ON/OFF], [AM ON/OFF] and [\phiM ON/OFF] keys.

Error message field

Error messages are displayed here when, for example, you exceed a parameter limit. A list of error messages is given at the end of this Chapter.

Soft key fields

These fields can hold up to 12 soft key labels. Some soft keys are used to select a field for data entry (e.g. [Carrier Freq]), in which case the soft key label will remain highlighted after being pressed to show that any subsequent data entry applies to that function.

Other soft keys may perform an action (e.g. turning the modulation on or off), in which case the label will flash to acknowledge the keypress.

Some soft keys cause another menu to be displayed, in which case there is no highlighting or flashing of the label, the change of menu acknowledges the key-press.

Selecting functions and keyboard entry

Whenever one of the main functions - carrier frequency, RF level, modulation - is highlighted on the main screen, making any terminated numerical entry will be accepted as being a changed parameter for that function. This enables you to enter, for example, a sequence of carrier frequencies without having to re-press the [Carrier Freq] key for each entry.

First of all, select the A source for adjustment by pressing the [A] key.

Carrier frequency

- (1) Press the [Carrier Freq] soft key to select carrier frequency as the current function. The key label is highlighted i.e. the line bordering the label is increased in thickness to about 1 mm. Data entered on the key pad will now be recognised as a frequency setting and replaces the current setting.
- (2) Enter 100 MHz by entering 100 on the numerical key pad and terminating with [MHz]. Observe that the Carrier Freq: display changes to 100.000 000 MHz.

If you make an error when keying in, press the function key again and key in the correct value. If this causes an error message (e.g. Err 1100: Carrier Limit) to be displayed, it can be cancelled by a correct entry (e.g. by entering a value which is within limits).

RF level

- (3) Press [RF LEVEL] (which causes its key label to be highlighted) to select RF level as the current function.
- (4) Enter 10 dBm by entering 10 on the numerical key pad and terminating with [dB]. Observe that the RF Level: display changes to +10.0 dBm.
- (5) Press the [RF ON/OFF] key for the A signal source. Repeated pressing toggles between the on and off states as shown by A

 O/P ON and OFF in the A source panel. Select ON. A 100 MHz, 10 dBm carrier is now being generated from the A source RF OUTPUT socket.

Modulation

- (6) Press [FM Devn]. Enter 100 on the key pad and terminate with [kHz]. 100 kHz is displayed in the modulation field.
- (7) Press [FM Mod Freq]. Enter 500 on the key pad and terminate with [Hz]. ModF: 500.00 Hz is displayed.
- (8) Press[Mod ON/OFF]. Repeated pressing toggles between the on and off states as shown by Modulation ENABLED and DISABLED at the centre of the screen. Select Modulation ENABLED.

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(9) Press [FM ON/OFF]. Repeated pressing toggles between the on and off states as shown by ON and OFF on the screen. Select ON. A 100 MHz, 10 dBm carrier is now being generated at 100 kHz deviation, sine wave modulated at 500 Hz from the A source RF OUTPUT socket.

Parameter adjustment

When a function has been selected, you can increment or decrement its parameter either continuously using the control knob or in steps using the $\{\hat{Y}\}$ and $\{\emptyset\}$ keys. You can also simultaneously adjust two parameters by means of the [KNOB LOCK] key.

Using the control knob

You enable the control knob by pressing the [KNOB ON/OFF] key so that the parameter to be adjusted is displayed outlined by a bracket. With the control knob enabled, you can set its resolution. Press the [+10] key to increase the bracket length by one decimal place. Similarly, press the [×10] key to decrease the bracket length by one decimal place. In this way you respectively increase or decrease the resolution of the control knob by a factor of ten.

Disabling the control knob will help to ensure that accidental changes to the set parameters are prevented.

Two-parameter adjustment

A feature of this instrument is that the [KNOB LOCK] key enables you to simultaneously and independently adjust two parameters using the control knob and the $[\hat{v}][\theta]$ keys. Proceed as follows:-

- (1) Select the function to be assigned to the control knob for adjustment by pressing its soft key e.g. [Carrier Freq]. When selected, the soft key is highlighted i.e. the line bordering the key label is increased in thickness to about 1 mm.
- (2) Enable the control knob using the [KNOB ON/OFF] key (so that the bracket is visible above and below the parameter).
- (3) Press the [KNOB LOCK] key. Now any movement of the control knob will only adjust the parameter of the assigned function leaving you free to select a second function e.g. [RF Level] and adjust its parameter this time using the [1] and [4] keys. At all times the function locked to the control knob is identified by its parameter being outlined by a bracket and an inverse-video bracket symbol being displayed at the lower right of the screen.

Using the steps keys

The selected function's parameter may be adjusted in steps using the $[\hat{v}]$ and $[\hat{v}]$ keys to respectively increment and decrement the parameter. The step size can be set as follows:

(1) Press the [SET Δ] key which causes the Steps Menu to be displayed (see Fig. 3-5 below). This shows the step sizes of the currently selected signal source.

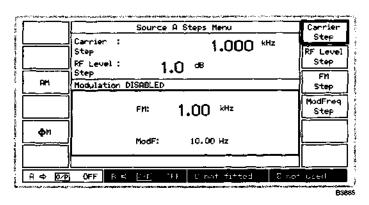


Fig. 3-5 Steps menu

- (2) Select [Carrier Step], enter the value on the key pad and press a terminator key. The step value will appear on the screen.
- (3) Return to the Sig Gen menu by pressing [SIG GEN].
- (4) Using the {û} and [0] keys respectively will now increment or decrement the carrier frequency by the set value.
- (5) [RF Level Step], [ModFreq Step] and [FM Step], [AM Step] and [φM Step] values can be entered in the same way.
- (6) Repeat as required for the other signal sources.

Displaying shifts

You can check the difference between the keyed-in value (the reference) and the current value, as well as restoring the reference either to the original value or resetting it to the new value. Proceed as follows:

(1) Press [TOTAL Δ] to display the *Total Shift Menu* for the selected signal source. This displays the amount of shift from the reference caused by using the control knob or [Φ] [Φ] keys to adjust the parameters (see Fig. 3-6 below).

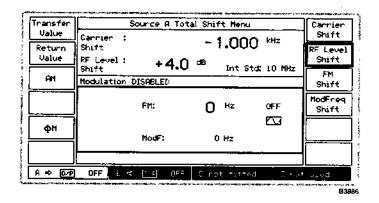


Fig. 3-6 Total shift menu

(2) Carrier frequency and RF level, as well as modulation depth/deviation and frequency - in combination with the [AM], [FM] and [φM] keys - can be further adjusted using the appropriate [Shift] key. The amount of shift at each key-press is that of the current step value.

Combiner summary

The $[\Sigma]$ hard key may be used to display a summary of all the sources' frequencies and levels and provides an easy means to change these parameters. This menu is also used to implement the attenuator lock function for each individual source. The function inhibits operation of the step attenuator from the level at which the key is enabled, and is usable for a level reduction of at least 10 dB.

 Press the [Σ] hard key to show the Combiner Summary similar to that shown in Fig. 3-7 below.

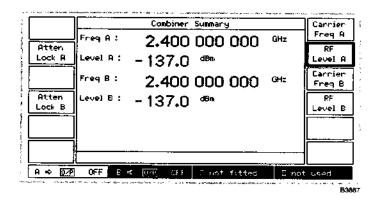


Fig. 3-7 Combiner summary

- (2) You can reset the carrier frequencies and RF levels for each of the sources fitted in your instrument. Press the [Carrier Freq] or [RF Level] key for the applicable source, enter the new value on the key pad and press a terminator key.
- (3) To display the individual signal source settings press the required [A] or [B] key.
- (4) To implement the attenuator lock function, press the [Atten Lock] key for the required A or B source. Atten Lock is shown on the menu (and also shown on the Sig Gen menu) against the appropriate source parameters.

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Individual source operation

The following section describes the method of controlling the settings of the individual signal sources. The method of control can be used irrespective of the routing of the signal source output, whether to its own RF OUTPUT or to the CONNECTION TO RADIO connector, and irrespective of any coupling that may have been set up.

Signal source selection

Select the required signal source by pressing the [A] or [B] key. The selection is acknowledged by the A or B panel at the bottom of the display being highlighted. Having entered the parameters for that signal source you can then repeat the procedure for the next source. In Fig. 3-8 below the parameters for the A source are shown.

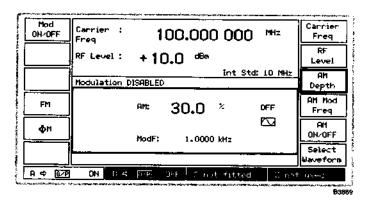


Fig. 3-8 Sig Gen menu with amplitude modulation selected for the A source

Carrier frequency selection

You can enter the carrier frequency in the range 10 kHz to 2.4 GHz to a resolution of 1 Hz.

- (1) Press [SIG GEN] to show the Sig Gen menu with the current carrier frequency displayed.
- (2) Press the [Carrier Freq] soft key to select carrier frequency as the current function.
- (3) Enter the required value using the numerical key pad. Terminate using the [Hz], [kHz], [MHz] or [GHz] key. If a value outside the specified range is requested, an error message is displayed and the instrument is automatically set to the end of the range.
- (4) You can then adjust the frequency either in steps using the $[\mathfrak{P}]$, $[\mathfrak{V}]$ keys or by using the control knob for continuous adjustment. The default increment/decrement is 1 kHz.
- (5) You can check the current amount of offset from the reference carrier frequency by pressing [TOTAL Δ]. This causes the *Total Shift Menu* to be displayed.
- (6) On the Total Shift Menu pressing the [Return Value] key returns you to the reference carrier frequency; pressing [Transfer Value] selects the currently displayed frequency as the reference frequency.
- (7) Pressing [SIG GEN] returns you to the Sig Gen menu.

Carrier on/off

The carrier can be switched on or off at any time by means of the [RF ON/OFF] key. This effectively switches the output on and off, retaining the 50 Ω output impedance.

RF level selection

You can enter the RF level in the range -137 to +24 dBm (to +20 dBm above 1.2 GHz).

- (1) Press [SIG GEN] to show the Sig Gen menu with the current RF level displayed.
- (2) Press the [RF Level] soft key to select RF level as the current function.
- (3) Enter the required value using the numerical key pad. For voltage terminate using the [μV], [mV] or [V] key. For logarithmic units terminate using the [dB] key. RF levels in linear and logarithmic units are selected from the utilities (see 'RF level units selection' below). If a value outside the specified range is requested, an error message is displayed and the instrument is automatically set to the end of the range.
- (4) You can then adjust the level either in steps using the [3],[1] keys or by using the control knob for continuous adjustment. The default increment/decrement is 1 dB.
- (5) You can check the current amount of offset from the reference level by pressing [TOTAL Δ]. This causes the *Total Shift Menu* to be displayed.
- (6) Pressing [Return Value] returns you to the reference level; pressing [Transfer Value] selects the currently displayed level as the reference level.
- (7) Pressing [SIG GEN] returns you to the Sig Gen menu.

Choice of units

Units may be μV , mV, V or dB. Conversion between dB and the voltage units is carried out by pressing the appropriate units key, i.e. to change dBm to a voltage unit, press any voltage key for the correct conversion. The choice of Volts EMF, Volts PD and the dB reference is made by using the RF Level Units Selection Menu.

Reverse power protection

Accidental application of power to an individual signal source's RF OUTPUT socket trips the reverse power protection circuit (RPP) and a menu similar to that shown in Fig. 3-9 below appears with a flashing message.

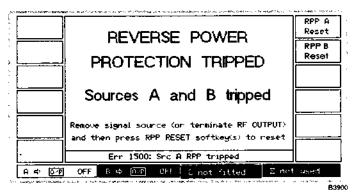


Fig. 3-9 RPP tripped

Note that the protection circuit may be activated when a source is set to a high level and its RF OUTPUT socket has no terminating load.

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The protection circuit can be reset by pressing the [RPP Reset] key for the appropriate source after having either removed the signal to the source or terminated the RF OUTPUT socket. The display then returns to the menu in use at the time that the RPP was tripped. If [RPP Reset] is pressed with the signal still applied, the RPP will trip again.

CAUTION

The maximum reverse power at the CONNECTION TO RADIO socket is 0.5 W.

Modulation selection

The carrier from each signal source can be amplitude, frequency or phase modulated from an internal or external source. Additionally pulse modulation is available from an external source. The internal modulation oscillator is capable of generating two tones simultaneously in one modulation channel and has a frequency range of 0.01 Hz to 20 kHz.

Modulation modes

Each signal source has its own independent modulation facilities. The MOD I/O socket on each of the signal sources allows an external modulation signal to be summed with the signals from the internal oscillator. This allows up to 3 modulations to be available from each source e.g. external FM with a combined internal AM1 and AM2.

Modulation source can be internal or external. If internal, the modulation can be the sum of two signals i.e. AM1 + AM2, FM1 + FM2 or $\phi M1 + \phi M2$, each of which can have its own depth/deviation and modulation frequency.

The common carrier wave can be modulated by two different types of modulation, where one uses an internal source and the other an external source. The internal source may be composed of two signals. Allowed combinations are:

```
internal AM + external FM; internal FM + external AM internal AM + external AM; internal \phiM + external AM
```

Note that pulse modulation may be selected for each signal source in addition to any normal modulation combination.

Mode selection

Modulation mode is selected as follows:-

(1) Press the [UTIL] hard key to display the *Utilities Selection Menu 1* (additionally pressing [Utils Menu 1] if necessary). Then select [Mod'n Mode] to display the Modulation Mode Selection Menu. This shows the currently selected modulation mode (see Fig. 3-10 below) for the selected signal source.

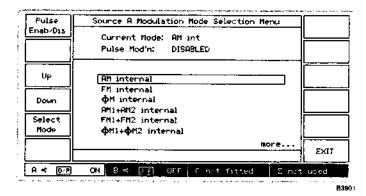


Fig. 3-10 Modulation mode selection menu

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- (2) Use the [Up] and [Down] keys to move the selection box over the required modulation mode. Repeated pressing of the [Down] key will cause the screen to scroll revealing further selections.
- (3) Press [Select Mode]. The display changes to show your new current modulation mode.
- (4) Press [Sig Gen] to display the Sig Gen menu which has been modified to show the new configuration.

Sig gen screens

Changing the modulation mode by means of the Modulation Mode Selection Menu affects the way in which the sig gen screen is presented as follows:

If a single internal modulation mode e.g. AM internal has been selected, the [Select Waveform] key is displayed. This is replaced by the [Select Coupling] key if instead, a single external modulation mode e.g. FM external has been selected.

If a dual internal modulation mode e.g. AMI + AM2 internal has been selected, the modulation field is divided vertically into 2 panels, one for each modulation channel as shown in Fig. 3-11 below.

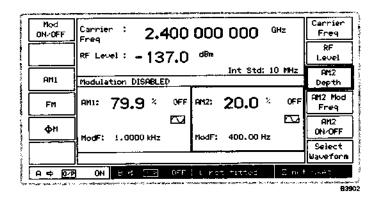


Fig. 3-11 Sig Gen menu with two internal modulation channels

If a dual mixed modulation mode e.g. AM1 internal & FM external has been selected, the modulation field is divided horizontally into 2 panels, one for each modulation source as shown in Fig. 3-12 below.

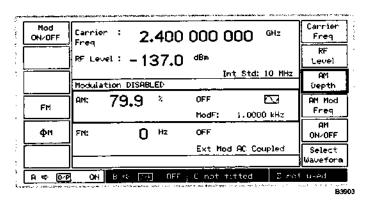


Fig. 3-12 Sig Gen menu with internal and external modulation sources

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Internal waveform selection

Having selected an internal modulation mode, you can select the type of waveform as follows:-

- (1) Press [SIG GEN] to show the Sig Gen menu.
- (2) Press [Select Waveform] to display the Internal Source Waveform Menu. This shows the currently selected modulation and waveform (see Fig. 3-13 below).

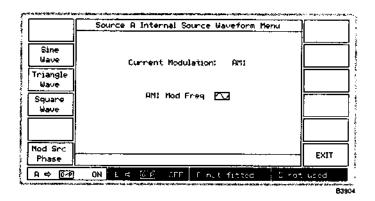


Fig. 3-13 Internal source waveform menu

- (3) Select between [Sine Wave], [Triangle Wave] and [Square Wave]. The waveform on the screen changes to show your new waveform selection.
- (4) Press [EXIT] to return to the Sig Gen menu.

Modulation source adjustment

You can adjust the phase difference of modulation oscillator channel 2 relative to channel 1 in degrees as follows:

(5) Press the [Mod Src Phase] key to display the Modulation Source Phase Adjustment menu shown in Fig. 3-14 below. This shows the currently selected phase difference setting for the selected signal source.

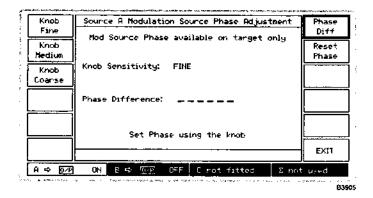


Fig. 3-14 Modulation source phase adjustment menu

(6) Select the required adjustment control by pressing [Knob Fine], [Knob Medium] or [Knob Coarse]. These provide adjustments in steps of 0.1°, 1.0° and 3.0° respectively.

- (7) Press [Phase Diff] and adjust the phase using the control knob. Turn clockwise to advance the phase and anticlockwise to retard the phase. Note that if you have set the source phase and subsequently adjusted the source frequency or changed the waveform, the menu Phase Difference: value will be blanked. This is because the value will then be indeterminate due to the adjustment or changed waveform.
- (8) To establish a reference, the displayed phase shift can be reset to 0.0° by pressing [Reset Phase].
- (9) Press [EXIT] to return to the Sig Gen menu.

External source coupling

Having selected an external modulation mode, you can select the type of external coupling as follows:-

- (1) Press [SIG GEN] and show the Sig Gen menu for a single modulation mode.
- (2) Press [Select Coupling] to display the External Source Coupling Menu. This shows the currently selected modulation and external coupling (see Fig. 3-15 below).

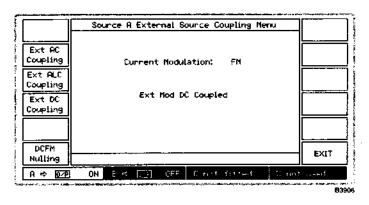


Fig. 3-15 External source coupling menu (the [DCFM Nulling] key only appears during FM external modulation mode with DC coupling)

- (3) Select between [Ext AC Coupling], [Ext ALC Coupling] and [Ext DC Coupling]. The screen changes to show your new coupling selection.
- (4) Apply a signal to the MOD I/O socket.
- (5) When Automatic Levelling Control is selected by pressing [Ext ALC Coupling], and the error message Err 511: ALC too high or Err:512: ALC too low is displayed, the level must be adjusted. Adjust the signal level until it is within the 0.75 to 1.25 V RMS ALC range of the source.
- (6) Press [EXIT] to return to the Sig Gen menu.

DCFM nulling

For a DC-coupled external signal, small frequency offsets can be reduced by using the DCFM nulling facility. Operation is as follows:

- (1) With FM External mode previously selected from the Modulation Mode Selection Menupress the [Ext DC Coupling] key shown in Fig. 3-15 above.
- (2) Connect your ground reference to the MOD I/O socket.
- (3) Press the [DCFM Nulling] key which is now displayed. * DCFM Nulling * appears during the nulling process and when it disappears the process is completed.

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Modulation ON/OFF

[Mod ON/OFF] switches all modulation ON or OFF and the condition is indicated in the centre of the Sig Gen menu:-

Modulation DISABLED

Modulation is also controlled by the individual modulation ON/OFF keys. For modulation to appear on the carrier, modulation must be both enabled with the [Mod ON/OFF] key and the individual [AM ON/OFF], [FM ON/OFF], [\piM ON/OFF] and [Pulse ON/OFF] keys. The individual modulation ON/OFF keys only reduce the modulation to zero, whereas the [Mod ON/OFF] key completely disables the modulation system so that the instrument reverts to a carrier frequency generator.

Amplitude modulation selection

Select amplitude modulation as follows:-

- Press [SIG GEN] to show the Sig Gen menu with the current modulation displayed in the bottom half of the screen.
- (2) Press the [AM] soft key if displayed (otherwise the instrument is already in the AM mode).
- (3) Press[AM Depth]. Enter the modulation depth using the numerical key pad and terminate with any [ENTER] key. If you exceed the 99.9% modulation limit it is automatically reset to the maximum allowed value.
- (4) If the internal modulation is to be the sum of two internal signals, select AMI + AM2 internal from the utilities (see 'Mode selection' below). A typical display is shown in Fig. 3-16 below. Press the [AM2] key to select the second signal. Press the [AM2 Depth] key and enter the required modulation depth for the second signal. If you exceed the (99.9% AM1) modulation depth limit, it is automatically reset to the maximum allowed value.

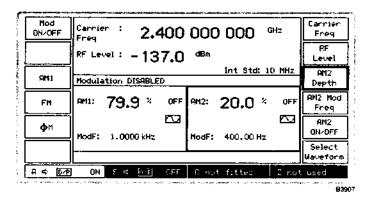


Fig. 3-16 Sig Gen menu with two modulation channels

- (5) Select [AM Mod Freq], enter the modulation frequency and terminate with the [Hz] or [kHz] key. If you exceed the 20 kHz modulation limit it is automatically reset to the maximum allowed value.
- (6) If required, change the waveform from that shown on the display (see 'Internal waveform selection' below).
- (7) Press [AM ON/OFF] to toggle between the on and off states as shown by the display.

Frequency modulation selection

Select frequency modulation as follows:-

- Press [SIG GEN] to show the Sig Gen menu with the current modulation displayed in the bottom half of the screen.
- (2) Press the [FM] soft key if displayed (otherwise the instrument is already in the FM mode).
- (3) Press [FM Devn]. Enter the deviation using the numerical key pad and terminate with the [Hz] or [kHz] key. If you exceed the 100 kHz deviation limit it is automatically reset to the maximum allowed value.
- (4) If the internal modulation is to be the sum of two signals, select FM1 + FM2 internal from the utilities (see 'Mode selection' below). A typical display is shown in Fig. 3-16 above. Press the [FM2] key to select the second signal. Press the [FM2 Depth] key and enter the required deviation for the second signal. If you exceed the (100 kHz FM1) deviation limit, it is automatically reset to the maximum allowed value.
- (5) Select [FM Mod Freq], enter the modulation frequency and terminate with the [Hz] or [kHz] key. If you exceed the 20 kHz modulation limit it is automatically reset to the maximum allowed value.
- (6) If required, change the waveform from that shown on the display (see 'Internal waveform selection' below).
- (7) Press [FM ON/OFF] to toggle between the on and off states as shown by the display.

Phase modulation selection

Select phase modulation as follows:-

- (1) Press [SIG GEN] to show the Sig Gen menu with the current modulation displayed in the bottom half of the screen.
- (2) Press the $[\phi M]$ soft key if displayed (otherwise the instrument is already in the ϕM mode).
- (3) Press [φM Devn]. Enter the deviation using the numerical key pad and terminate with the [rad] key. If you exceed the 10 rad deviation limit it is automatically reset to the maximum allowed value.
- (4) If the internal modulation is to be the sum of two signals, select φM1 + φM2 internal from the utilities (see 'Mode selection' below). A typical display is shown in Fig. 3-16 above. Press the [φM2] key to select the second signal. Press the [φM2 Depth] key and enter the required deviation for the second signal. If you exceed the (10 rad φM1) deviation limit, it is automatically reset to the maximum allowed value.
- (5) Select [opt Mod Freq], enter the modulation frequency and terminate with the [Hz] or [kHz] key. If you exceed the 20 kHz modulation limit it is automatically reset to the maximum allowed value.
- (6) If required, change the waveform from that shown on the display (see 'Internal waveform selection' below).
- (7) Press [\phiM ON/OFF] to toggle between the on and off states as shown by the display.

Pulse modulation selection

Pulse modulation may be selected in addition to any other normal modulation modes. The source is external from any of the PULSE INPUT sockets. Select pulse modulation as follows:-

- (1) Press [UTIL] to display the *Utilities Selection Menu 1*. If the *Utilities Selection Menu 2* is displayed, it will be necessary to press the [Utils Menu 1] key.
- (2) Select [Mod'n Mode] to display the Modulation Mode Selection Menu.
- (3) Press the [Pulse Enab/Dis] key to toggle between the ON and OFF states until the display shows Pulse Mod'n: ENABLED.

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- (4) Press [SIG GEN] to return to the Sig Gen menu.
- (5) Press [Pulse ON/OFF] to toggle between the ON and OFF states until the display shows Pulse ON.

When ON the carrier is controlled by the logic level applied to the PULSE INPUT socket. A logical '1' (a voltage between 3.5 and 5 V) allows carrier output, a logical '0' (a voltage between 0 and 1.0 V) suppresses it. Turning pulse mod OFF effectively applies a logical '1' allowing carrier output.

FSK selection

The instrument accepts logic level inputs to the AUXILIARY PORT connector to produce an FSK modulated output signal from each source. The input data is sampled at 100 kHz and produces a 2- or 4-level shift waveform which is filtered by a 20 kHz Bessel filter and applied to the carrier. Frequency shift keying is selected as follows:

- (1) Press [UTIL] to display the *Utilities Selection Menu 1*. If the *Utilities Selection Menu 2* is displayed, it will be necessary to press the [Utils Menu 1] key.
- (2) Select [Mod'n Mode] to display the Modulation Mode Selection Menu.
- (3) Use the [Up] and [Down] keys to move the selection box over the required 2FSK or 4FSK modulation mode.
- (4) Press [Select Mode]. The display changes to show your new current modulation mode.
- (5) Press [Sig Gen] to display the Sig Gen menu. This has been modified to show either 2 level FSK - Ext source or 4 level FSK - Ext source in the modulation field (see Fig. 3-17 below).

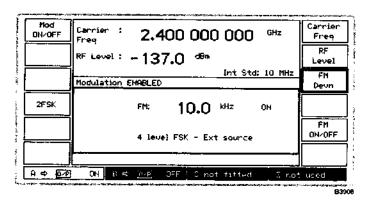


Fig. 3-17 Sig Gen menu with 4FSK selected

- (6) Press [FM Devn], enter the required deviation and terminate with the [Hz] or [kHz] key. If you exceed the 100 kHz deviation limit the entered value is automatically reset to the maximum allowed value.
- (7) If FSK is turned off (either locally with [FM ON/OFF] or globally with [Mod ON/OFF]) no frequency shift is applied to the carrier.

For information on the use of the AUXILIARY PORT connector for FSK operation see Chap. 2 'Auxiliary port connector' and 'FSK operation'.

Sweep

The sweep capability allows the comprehensive testing of systems, since measurements at single points will not necessarily give an overall indication of the performance. The sweep function is specified by the following parameters:

- Start frequency
- Stop frequency
- · Size of step
- Time per step

The sweep can be operated in single shot or continuous modes with the start command triggered by a key press, an external pulse or GPIB control. Once started, the sweep can be stopped at any time when the display will indicate the current parameter value.

Sweep operation

(1) Press the [SWEEP] key which causes the Sweep Control screen to be displayed. In fixed, non-sweep, mode the screen is similar to that shown in Fig. 3-18 below. In sweep mode the screen changes similar to that shown in Fig. 3-20.

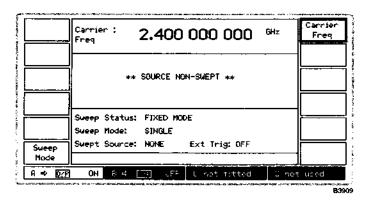


Fig. 3-18 Sweep control screen in fixed mode

(2) Press [Sweep Mode] to display the Carrier Sweep Mode menu shown in Fig. 3-19 below.

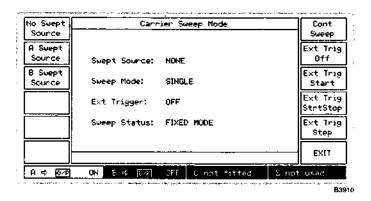


Fig. 3-19 Carrier sweep mode menu

- (3) Select the A or B source for sweeping by pressing the appropriate [A Swept Source] or [B Swept Source] key.
- (4) Select the sweep mode between single shot and continuous sweeping by pressing the [Sweep] key which toggles between [Single Sweep] and [Cont Sweep].
- (5) For external triggering press [Ext Trig Off] to inhibit the external trigger or press one of the following keys to select the appropriate trigger mode:
 - [Ext Trig Start] The first trigger input causes the carrier sweep to commence sweeping.

 Any other trigger inputs whilst sweeping are ignored. Only at the end of each sweep is the trigger latch reset ready for the next input.
 - [Ext Trig StrtStop] The first trigger input starts the carrier sweep and the following trigger input pauses it, so that the user can investigate a particular point of interest. The next trigger input continues the sweep from where it was paused. At the start of each sweep the trigger latch is reset ready for the next input.
 - [Ext Trig Step] Each trigger input steps the sweep on by one frequency step. The trigger latch is reset after each step ready for the next step.
- (6) Pressing [No Swept Source] disables sweep mode.
- (7) If no source has been selected for sweeping, pressing [EXIT] will return you to the Carrier Sweep Mode Menu. Otherwise, the Sweep Control screen will be displayed.

Sweep control

(8) The Sweep Control screen displayed is similar to that shown in Fig. 3-20 below. This is used to perform the sweeping operation.

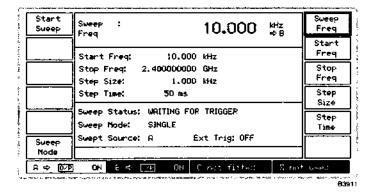


Fig. 3-20 Sweep control screen in sweep mode (with the B source coupled to the A source)

- (9) Enter the sweep start and stop frequencies using the [Start Freq] and [Stop Freq] keys.
- (10) Press [Step Size] and enter the step size in the range 1 Hz to the instrument maximum frequency, to a resolution of 1 Hz.
- (11) Press [Step Time] and enter the step time in the range 50 ms to 10 s to a resolution of 1 ms.
- (12) To start the sweep press [Start Sweep]. The key changes its function to [Stop Sweep] and Sweep Status changes from WAITING FOR TRIGGER to SWEEPING. The displayed Sweep Freq changes to show the progress of the sweep.
- (13) The sweep can be stopped at any time by pressing [Stop Sweep]. This causes the key function to change to [Continue Sweep] and Sweep Status changes to PAUSED.
- (14) Whilst the sweep is paused you can adjust the frequency by selecting [Sweep Freq] then using the control knob to look at a particular frequency of interest. Pressing [Transfer] followed by [Continue Sweep] causes the sweep to continue from your adjusted frequency.

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- Otherwise simply pressing [Continue Sweep] restarts the sweep from where it was paused. Pressing [Reset Sweep] discontinues the sweep and resets it to the start frequency.
- (15) At the end of a single sweep, the stop frequency is shown and the key function changes to [Start Sweep] with SWEEP COMPLETE displayed. For continuous sweep, the sweep automatically recommences from the start frequency.
- (16) To change the sweep mode, press the [Sweep Mode] key which returns you to the Carrier Sweep Mode menu.

Utilities

Utility menu selection

Pressing the [UTIL] key gains access to the utilities options from two primary menus, Utilities Selection Menu 1 and Utilities Selection Menu 2. When a selection is made from either of these menus and [UTIL] is subsequently pressed, the primary menu is re-displayed. However, if instead a selection is made and then one of the other hard keys e.g. [MEM] is pressed, pressing [UTIL] subsequently once return to the sub-menu, pressing it again returns to the primary menu. This provides an operating short-cut in that it allows you to re-access a sub-menu without first having to go again through the primary menu.

Selection menu 1

The display for Utilities Selection Menu 1 is shown in Fig. 3-21 below.

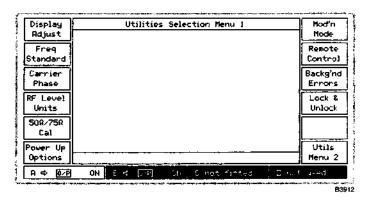


Fig. 3-21 Utilities selection menu I

To obtain Utilities Selection Menu 2 from the menu, select [Utils Menu 2].

Display adjustment (menu 1)

You can set the display contrast and brightness to suit your individual preferences using this utility. The setting can then be saved for automatic recall whenever the instrument is switched on. Proceed as follows:

(1) Select (Display Adjust) to call up the Display Adjustment Utility shown in Fig. 3-22 below.



Fig. 3-22 Display adjustment utility

- (2) Set the required brightness by pressing [Dim], [Medium] or [Bright]. You can then adjust the contrast by means of the control knob.
- (3) Once adjusted, the display setting can be stored in the non-volatile memory by pressing [Save LCD Setting]. The setting will be subsequently recalled on power-up.
- (4) Press [EXIT] to return to the Utilities Selection Menu 1.

Frequency standard selection (menu 1)

This utility enables you to select a 10 MHz output as a standard for use with associated equipment. It also enables you to select a standard (either external or internal) for use by the instrument. When an external standard is selected, the internal TCXO is locked to the external standard using a phase locked loop. For a 10 MHz standard, the menu allows you to select between direct and indirect. When direct is selected the internal standard for the RF trays is provided directly from the external standard. When indirect is selected this standard is provided from the TCXO locked to the external standard. Frequency standard selection is as follows:

 Select [Freq Standard] to display the Frequency Standard Selection Menu shown in Fig. 3-23 below. This shows the currently selected standard.

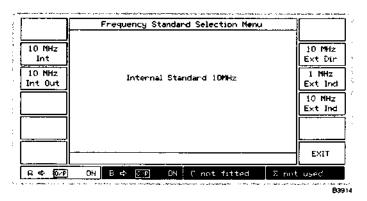


Fig. 3-23 Frequency standard selection menu

- (2) Select the internal standard for the instrument by pressing [10 MHz Int].
- (3) To provide an externally generated 1 or 10 MHz standard for the instrument, connect the signal to the rear panel EXT STD I/P socket. Then choose one of the three external standards [10 MHz Ext Dir], [1 MHz Ext Ind] or [10 MHz Ext Ind]. You should choose

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[10 MHz Ext Dir] if your provided 10 MHz standard is better than that fitted in the instrument.

- (4) To obtain an internally generated 10 MHz standard from the instrument's INT STD O/P socket, select (10 MHz Int Out).
- (5) Press [EXIT] to return to the Utilities Selection Menu 1.

Carrier phase adjustment (menu 1)

You can adjust the phase offset of the carrier with respect to its current phase in degrees as follows:

(1) Press [Carrier Phase] to display the Carrier Phase Adjustment Utility shown in Fig. 3-24 below. This shows the currently selected phase offset for the selected signal source.

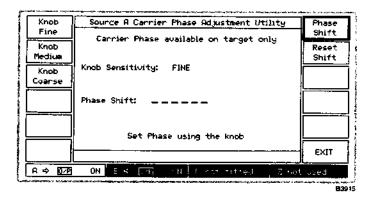


Fig. 3-24 Carrier phase adjustment utility

- (2) Select the required adjustment control by pressing [Knob Fine], [Knob Medium] or [Knob Coarse]. These provide adjustments in steps of 0.09°, 0.9° and 2.7° respectively.
- (3) Press [Phase Shift] and adjust the carrier phase using the control knob. Turn clockwise to advance the phase and anticlockwise to retard the phase. Note that if you have set the carrier phase and subsequently adjusted the carrier frequency, the menu Phase Shift: value will be blanked. This is because the value will then be indeterminate due to the adjustment.
- (4) To establish a reference the displayed phase shift can be reset to 0.00° by pressing [Reset Shift]. But note that this does not reset the actual phase shift, only the displayed value is reset to provide a new reference.
- (5) Press [EXIT] to return to the Utilities Selection Menu 1.

RF level units selection (menu 1)

RF output level units may be changed as follows:

 Press [RF Level Units] to display the RF Level Units Selection Menu which shows the current selection (see Fig. 3-25 below).

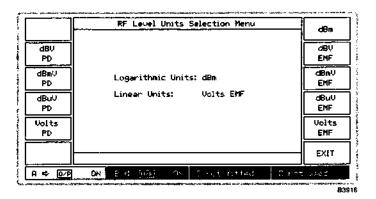


Fig. 3-25 RF level units selection menu

- (2) Select between linear and logarithmic units in EMF or PD. Logarithmic units may be referred to volts (dBV), millivolts (dBmV), microvolts (dBμV) or to 1 millivolt into 50 Ω (dBm).
- (3) Press [EXIT] to return to the Utilities Selection Menu 1.

50 Ω /75 Ω impedance selection (menu 1)

The performance specification of each signal source assumes operation into $50~\Omega$ loads. By means of this menu in association with a $75~\Omega$ adapter (see 'Versions, options and accessories' in Chap. 1) you can select operation into $75~\Omega$ loads whilst maintaining correct voltage calibration. It also enables the reverse power protection circuit to function correctly. But note that in the event of an overload the RPP will function but the adapter will NOT be protected. Proceed as follows:

Press [50Ω/75Ω Cal] to display the 50 Ohm/75 Ohm Calibration Menu shown in Fig. 3-26 below.

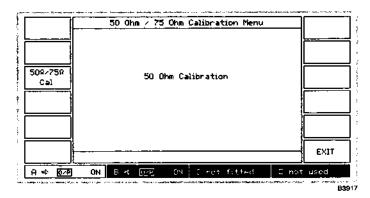


Fig. 3-26 50 ohm/75 ohm calibration menu

- (2) Press [50Ω/75Ω Cal] which toggles between 50 Ohm Calibration and 75 Ohm Calibration as shown by the screen. Note that all RF OUTPUT sockets, including the combiner's CONNECTION TO RADIO, will change calibration.
- (3) For 75 Ω operation connect a 50 Ω /75 Ω adapter to the front panel RF OUTPUT socket for each appropriate signal source. Whenever the impedance is changed, the value of the displayed level is adjusted (by 5.7 dB) to the level at the output from the adapter.
- (4) Press [EXIT] to return to the Utilities Selection Menu 1.

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Power-up options (menu 1)

The instrument can power-up in one of two states; with the factory settings or with the settings of your choice stored in one of the full memory locations. Selection is made as follows:

(1) Press [Power Up Options] to display the Power Up Options Menu shown in Fig. 3-27 below. This shows the currently selected power-up choice.

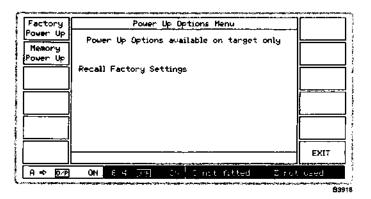


Fig. 3-27 Power up options menu

- (2) Press [Factory Power Up] to select the factory power-up settings (these are listed in Table 3-1 below). Otherwise press [Memory Power Up] to store the current settings as your selected power-up state.
- (3) Press [EXIT] to return to the Utilities Selection Menu 1.

Default settings

The instrument is reset to the factory default settings in the following cases:

- (1) At power-up to factory default settings.
- (2) Following execution of the *RST command.
- (3) When [Factory Recall] is pressed on the Memory Recall Menu.

The default settings are shown in Table 3-1.

Table 3-1 Instrument default settings

Source selected	Source A
Carrier frequency : Step :	(Maximum available) 2.4 GHz 1 kHz
RF level Step :	-137 dBm 1 dB Status: ON
Modulation mode	Internal FM, modulation disabled
Modulations :	FM1 : Deviation: 0 Hz, OFF : Internal source, frequency: 1 kHz, sine
	FM2 : Deviation: 0 Hz, OFF : Internal source, frequency: 400 Hz, sine
	ΦM1 : Deviation: 0 rad, OFF: Internal source, frequency: 1 kHz, sine
	ΦM2 : Deviation: 0 rad, OFF: Internal source, frequency: 400 Hz, sine
	AM1 : Deviation: 0%, OFF : Internal source, frequency: 1 kHz, sine
	AM2 : Deviation: 0%, OFF : Internal source, frequency: 400 Hz, sine
	Puise : OFF :
Modulation steps:	ΔFM 1 kHz, ΔΦM 0.1 rad, ΔAM 1%
Mod frequency steps :	10 Hz
Carrier sweep Freg mode :	Fixed
Mode:	Single sweep
Ext trigger :	Off
Start :	10 kHz
Stop:	(Maximum available)
Step_size :	1 kHz
Time :	50 ms

Modulation mode selection (menu 1)

Modulation mode is selected by pressing [Mod'n Mode] to display the Modulation Mode Selection Menu shown in Fig. 3-28 below. Using the menu is explained under 'Modulation mode selection' above.

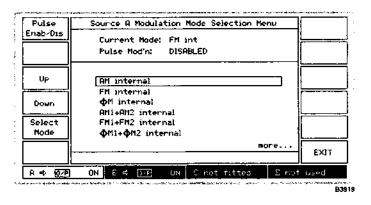


Fig. 3-28 Modulation mode selection menu

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Remote control selection (menu 1)

The remote mode of operation is selected as follows:-

 Select [Remote Control] to display the Remote Control Utility. This shows the currently selected remote mode (see Fig. 3-29 below).

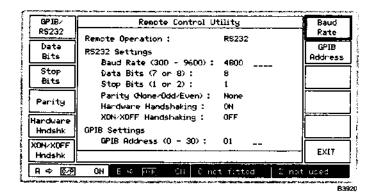


Fig. 3-29 Remote control utility

(2) Press [GPIB/RS232] to toggle between GPIB and RS232.

GPIB mode

(3) Press [GPIB Address] and enter the address which must be unique on the system to the instrument and within the range 0 to 30.

RS-232 mode

- (3) Press [Data Bits] to toggle between 7 and 8 data bits.
- (4) Press [Stop Bits] to toggle between 1 and 2 stop bits.
- (5) Press [Parity] to cycle through the selections None, Odd, Even.
- (6) Press [Hardware Hndshk] and [XON/XOFF Hndshk] to select any combination between both OFF to both ON.
- (7) Press [Baud Rate] and set the baud rate in the range 300 to 9600 bit/s. But note that if the entered value is not one of the following standard settings, the next higher value will be selected by default.

(8) Press [EXIT] to return to the Utilities Selection Menu 1.

Background error reporting (menu 1)

Background errors are generated due to an incorrect operating condition within the instrument. These error messages are generated automatically to warn the operator. Although there is only room to display one message in the error message field of the displays, this utility enables a complete list of the current background errors to be shown. Proceed as follows:

 Press [Backg'nd Errors] which causes the Current Background Errors display similar to that in Fig. 3-30 below to be shown. The errors are shown in priority order.

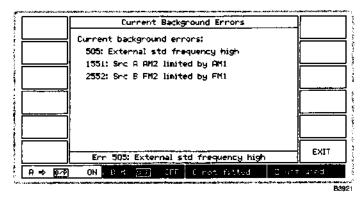


Fig. 3-30 Current background errors display (showing example errors)

- (2) Where there are more background errors than can be displayed on one screen page, the [Next Page] and [Previous Page] soft keys will be displayed to enable more than one page of errors to be viewed.
- (3) Press [EXIT] to return to the Utilities Selection Menu 1.

Protection locking and unlocking (menu 1)

To prevent accidental interference with the contents of internal memories, internal data is protected by secure key sequences. There are two levels of protection. The most secure, Level 2, is used for memory erasure, elapsed time reporting and for servicing purposes such as altering the calibration data of the instrument. Level 1 protection is used for display blanking and memory protection.

The lock and unlock utility is selected as follows:

(1) Select [Lock & Unlock] to display the Lock & Unlock Utility. When Level 1 and Level 2 are both locked the display will be similar to Fig. 3-31 below.

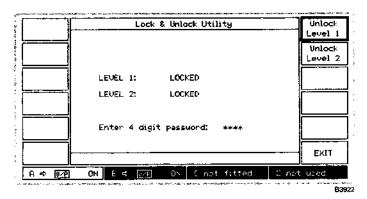


Fig. 3-31 Lock and unlock utility (during password entry)

- (2) To unlock to Level 1 press [Unlock Level 1] and enter a 4-digit password (the default is 1234). As each digit is entered an asterisk is displayed. Terminate with [ENTER].
- (3) To unlock to Level 2 press [Unlock Level 2] and enter a 6-digit password (the default is 123456). As each digit is entered an asterisk is displayed. Terminate with [ENTER].
- (4) When successful, UNLOCKED is displayed on the screen against the appropriate level and the [Unlock Level 1] or [Unlock Level 2] key is blanked. If the entered password is not recognised by the instrument the password will have been changed by operating personnel.

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- (5) To lock the instrument, press the appropriate [Lock Level 1] or [Lock Level 2] key.
- (6) Press [EXIT] to return to the Utilities Selection Menu 1.

Note

If you have lost or forgotten the password contact our Service Division or nearest agent (for address see inside rear cover). You will be required to give the instrument serial number.

Selection menu 2

Press the [Utils Menu 2] on the Utilities Selection Menu 1 to obtain the display for Utilities Selection Menu 2 as shown in Fig. 3-32 below. Some of the items on this menu are intended for use in servicing and are described in the Service Manual.

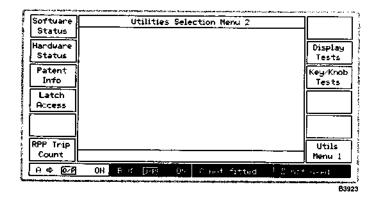


Fig. 3-32 Utilities selection menu 2 (some of these keys only appear when unlocked to the appropriate Level)

To obtain Utilities Selection Menu 1 from the menu, select [Utils Menu 1].

Software information (menu 2)

You can obtain a description of the instrument's software by pressing [Software Status] which causes Fig. 3-33 below to be displayed. This shows the software version and date as well the EPROM part number.

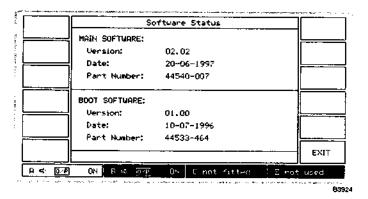


Fig. 3-33 Software status display

(1) Press [EXIT] to return to the Utilities Selection Menu 2.

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Hardware information (menu 2)

You can obtain a description of the instrument's hardware by pressing [Hardware Status] which causes Fig. 3-34 below to be displayed. This shows the instrument type and serial number as well as options fitted.

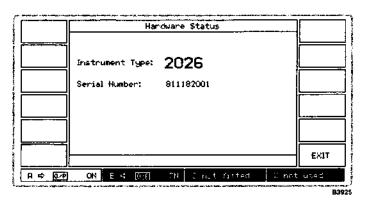


Fig. 3-34 Hardware status display

(1) Press [EXIT] to return to the Utilities Selection Menu 2.

Patent information (menu 2)

To obtain the more important patent information, press [Patent Info] which causes Fig. 3-35 below to be displayed.

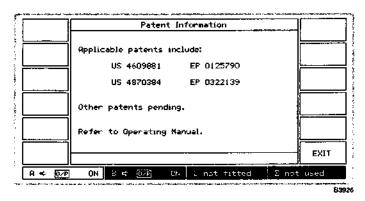


Fig. 3-35 Patent information display

- (1) For a full list of patents refer to 'Patent protection' in the Preface.
- (2) Press [EXIT] to return to the Utilities Selection Menu 2.

Display blanking (menu 2)

This facility is used to prevent sensitive data from being displayed. It allows various parts of the display to be replaced by a series of dashes so that values entered by the user or recalled from the memory will not be visible.

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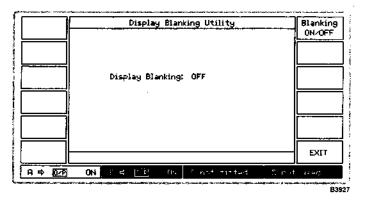


Fig. 3-36 Display blanking utility

- (1) Unlock the protection to Level 1 by means of the Lock & Unlock Utility (menu 1).
- (2) Press [Display Blanking] which causes the screen shown in Fig. 3-36 above to be displayed.
- (3) To blank the screen press the [Blanking ON/OFF] key which toggles between the on and off states
- (4) Press the [SIG GEN] key to display the main screen. Here it can be seen that the main parameters are blanked and replaced by dashes. This also applies to the parameters displayed on the Sweep Control screen.
- (5) Press [EXIT] to return to the Utilities Selection Menu 2.

Latch access utility (menu 2)

This utility is intended for use as a diagnostic aid by allowing data to be sent to latches within the instrument. For further information consult the Service Manual. The menu is shown in Fig. 3-37 below.

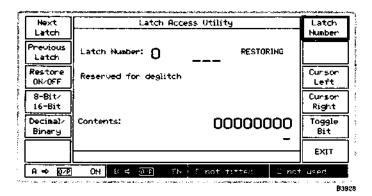


Fig. 3-37 Latch access utility

Elapsed time (menu 2)

The elapsed time facility displays the total number of operating hours as well as the number of elapsed operating hours since the last reset by the [Reset Elapsed] key. This facility can be used to assess the instrument's operational reliability and utilisation. To use this facility the instrument must be unlocked to Level 2. The screen is shown in Fig. 3-38 below.

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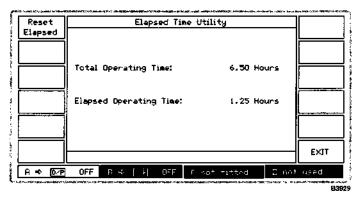


Fig. 3-38 Elapsed time utility

RPP trip count utility (menu 2)

This utility lists the number of times each of the fitted sources has tripped. The screen is shown in Fig. 3-39 below.

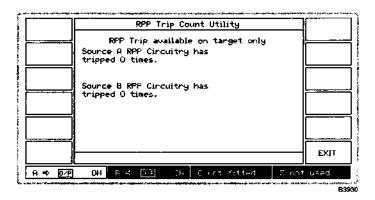


Fig. 3-39 RPP trip count utility

Display test utility (menu 2)

This utility provides a simple test of the display. The screen is shown in Fig. 3-40 below.

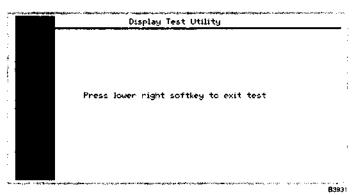


Fig. 3-40 Display test utility

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Key/knob tests (menu 2)

In this utility the user is invited to operate the keys and control knob whilst checking the reaction of the instrument. The screen is shown in Fig. 3-41 below.

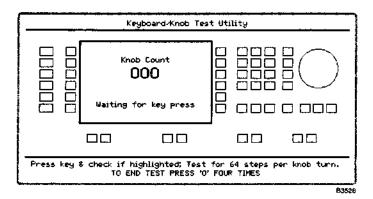


Fig. 3-41 Keyboard/knob test utility

Calibration utility (menu 2)

This menu shows when each individual item was last adjusted and enables you to enter the date of the current adjustment. The instrument must be unlocked to Level 2 to use this utility. Full details regarding calibration can be found in the Service Manual. The first page of the menu is shown in Fig. 3-42 below.

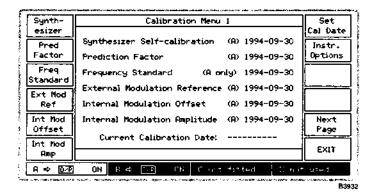


Fig. 3-42 Calibration menu

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Memory

Memory stores

There are three types of store: carrier, full and RAM. Both carrier and full stores are non-volatile. The contents of the RAM store are lost when the instrument is switched off.

Each type of store holds the data for all fitted sources.

Carrier store

The non-volatile carrier frequency store has 100 locations numbered 0 to 99 for the storage of carrier frequency only. This store can be used to apply a set of test conditions to a range of frequencies. For example, if you wish to use the same modulation at a variety of frequencies you can use the carrier store to set the instrument to each of the frequencies in turn. When a carrier store is used it will only replace the current carrier frequency - all the other settings will remain unchanged.

Full store

The non-volatile full store has 100 locations numbered 0 to 99 for the storage of instrument settings. This store is used to store those parameters which currently affect the RF output; carrier frequency, RF level, modulations in use, on/off and source information and the two modulation oscillator frequencies in use.

A full store contains the following information:

Carrier frequency setting
Carrier frequency step size
RF level setting
RF level step size
All modulation settings
All modulation step sizes
Modulation mode and status
The active modulation frequencies
The modulation frequency step size
All sweep settings

RAM store

The volatile RAM store has locations numbered from 0 to 99 for the full storage of instrument settings. The parameters stored are the same as those for the full store. However, the RAM store has no long term wear-out mechanism and is therefore recommended for use in ATE programs where all the settings to be used in a test sequence are initially declared and then recalled. This results in a reduction of the GPIB/RS-232 overhead.

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Storing data

Select the memory store function as follows:

(1) Press the [MEM] hard key and then, if necessary, press the [Store/Recall] soft key to display the Memory Store Menu shown in Fig. 3-43 below.

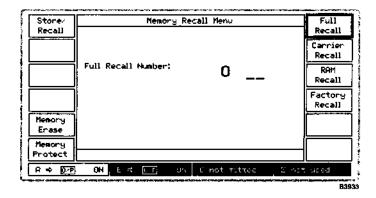


Fig. 3-43 Memory store menu

(2) To store data, press the [Full Store], [Carrier Store] or [RAM Store] key for the type of store required, then enter the store location via the numerical key pad and terminate with [ENTER].

Note that memory erasure requires unlocking to Level 2 (see 'Protection locking and unlocking' above).

Memory protection

Memory stores may be protected against accidental overwriting of the contents.

Memory protection summary

(1) To see which store locations are protected (or unprotected), press the [Memory Protect] key. If the instrument is in the protection locked state, the Memory Write Protection Summary shown in Fig. 3-44 below is displayed. Otherwise Fig. 3-45 below is shown.

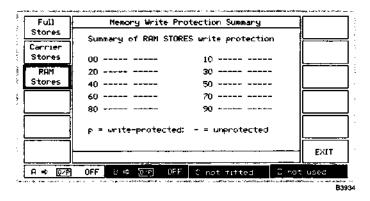


Fig. 3-44 Memory write protection summary

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- (2) From the summary, select the type of memory stores to be displayed by selecting between [Full Stores], [Carrier Stores] and [RAM Stores]. An unprotected store is indicated by a dash (-), a protected store is indicated by the letter p.
- (3) Press [EXIT] to return to the Memory Store Menu.

Memory protection menu

(4) To change the write protection, the instrument must be unlocked to Level 1 (see 'Protection locking and unlocking' above). Subsequently pressing [Memory Protect] causes the Memory Write Protection Menu similar to that shown in Fig. 3-45 below to be displayed.

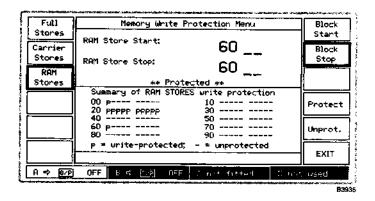


Fig. 3-45 Memory write protection menu

- (5) Select the type of memory stores to be changed by selecting between [Full Stores], [Carrier Stores] and [RAM Stores]. An unprotected store is indicated by a dash (-), a protected store is indicated by the letter p.
- (6) To change the protection for a memory block enter the [Block Start] and [Block Stop] numbers. For a single store make both numbers the same.
- (7) Select [Protect] or [Unprot.] as required. This action is acknowledged by the message ** Protected ** or ** Unprotected ** appearing respectively.
- (8) Press [EXIT] to return to the Memory Store Menu.

Note that at power-on the volatile RAM stores are unprotected to allow immediate use.

Memory recall

There are three types of recall: carrier, full and RAM. Both carrier and full stores are non-volatile. The contents of the RAM store are lost when the instrument is switched off.

Carrier recall

The non-volatile carrier frequency store has 100 locations numbered 0 to 99 for carrier frequency only. These can be recalled and used in conjunction with full recall to apply a set of test conditions to a range of frequencies.

Full recall

The non-volatile store has 100 locations numbered 0 to 99 for the storage of instrument settings. These stores may be recalled and used to reset the instrument's parameters to those which affect the RF output: carrier frequency, RF level, modulations in use, on/off and source information and the two modulation oscillator frequencies in use.

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RAM recall

The volatile RAM store has 100 locations numbered 0 to 99 for the full storage of instrument settings. The parameters that are recalled are the same as those for full recall.

Recalling data

Select the memory recall function as follows:

(1) Press the [MEM] hard key and then, if necessary, press the [Store/Recall] soft key to display the Memory Recall Menu shown in Fig. 3-46 below.

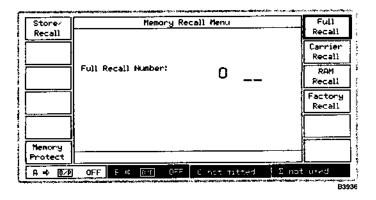


Fig. 3-46 Memory recall menu

- (2) To recall data, press the [Full Store], [Carrier Store] or [RAM Store] key for the type of recall required, then enter the store location via the numerical key pad and terminate with [ENTER].
- (3) Pressing [Memory Protect] causes a Memory Write Protection screen to be displayed. For details of displaying the stores and changing their protection states see 'Memory protection' above.
- (4) Press [Factory Recall] to set the instrument to the factory settings (these are listed in Table 3-1 above).

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Error messages

Error handling

Error messages are divided into four groups:

Background errors - represent a condition of the instrument.

(2) Foreground errors - generally caused by the user.

(3) GPIB errors - generated by incorrect programming.

(4) Fatal errors - caused by failure associated with the main RAM or the

PROM. These errors may or may not be displayed according to the severity of the failure or corruption.

Background errors:

These are generated due to an incorrect operating condition within the instrument. These errors are generated automatically to warn the operator. For example if the reverse power protection circuit should trip the message: Err 500: RPP tripped will be displayed on the main screen. Background errors are listed in Table 3-2. Only one error will be displayed, that with the highest priority. To obtain a full list of errors occurring on your instrument in priority order, select [Backg'nd Errors] from the Utilities Selection Menu 1. This causes the Current Background Errors screen to be displayed (see Fig. 3-30). Select [Next Page] if the list is continued on a subsequent page.

Foreground errors:

These are typically generated when an entered parameter value is outside the valid range or for some other invalid operation. For example trying to set the carrier frequency above or below the specified range will display the following message *Err 100: Carrier limit* on the screen. The foreground errors are cleared upon function selection or by re-entering the parameter correctly. Foreground errors are listed in Table 3-3.

Error message priority:

A background error has a priority bit set which is used to determine which message needs to be displayed. A foreground error will temporarily overwrite the background error if currently displayed, but will return to displaying that error once the foreground error has been cleared.

GPIB errors

When an error occurs the error number is put into the error queue and the error message is displayed. Clearing the error message from the screen does not clear the error queue, which is only cleared by the GPIB command ERROR? query, which returns the error at the head of the queue, or by the *CLS command which clears the whole error queue. GPIB errors are listed in Table 3-4.

The queue holds a maximum of 64 error message error numbers. If an error occurs while the queue is full the last error number is replaced with 399 to indicate that the queue is full. The ERROR? query returns a value of 399 for queue full and 0 for queue empty.

When an error number is written into the queue, a bit (<erb>) in the status byte register is set, and an appropriate bit in the standard event register is also set (one of <crme>, <exe>, <dde> or <qye>). These errors will also generate SRQ if the relevant bit in the status register is set. Many background errors are also reported in the Hardware and Coupling Status Registers.

Source specific errors

Where it is necessary to identify the signal source causing an error, the error message number has 1000 or 2000 added to it for the A or B source respectively. Thus error number 2500 indicates that the B source has tripped the reverse power protection circuit.

Table 4-2 Background errors (500 - 599) in priority order

-	. :	-	591	fil	Main PROM faulty
590	ft!	Main RAM faulty	! -	-	•
-	-	-	i - l	- 1	•
٠,	-	-	-	- '	-
-	-	-		•	
500	dde !	RPP tripped ‡	501	dde	Fractional-N loop low ‡
502	dde	Fractional-N loop high ‡	503	dde	Ext standard missing
504	dde	External std frequency low	505	dde	External std frequency high
506	dde	VCXO loop low ‡	507	dde	VCXO loop high ‡
508	dde	Amplitude mod unlevelled ‡	509	dde	Output unlevelled ‡
510	dde	High power amplifier failed ‡	511	dde	ALC too high ‡
512	dde	ALC too low ‡	513	dde	DSP not responding ‡
}	-	-	-	-	<u> </u>
-	- 1	•	- [-	-
- 1	-		549	exe	RF level uncalibrated ‡
550	exe	RF level limited by AM ‡	551	exe	AM2 limited by AM1 ‡
552	exe	FM2 limited by FM1 ‡	553	exc	ΦM2 limited by ΦM1 ‡
554	-	•	555	-	•
556	- !	-	557	exe	Carrier limited by coupling ‡
558	exe	Offset limited by harmonic	559	exe	Offset limited by sub-harm
560.	exe	Harmonic limited by offset	561	exe	Sub-harm limited by offset

(# = Source specific)

Table 4-3 Foreground errors (0 - 399)

0	dde	No error	1	dde	EEPROM checksum
2	dde	Pad cal checksum	3	dde	RF cal checksum
4	dde	Freq std checksum	5	dde	Synthesizer cal checksum
6.	áde ⁱ	Mod ref checksum	7	dde	Mod offset checksum
8 j	dide	Mod amp checksum	9	dde	ALC cal checksum
10	dde	FM cal factor checksum	11	dde	FM tracking checksum
12	dde	ΦM cal factor checksum	13	dide	System cal checksum
14	dde;	AM cal checksum	15	dde	Store checksum
16	dde	image checksum	1 7	. !	
20	dde	Frac-N out of lock at <freq></freq>	21	dde	VCO cal fail at <freq></freq>
22	dde	VTF tune cal fail at <freq></freq>	23	dde	FM tracking cal fail at <freq></freq>
		, 11 tab	51	dde	Keyboard buffer overflow
52	dde	Display buffer overflow	53	dde	Display missing
.		Display outlet overnow	į		Display missing
- i		Charles Novel	101	-	On the Professional Control of the Profession Control of the Professio
100	exe	Carrier limit	101	exé	Carrier step limit
102	exe	RF level limit	103	exc	RF level step limit
104	exe	Invalid modulation mode	105	exe	AM limit
106	exc	AM2 limit	107	exc	AM step limit
108	exe	AM2 step limit	109	exe	FM limit
110	exe	FM2 limit	111	exe	FM step limit
112	exe	FM2 step limit	113	exe	ΦM limit
114	exe	ΦM2 limit	115	exe	ΦM step limit
116	exe	ΦM2 step limit	117	exe	Memory limit
118	exe	AM mod freq limit	119	ехс	AM mod step limit
120	exe	AM2 mod freg limit	121	exc	AM2 mod step limit
122	exe	FM mod freq itmit	123	exe	FM mod step limit
124	exc	FM2 mod freq limit	125	exe	FM2 mod step limit
126	éxe	ΦM mod freq limit	127	¢хċ	ΦM mod step limit
128	exe	ΦM2 mod freg limit	129	ехе	ΦM2 mod step limit
130	exe	Return/Transfer not allowed	131	ехе	Util limit
132	exe	Start freq limit	133	exc	Stop freq limit
134	exe	Sweep time limit	135	exe	Sweep mode disabled
136	exe	Carrier phase limit	137	exe	AM phase limit
138	exe	FM phase limit	139	еже	ΦM phase limit
140	cxc	Memory store limit	141	exe	Memory recall limit
142	exe	Display blanking limit	143	exe :	GPIB address limit
144	exe,	Laich address limit	145	exe	Latch data limit
146	exe	Freq std carrier limit	147	exe	Freq std course adj limit
148	exe†	Freq std fine adj limit	349	exe	Mod ref adj limit
170	exe	Util not available	171	ехе	Entry outside limits
172	exe	Data out of range	173	exc	Units not valid
174	ėxe i	Unley fact limited by FM fact	175	exe ;	Invalid band rate
176	exe	Data overrun	177	exe	Data parity
178	exe	Data framing	179	exe	Break in data
180	ėxe	Transmit buffer full	181	exe	Receiver not enabled
182	exe	Protected utility - Level 1	183	exe	Protected utility - Level 2
184	-	-	185	exe	This store is Read Only
-0-			187	-	-
186	-				Dulas has been disabled
186	***	Pulse upavailable in 4FNK mode			
188	exe	Pulse unavailable in 4FSK mode	189	exe	Pulse has been disabled No high power app fitted
	exe	No attenuator fitted	191 193	exe exe	No high power arm fitted Ext DCFM mod mode required

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Table 4-4 GPIB errors (400 - 499)

400 cme Syntax error 401 cme Unrecognised mnemon	:-
i '	TC.
402 cme Numeric syntax 403 cme Data expected	
404 cme lllegal data 405 cme Too much data	
406 cme Incorrect data type 407 cme Unrecognised characte	т d ata
408 ome Character data not unique 409 ome Block definition	
410 cme Block size 411 cme Missing quote	
412 cme Terminator expected 413 cme Invalid unit	
414 cme Unit not expected 415 cme No header match found	i
416 cme Header not unique 417 cme Illegal star command	
418 cme Sub-command not allowed 419 cme Action not allowed with	h header
420 cme Query not allowed with header 421 cme Parser decode	
450 qye Query INTERRUPTED 451 qye Query UNTERMINAT	ED
452 qye Query DEADLOCK 453 qye Query lost after arbitra	ry char
Ⅱ	

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Chapter 4 SETUP

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Summary

The setup menus are used to route the outputs from the signal sources to either their individual RF OUTPUT sockets or, via the combiner, to the CONNECTION TO RADIO socket and additionally allow the sources to be coupled together by a mathematical formula in both frequency and level. The routeing is set using the combiner setup facility and the coupling parameters are enabled and set using the coupling setup facility.

The applications facility allows the user to select one of a number of common test configurations, such as intermodulation testing for two signal sources. When an application is selected the most appropriate signal routing is automatically chosen and the required coupling controls enabled. Control parameters are then redefined in terms of the measurement being performed to minimise the number of parameter entries required. For example for intermodulation testing with equal amplitude sources, only one RF level control is provided and this automatically sets the level of both sources. Control parameters are described in terms which are relevant to the measurement being performed.

Setup menu selection

Pressing the [SETUP] key gains access to the Setup Menu similar to that shown in Fig. 4-1 below.

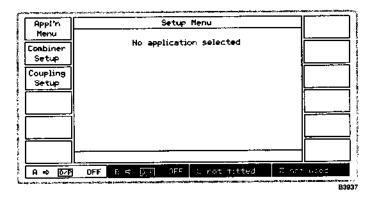


Fig. 4-1 Setup menu

The [Appl'n Menu] key accesses the Applications Selection Menu which enables you to select one of the three predefined applications. The [Combiner Setup] key accesses the Combiner Setup Menu which enables you to connect the signal sources in any combination to the combiner. The combined signal is then available at the CONNECTION TO RADIO socket. [Coupling Setup] accesses the Frequency and Level Coupling menu which enables you to couple the B source to the A source. This source can then track the A source by means of a level offset and a frequency and harmonic offset.

Combiner setup

This facility allows the user to route an individual signal source (A or B) to either its designated separate RF OUTPUT connector or through the combiner to the CONNECTION TO RADIO connector. The current routeing of the signal sources is always indicated by the source field at the bottom of the display. If both sources are routed to their separate connectors the combiner panel shows Σ not used.

Combiner selection

Select the required signal source - combiner configuration as follows:-

(1) On the Setup Menu press [Combiner Setup] to display the Combiner Setup Menu. This shows a graphical display of the current combiner setup similar to Fig. 4-2 below.

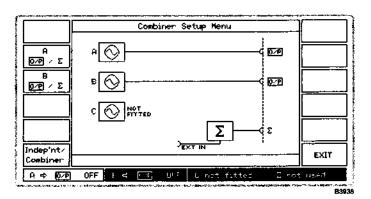


Fig. 4-2 Combiner setup menu

- (2) Pressing the [O/P/Σ] key for a particular source toggles between connecting the source to its own RF OUTPUT connector (shown by O/P on the display) or, via the combiner, to the CONNECTION TO RADIO connector (shown by Σ). Use these keys to select your required configuration. As shown by the display, the external INPUT FROM RADIO TEST SET socket is permanently connected to the combiner.
- (3) At each change in configuration the A and B source panels and the combined output Σ panel at the bottom of the display change to show the new destinations. These settings are repeated on all menus.
- (4) Pressing the [Indep'nt/Combiner] key switches between the current configuration having a combiner output and both sources having independent outputs. This provides a convenient way to restore the sources to normal, independent operation.
- (5) Selecting [EXIT] returns you to the Setup Menu.

External source

Provision is made on the rear panel for connecting an external signal generator to the combiner via the INPUT FROM RADIO TEST SET (shown by EXT IN in Fig. 4-2 above).

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Coupling

Frequency and level coupling

Many measurements are made where it is convenient if the carrier frequencies and RF levels of signal sources are automatically related to each other. The coupling setup facility allows two signal sources to be coupled together in frequency and/or level. The frequencies can be coupled with a defined offset value (e.g. 10.7 MHz), and can be harmonically related. The harmonic relationship is useful where a harmonic sampling gate or divider is being tested. RF levels can be entered in dB. Coupling factors of the B source are always set relative to the A source.

The frequency coupling is entered in the form:

Frequency (B) = frequency (A) \times N + offset frequency

OR

Frequency (B) = frequency (A)/N + offset frequency

where N is an integer between 1 and 9

The B source can be coupled only by entering its value relative to the A source. Offsets can have either positive or negative values.

Whenever a coupling factor has been set the signal generator display clearly identifies the presence of coupling factors in the frequency or level display fields by displaying an icon of the form $\Rightarrow B$ under the frequency/level units to indicate which source that parameter is currently coupled to.

Coupling selection

To set the coupling factors proceed as follows:-

(1) On the Setup Menu press the [Coupling Setup] key to display the Frequency and Level Coupling menu (see Fig. 4-3 below). The screen is split horizontally into two, with the upper part displaying the frequency coupling parameters and the lower part displaying the level coupling parameters.

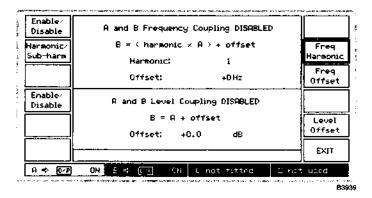


Fig. 4-3 Frequency and level coupling menu

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Frequency

- (2) Select the required source by pressing [A & B Coupling].
- (3) Select [Freq Offset] and enter the required offset from the A source, positive or negative, up to the instrument's maximum frequency and terminate with the [Hz], [kHz], [MHz] or [GHz] key.
- (4) To set the B source to a frequency which is a harmonic or sub-harmonic of the A source press the [Harmonic/Sub-harm] key. This key toggles the soft key selection between [Freq Harmonic] and [Freq Sub-harm]. Enter the required harmonic or sub-harmonic in the range 1 to 9 and terminate with any [ENTER] key.
- (5) Press [Enable/Disable] which toggles between the two states shown on the display. When Enable is selected, the Sig Gen menu is modified by the addition of an arrow and the letter for the coupled source in the frequency field. Thus ⇒B indicates that the A source is coupled to the B source.

Level

- (2) Select the required source by pressing [A & B Coupling].
- (3) Select [Level Offset] and enter the required offset from the A source, positive or negative, and terminate with the [dB] key.
- (4) Press [Enable/Disable] which toggles between the two states shown on the display. When Enable is selected, the Sig Gen Menu is modified by the addition of an arrow and the letter for the coupled source in the RF level field.

Applications

Applications summary

The 2026Q MultiSource Generator supports a number of measurement applications which require two signal sources to be coupled together. In addition to automatically selecting the most appropriate signal routeing format, the applications mode also automatically couples the sources together and modifies the descriptions of the parameters entered to best suit the application. This considerably simplifies control of the sources and provides a clearer description of the measurement being performed.

Whenever an application is selected the signal routeing in graphical form can be displayed to ensure that the user understands how the sources are connected to the RF connectors. In addition, a stylised spectral diagram can be displayed which shows how the main control parameters are used in the test.

Applications selection

To select one of the predefined applications press the [Appl'n Menu] key on the Setup Menu. This causes the Applications Selection Menu to be displayed similar to that shown in Fig. 4-4 below.

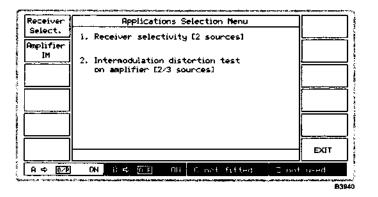


Fig. 4-4 Applications selection menu

This menu enables you to perform two-tone intermodulation distortion tests on an amplifier, or carry out a receiver selectivity test. Intermodulation tests require the presence of a strong interfering signal whose intermodulation products fall in the receiver's or amplifier's input frequency band.

Amplifier intermodulation distortion application

Intermodulation tests on amplifiers are a good indication of the linearity of an amplifier. Many communication systems require devices able to carry two or more signals without introducing spurious frequencies which might effect system performance. The 2026Q can support 2-tone intermodulation testing. The number of tones can also be increased by using the external source input, INPUT FROM RADIO TEST SET, for the connection of external generators.

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Two-tone test

In this test two tones are input to an amplifier. Amplifier output will comprise not only the two applied tones but also, due to amplifier non-linearity, intermodulation products. One tone is provided from source A at the required amplifier frequency. The second interfering tone is provided from source B at a different frequency but same amplitude.

Procedure

You can carry out an intermodulation distortion test on an amplifier as follows:

(1) Press [Amplifier IM] which displays the Intermod. Distortion Test on Amplifier block diagram as shown in Fig. 4-5 below.

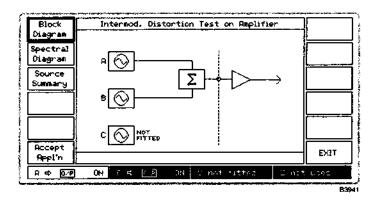


Fig. 4-5 Intermodulation distortion test on amplifier block diagram

- (2) Connect the amplifier under test to the output from the combiner (CONNECTION TO RADIO socket) as shown by the block diagram.
- (3) Press [Spectral Diagram] which displays the Intermod. Distortion Test on Amplifier spectral diagram as shown in Fig. 4-6 below.

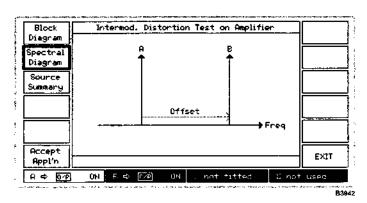


Fig. 4-6 Intermodulation distortion test on amplifier spectral diagram

- (4) The spectral diagram shows the default setting with the B source offset higher in frequency than the A source for a 2-tone test. You can reverse this setting so that the B source is at the lower frequency by entering a negative offset frequency. Also shown is that both signals have the same RF level.
- (5) If you wish to continue, press [Accept Appl'n] otherwise press [EXIT] which returns you to the Applications Selection Menu to enable you to select an alternative test.

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4-8

(6) Pressing [Accept Appl'n] displays the screen shown in Fig. 4-7 below. The screen is split horizontally into two, with the upper part displaying the receiver parameters and the lower part displaying the interferer offset frequency.

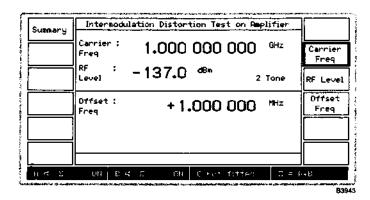


Fig. 4-7 Intermodulation distortion test on amplifier - 2-tone selected

- (7) Select [Carrier Freq] and [RF Level] to set these parameters. The carrier frequency entered is that for the A source. The RF level entered is that for both sources, but note that the RF level limit is +4 dBm.
- (8) Select [Offset Freq] to change the equidistant offsets of the interferer B source. You can reverse the relative position of the B source by entering a negative offset frequency.
- (9) At any time during the test you can press [Summary] then [Source Summary] to display the Source Summary screen similar to that shown in Fig. 4-8 below. This shows the allocated frequencies and levels of both sources to confirm your selection.

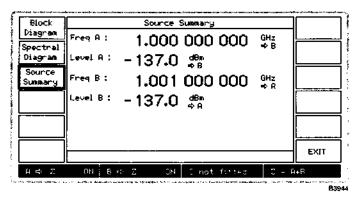


Fig. 4-8 Intermodulation distortion test on amplifier - Source summary screen

- (10) At the conclusion of the test, press [EXIT] to return to the previous screen to continue with the application.
- (11) To choose another application or to cancel the current application and return to normal operation, press [SETUP]. This causes the Setup Menu shown in Fig. 4-9 below to be displayed. The screen is split horizontally in two, with the upper part displaying the application mode and the lower part displaying the application cancellation selection.

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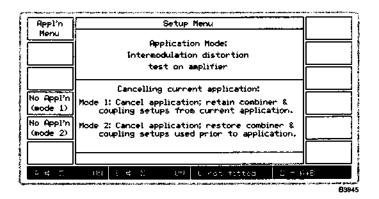


Fig. 4-9 Setup menu in application mode

- (12) To choose another application press [Appl'n Menu] which returns you to the Applications Selection Menu.
- (13) To cancel the current operation but retain the combiner and coupling setups, press [No Appl'n (mode 1)]. This enables you to temporarily leave the test e.g. to adjust the control knob. To cancel the current operation but restore to the previous combiner and coupling setups press [No Appl'n (mode 2)]. Pressing either key returns you to the Setup Menu with no application selected as confirmed by the screen.

Receiver selectivity application

The receiver selectivity test enables you to generate a modulated low level RF signal to open a receiver and a second, much higher level signal (with or without modulation) to interfere with the received signal. A facility is provided for you to increment, at a specified channel spacing, through the channels.

Procedure

(1) Press [Receiver Select.] which displays the Receiver Selectivity block diagram as shown in Fig. 4-10 below.

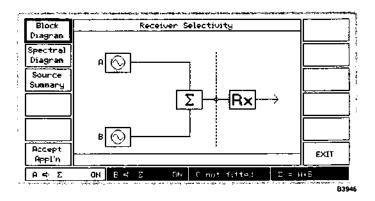


Fig. 4-10 Receiver selectivity block diagram

(2) Connect the receiver under test to the output from the combiner (CONNECTION TO RADIO socket) as shown by the block diagram.

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(3) Press [Spectral Diagram] which displays the Receiver Selectivity spectral diagram as shown in Fig. 4-11 below.

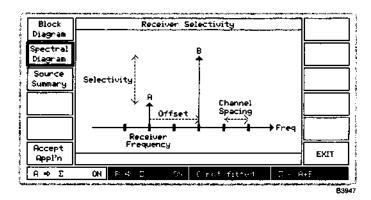


Fig. 4-11 Receiver selectivity spectral diagram

- (4) As shown by the spectral diagram, the A source is set to the receiver channel and the B source is offset higher in frequency than the A source at a multiple of the channel spacing. You can reverse this setting so that the B source is at the lower frequency by entering a negative offset. The B source is set higher in level than the A source.
- (5) If you wish to continue, press [Accept Appl'n] otherwise press [EXIT] which returns you to the Applications Selection Menu to enable you to select an alternative test.
- (6) Pressing [Accept Appl'n] displays a screen similar to that shown in Fig. 4-12 below. The screen is split horizontally into two, with the upper part displaying the receiver parameters and the lower part displaying the interferer parameters. Note that in the signal source field at the bottom of the screen, the A and B sources are shown connected to the combiner by Σ = A+B.

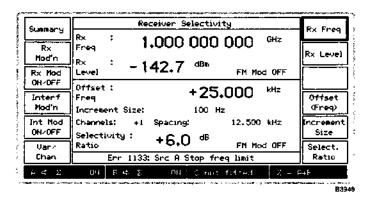


Fig. 4-12 Receiver selectivity - application accepted

- (7) Select [Rx Freq] and [Rx Level] if you want to change these parameters for the A source, but note that the RF level limit is +4 dBm when the selectivity ratio is set to 0 or to a negative value.
- (8) If you want to apply modulation to the A source press the [Rx Mod'n] key to access the Receiver Modulation Setup Menu shown in Fig. 4-13 below. At the conclusion press [EXIT] to return to the previous screen.

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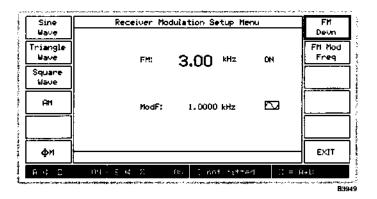


Fig. 4-13 Receiver selectivity - receiver modulation setup menu

- (9) When the A source is modulated press [Rx Mod'n ON/OFF] to toggle between the two states as shown by the screen.
- (10) If you want to apply modulation to the interferer (B source) press the [Interf Mod'n] key to access the Interferer Modulation Setup Menu shown in Fig. 4-14 below. At the conclusion press [EXIT] to return to the previous screen.

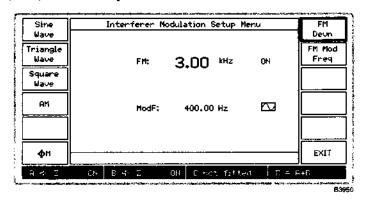


Fig. 4-14 Receiver selectivity - interferer modulation setup menu

- (11) When the B source is modulated, press [Int Mod'n ON/OFF] to toggle between the two states as shown by the screen.
- (12) To select channel mode, use the [Var/Chan] key which toggles between the variable and channel modes.
- (13) Press the [Channel Spacing] key and enter the channel spacing frequency using the keyboard.
- (14) Set the required interferer offset as a multiple of the channel frequency by pressing [Offset (Channel)] and entering the number on the keyboard. Entering a negative number sets the B source lower in frequency than the A source.
- (15) For a finer control of channel spacing and offset, select the variable mode by means of the [Var/Chan] key and use the [Increment Size] and [Offset (Freq)] keys which are now displayed. Entering a negative offset sets the B source lower in frequency than the A source.
- (16) Set the selectivity ratio (the amount by which the B source level is greater than the A source level) by pressing [Select. Ratio] and entering the ratio in dB.

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(17) At any time during the test you can press [Summary] then [Source Summary] to display the Source Summary screen similar to that shown in Fig. 4-15 below. This shows the allocated frequencies and levels of both sources to confirm your selection.

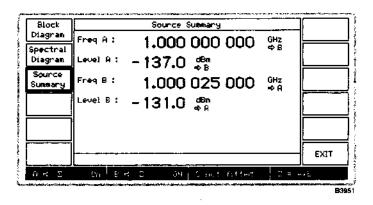


Fig. 4-15 Receiver selectivity - source summary

- (18) At the conclusion of the test, press [EXIT] to return to the previous screen to continue with the application.
- (19) To choose another application or to cancel the current application and return to normal operation, press [SETUP]. This causes the Setup Menu shown in Fig. 4-16 below to be displayed. The screen is split horizontally in two, with the upper part displaying the application mode and the lower part displaying the application cancellation selection.

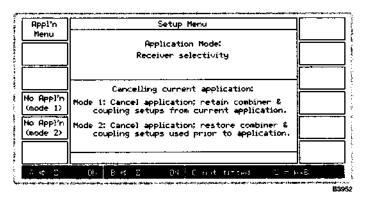


Fig. 4-16 Setup menu in application mode

- (20) To choose another application press [Appl'n Menu] which returns you to the Applications Selection Menu.
- (21) To cancel the current operation but retain the combiner and coupling setups, press [No Appl'n (mode 1)]. To cancel the current operation but restore to the previous combiner and coupling setups press [No Appl'n (mode 2)]. Pressing either key returns you to the Setup Menu with no application selected as confirmed by the screen.

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Chapter 5 REMOTE OPERATION

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Preparing the instrument for remote operation

Introduction

The 2026Q MultiSource Generator can be controlled remotely using either the RS-232 interface or the GPIB (General Purpose Interface Bus) interface. The command set used is designed to comply with IEEE 488.2. In RS-232 mode some IEEE 488.2 features are not implemented due to the restrictions of the interface.

Programs to control the instrument remotely over the two interfaces have much in common, the main difference being the way in which characters are transmitted.

Local lockout

In the remote mode the controller can set the instrument into Local Lockout state. When Local Lockout is set the front panel is disabled and the [LOCAL] key is made ineffective. This state is often used when the instrument is part of an automatic test system and left unattended. In this state the instrument cannot be affected by operation of the front panel. The keyboard can only be re-enabled by releasing Local Lockout over the remote interface or by switching the supply off and on again.

Remote/local operation

When the instrument is addressed by the GPIB controller it will enter its remote mode and the screen will display the [REM] annunciator at the lower right corner. Only one key, [Go To Local], will have any effect. Pressing this key returns the instrument to normal manual operation, unless Local Lockout (LLO) has been asserted by the controller.

When the instrument is addressed by the RS-232 controller, the remote mode is normally not entered (and thus no [REM] annunciator appears on the screen), although RS-232 operation is taking place.

In order to go to remote mode via the RS-232 it is necessary to transmit a control character (^A or 01H - connect or go to remote) following which the [REM] annunciator appears. Subsequently pressing [Go To Local] or transmitting a control character (^D or 04H - disconnect or go to local) will return the instrument to normal manual operation (unless Local Lockout has been asserted).

Remote operation selection

Remote operation can be selected between RS-232 and GPIB as follows:

- Press [UTIL] to display the Utilities Selection Menu 1 (if necessary, additionally press [Utils Menu 1]).
- (2) Press [Remote Control] to display the Remote Control Utility shown in Fig. 5-1 below.

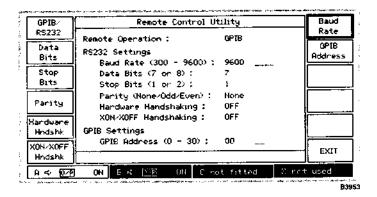


Fig. 5-1 Remote control utility

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(3) Select between GPIB and RS-232 operation by pressing the [GPIB/RS232] key which toggles between the two selections as shown by the screen.

RS-232 operation

RS-232 control port

The connections required between the RS-232 serial port and the controlling device are described in Chapter 2 under 'RS-232 interface'.

Handshaking

Software only

Flow control is achieved by XON/XOFF.

Note

All control lines are normally in the OFF state and are ignored.

Hardware only

Flow control is achieved DSR or CTS to suspend transmission from the instrument and using DTR to suspend transmission from the controller.

Note

The instrument will try to stop the controller from transmitting when the instrument's input buffer is nearly full and will allow further transmission when the buffer has enough room for new data.

The instrument will continue to transmit for a few characters after receiving the command to stop transmission, the controller must have enough buffer space to cope with this extra data.

Hardware and software

Normally used in conjunction with a modem. The flow control between the instrument and modem is achieved with the control lines, and the flow control to the remote control is achieved by XON/XOFF.

Control characters

The following list shows the control characters that are used over the RS-232 system to simulate certain features of the IEEE 488 interface:

^A (control A 01H) - connect or go to remote

^D (control D 04H) - disconnect or go to local

^R (control R 12H) - local lockout

^P (control P 10H) - release local lockout

^Q (control Q 11H) - XON char for software handshake

^S (control S 13H) - XOFF char for software handshake

Note that power on (PON) also clears the local lockout states.

Setting RS-232 parameters

With the Remote Control Utility shown in Fig. 5-1 above selected, proceed as follows:-

- (1) Press [Data Bits] to toggle between 7 and 8 data bits.
- (2) Press [Stop Bits] to toggle between I and 2 stop bits.
- (3) Press [Parity] to cycle through the selections None, Odd, Even.
- (4) Press [Hardware Hndshk] and [XON/XOFF Hndshk] to select any combination between both OFF to both ON.

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(5) Press [Baud Rate] and set the baud rate in the range 300 to 9600 bit/s. But note that if the entered value is not one of the following standard settings, the next higher value will be selected by default.

GPIB operation

The instrument can be operated remotely from a personal computer fitted with a GPIB interface card or a dedicated GPIB controller. All functions can be controlled by coded messages sent over the interface bus via the 24-way socket on the rear panel of the instrument. IEEE Standard 488.2 (1992) is implemented, which defines the protocols and syntax of commands.

The instrument can function either as a talker or a listener. In the listen mode, it will respond to IEEE 488.2 common commands and queries and device-specific commands and queries. These allow various device functions to be controlled and operating parameters to be set. In the talk mode, device status information and parameter settings can be read from the instrument.

For full information on the IEEE protocols and syntax the IEEE 488.2 standard should be consulted.

GPIB control port

The connections required between the GPIB interface port and the controlling device are described in Chapter 2 under 'General Purpose Interface Bus (GPIB)'.

Setting GPIB address

The instrument must be given an address code before it can be used by remote control over the GPIB. With the Remote Control Utility shown in Fig. 5-1 above selected, proceed as follows:-

(1) Press [GPIB Address] and enter the address which must be unique on the system to the instrument and within the range 0 to 30.

GPIB functions

The IEEE 488.1 interface functions offered by the 2026Q are as follows:

Source handshake (SH1) complete capability.

Acceptor handshake (AH1) complete capability.

Talker (T6) basic talker, serial poll, unaddress if MLA.

Listener (L4) basic listener, unaddress if MTA.

Service Request (SR1) complete capability.

Remote/Local (RL1) complete capability.

Device clear (DC1) complete capability.

Device trigger (DT1) complete capability.

Parallel Poll (PP0) no capability.

Controller (C0) no capability.

Tri-state drivers (E2) as opposed to open collector drivers.

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Device listening elements

The following is a list of the device listening elements (as defined in the IEEE 488.2 standard) which are used in the instrument:

- <PROGRAM MESSAGE>
- <PROGRAM MESSAGE TERMINATOR>
- <PROGRAM MESSAGE UNIT>
- <PROGRAM MESSAGE UNIT SEPARATOR>
- < COMMAND MESSAGE UNIT>
- <QUERY MESSAGE UNIT>
- <COMPOUND COMMAND PROGRAM HEADER>
- <COMPOUND QUERY PROGRAM HEADER>
- <PROGRAM HEADER SEPARATOR>
- <PROGRAM DATA>
- <PROGRAM DATA SEPARATOR>
- <DECIMAL NUMERIC PROGRAM DATA>
- < CHARACTER PROGRAM DATA>
- <SUFFIX PROGRAM DATA>
- <STRING PROGRAM DATA>
- <ARBITRARY BLOCK PROGRAM DATA>

Device talking elements

The following is a list of the device talking elements (as defined in the IEEE 488.2 standard) which are used in the instrument:

- <RESPONSE MESSAGE>
- <RESPONSE MESSAGE TERMINATOR>
- <RESPONSE MESSAGE UNIT>
- <RESPONSE MESSAGE UNIT SEPARATOR>
- <COMPOUND RESPONSE HEADER>
- <RESPONSE HEADER SEPARATOR>
- <RESPONSE DATA>
- <RESPONSE DATA SEPARATOR>
- <NR1 NUMERIC RESPONSE DATA>
- <NR2 NUMERIC RESPONSE DATA>
- <ARBITRARY ASCII RESPONSE DATA>
- <CHARACTER RESPONSE DATA>
- <STRING RESPONSE DATA>
- <DEFINITE LENGTH ARBITRARY BLOCK RESPONSE DATA>

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Programming

Program messages

A message consists of one or more message units. Message units are separated by a semi-colon (;). The whole message is ended by the Program Message Terminator (or End Of Message) defined as one of the following:

- (1) <newline> (ASCII 10 often known as 'line feed') or
- (2) <newline> + END (the EOI line is asserted as well) or
- (3) + END (EOI is asserted in the last data byte of the message)

Note

A response message is always terminated by <EOM> consisting of <newline> + END.

A message unit consists of a mnemonic header which may be followed by data. If data follows, it must be separated from its header by at least one space:

<header><SPACE><data>

e.g. RFLV:INC 6.0 dB

Spaces may be freely inserted in a message to improve readability, except within a header or within data.

A header may be a command or a query. A query has a '?' as its final character and causes the generation of a response message which will be read by the controller. Common commands and queries (defined in IEEE 488.2) begin with a '*'.

Upper and lower case characters are considered equivalent (i.e. FM fm Fm fM are all interpreted by the instrument in the same way).

Compound headers

The instrument implements compound headers which allows a complex set of commands to be built up from a small set of basic elements in a 'tree and branch' structure. The elements of a compound header are separated by a colon (:). Spaces are not allowed within a header.

Special rules apply when more than one compound header is used in one message. When the separator ';' is encountered, all headers except the trailing element of the previous header in the message are assumed to precede the following header, for example:

AM:DEPTH 30PCT;ON

is equivalent to the two commands:

AM:DEPTH 30PCT

and AM:ON

This does not apply to common commands (*RST etc.). The rule may be overridden by preceding a header with a colon, for example:

AM:ON;:FM:ON

Most main functions have a short form of header which may be used for clarity and brevity in simple messages, for example:

CFRQ 1.25GHZ is the same as CFRQ:VALUE 1.25GHZ

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Program data

Data can take many forms, as follows:

Decimal Numeric Data is a flexible numeric format which encompasses integer, fixed point and floating point (mantissa and exponent) representations. Data is rounded to a resolution appropriate to the function. Decimal data can, in most cases, be followed by the appropriate units. If no units are present, the specified default units are assumed.

Character Data is an alphanumeric word.

String Data consists of a number of 7-bit ASCII characters enclosed in quotes, either a pair of single ('ASCII 39') or double ("ASCII 34") quotes may be used.

Some commands can accept Multiple Data items which are separated by commas, for example MODE FM,AM.

Message exchange protocol

The controller should not attempt to read a response until it has sent the entire query message (terminated by EOM). Also, it should not start to send a new message until it has read the entire response (terminated by EOM). The query message may contain more than one query message unit, but only one response message (containing several response message units) is generated.

Failure to follow the protocol will generate a query error:

INTERRUPTED (error 450) occurs when the controller starts to send a new message before having read the response to a preceding query.

UNTERMINATED (error 451) occurs when the controller attempts to read a response without having sent a query.

DEADLOCK (error 452) can only occur if the input and output buffers are both filled by the controller having sent an extra long message containing several query message units.

These instruments have an input buffer of 256 characters and an output buffer of 256 characters.

Remote/local operation

When the instrument is addressed by the controller it will enter its remote mode and the screen will display the [REM] annunciator. Only one key, the softkey [Go To Local], will have any effect. Pressing this key returns the unit to normal manual operation, unless Local Lockout has been asserted by the controller.

Common commands and queries (IEEE 488.2)

The IEEE 488.2 standard defines a set of common commands and queries which implement common system functions.

Common command and query mnemonics are preceded by an asterisk (*) to distinguish them from device dependent data such as instrument programming strings. The following common commands and queries are implemented in the instrument:

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Mnemonic	Name and Description		
*IDN?	Identification Query. Returns an arbitrary ASCII response comprising four data fields in the format:		
	<manufacturer>,<model>,<serial number="">,<software and="" issue="" number="" part="">.</software></serial></model></manufacturer>		
	where: <pre> <manufacturer> is MARCONI INSTRUMENTS, <model> is the instrument model number, which is 2026. <serial number=""> is the instrument serial number in the form nnnnnn/nnn, where n is an ASCII digit in the range 0 to 9. <software and="" issue="" number="" part=""> is in the form nnnnn/nnn/nn.nn, where n is an ASCII digit in the range 0 to 9. </software></serial></model></manufacturer></pre>		
Example:	MARCONI INSTRUMENTS, 2026, 811162/111, 44533/222/01.00 <eom></eom>		
*OPT?	Option Identification Query. Returns an arbitrary ASCII response containing a data field for each fitted option in the format:		
	<option a="">,<option b="">,,<option n=""><eom></eom></option></option></option>		
	Option 1: 3 SOURCE GENERATOR Option 3: HIGH STABILITY OCXO Option 4: REAR PANEL CONNECTORS If no options are fitted, ASCII '0' is returned		

Note

Because an Arbitrary ASCII Response ends with the Response Message Terminator (<EOM>) either *IDN? or *OPT? must be the last Query Message Unit in a Program Message.

Example: 3 SOURCE GENERATOR, HIGH STABILITY OCXO<EOM>

*RST	Reset Command. Sets the instrument functions to the factory default power up state.
*TST?	Self Test Query. Returns a '0' when the GPIB interface and processor are operating.
*OPC	Operation Complete Command. Sets the Operation Complete bit in the Standard Event Status Register when execution of the preceding operation is complete.
*OPC?	Operation Complete Query. Returns a 'I' when the preceding operation has been completed.
*WAl	Wait to Continue Command. Inhibits execution of an overlapped command until the execution of the preceding operation has been completed.
*TRG	Trigger Command. Equivalent to Group Execute Trigger.
*STB?	Read Status Byte Query. Returns the value of the Status Byte as an nr1 number (0-255).
*SRE <nrf></nrf>	Service Request Enable Command. Sets the Service Request Enable Register.
*SRE?	Service Request Enable Query. Returns the value of the Service Request Enable Register as nr1.
*ESR?	Standard Event Status Register Query. Returns the value of the Status Event Status Register as nr1.
*ESE <nrf></nrf>	Standard Event Status Enable Command. Sets the Standard Event Enable Register.
*ESE?	Standard Event Status Enable Query. Returns the value of the Standard Event Status Enable Register as nr1.
*CLS	Clear Status Command. Clears all the Status Event registers and clears the Error Queue. Does not affect the Enable Registers.

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Device dependent commands

The following list describes the features of the device dependent mnemonics for the instrument together with simple examples of their use within each major section (Carrier frequency, RF level, etc.) The root mnemonic is listed first followed by the lower level mnemonics. Each group is followed by a list of requirements for data type and suffix.

In addition to the normal listen commands the instrument accepts query commands which cause it to prepare a message which will be sent to the controller when the instrument is next addressed to talk. For each query an example of a response is given. Where responses are similar for a group of queries not all are listed. Some queries can produce more than one type of response - an example of each is usually given.

In the list which follows, the abbreviations <char>, <arf> and <str> have the following meanings:

<char> = Character Program Data

<nrf> = Decimal Numeric Program Data

<str> = String Program Data

Where the data format is Decimal Numeric Program Data, the value may be expressed as a signed or unsigned number in any of the following formats:

nr1: Decimal integer, e.g. 1234 or -567

nr2: Floating point number, e.g. 1.234 or -56.789

nr3: Floating point number with exponent, e.g. 1.2345E5 or -12.47E-8

Default settings

These are the settings assigned to instrument functions in the following cases:

- (i) Power-up to factory default settings.
- (ii) Execution of *RST command.
- (iii) Pressing [Factory Recall] on the Memory Recall Menu.

Source selection

SOURCE

Select RF Source A or B as current source. When a source is selected, the

source-specific commands and queries will then apply to that source.

Data type: Character Program Data (A or B)

Allowed suffices: None Default suffix : None

SOURCE?

Prepares message containing information on the current RF Source selection

in the following format:

:SOURCE <mode>

<mode> is character program data indicating the current source where:

(A or B).

:SQURCE B Example:

Combiner mode

CMODE

Set the combined output mode. The combinations are as follows:

(where A and B refer to sources A and B respectively)

A+B, A, B, OFF

Data type: Character Program Data (A, B, AB, OFF) Allowed suffices :

None

Delault suffix : None

> CMODE AB Examples:

CMODE?

Prepares message containing information on the combined output mode

setting in the following format:

: CMODE <mode>

Example: :CMODE AB

Coupling (carrier frequency and RF level)

COUPLING

(not used alone)

:MODE

Set coupling mode

Data type:

Character Program Data (combinations of CFRQAB, RFLVAB or

DISABLED: See table below.)

Allowed suffices: None

Default suffix:

VALID COUPLING MODES

CFRQAB: Enable Carrier Frequency coupling between sources A and B RFLVAB; Enable RF Level coupling between sources A and B.

DISABLED: Disable all coupling.

Note: Order is not important, for example CFRQBA, RFLVAB is equivalent

ω RFLVAB, CFRQBA.

:CFRQAB

:MODE

:HARM

Select HARMonic or SUBHARMonic relationship

Data type:

Allowed suffices: None Default suffix :

Set Harmonic for carrier frequency coupling relationship

Character Program Data (either HARM or SUBHARM))

COUPLING:CFRQAB: (continued)

:SUBHARM

Set Sub-harmonic for carrier frequency coupling relationship

Data type: Decimal Numeric Program Data

Allowed suffices: None

Default suffix: None

:OFFSET

Set Frequency Offset for carrier frequency coupling relationship

Data type: Decimal Numeric Program Data

Allowed suffices : Any one of: GHZ, MHZ, KHZ or HZ

Default suffix: HZ

:RFLVAB

OFFSET

Set Level Offset for RF Level coupling relationship

Data type: Decimal Numeric Program Data

Allowed suffices : DB Default suffix: DB

COUPLING?

Prepares message containing information on the Coupling Mode in the

following format:

:COUPLING:MODE <mode>

<mode> is character program data indicating the coupling mode where:

selections.

:COUPLING:MODE CFRQAB,RFLVAB Example:

COUPLING:CFRQAB?

Prepares message containing information on the carrier frequency coupling

relationship in one of the following formats:

:COUPLING:CFRQAB:MODE <mode>;HARM <nr1>;SUBHARM

<mr1>;OFFSET <mr2>

where:

<mode> is character program data indicating HARMonic or

SUBHARMonic selection.

Example:

:COUPLING:CFRQAB:MODE SUBRARM; HARM 2; SUBHARM 6;

OFFSET 200000.0

COUPLING:RFLVAB?

Prepares message containing information on the RF level coupling relationship

in one of the following formats:

:COUPLING:RFLVAB:OFFSET < mr2>

Example: :COUPLING:RFLVAB:OFFSET 3.5

Carrier frequency (source-specific)

CFRQ Set Carrier Prequency (short form)

:VALUE Set Carrier Frequency

Set Carrier Frequency step :INC

> Data type: Decimal Numeric Program Data Allowed suffices:

Any one of: GHZ, MHZ, KHZ or HZ

Default suffix :

Go UP one step :UP Go DOWN one step :DN Return to original setting :RETN

:XFER Transfer current value to be the new setting

> Data type : None Allowed suffices: Default suffix : None

Adjust Phase Offset of Carrier in degrees :PHASE

Data type: Decimal Numeric Program Data

Allowed suffices : DEG Default suffix : DEG

> CFRQ:VALUE 2.54MHZ;INC 10KHZ CFRQ:UP;XFER Examples:

CFRQ? Prepares message containing information on Carrier Frequency setting in the

following format:

:CFRQ:VALUE <nr2>; INC <nr2>

Example: :CFRQ:VALUE 1000000000.0;INC 25000.0

RF level (source-specific)

RFLV Set RF Output Level (short form)

:VALUE Set RF Output Level

Data type: Decimal Numeric Program Data

Allowed suffices : Any one of: DBM, DBV, DBMV, DBUV, V, MV, UV OR NV.

Default suffix : DBM unless changed by UNITS command

:INC Set RF Level step (dB)

> Data type : Decimal Numeric Program Data

Allowed suffices: DB only Default suffix : DB

Go UP one step :UP :DN Go DOWN one step :RETN Return to original setting

:XFER Transfer current value to be the new setting

Tura RF Output QN :ON :OFF Turn RF Output OFF

> Data type : Allowed suffices : None Default suffix:

:TYPE Selects EMF or PD for voltage related units

Data type: Character Program Data (EMF or PD)

Allowed suffices: None Default suffix:

:UNITS Select default RF level units.

> Character Program Data (DBM, DBV, DBMV, DBUV, V, MV or UV) Data type : Allowed suffices :

Default suffix :

RFLV:VALUE -27.3DBM;ON RFLV:TYPE PD;VALUE 1.23UV Examples:

Prepares message containing information on RF Level setting in the following RFLV?

format

:RFLV:UNITS <unit>;TYPE <type>;VALUE <nr2>;INC <nr2>;<status>

<unit> is character program data defining the default RF level

units (DBM, DBV, DBMV, DBUV, V, MV or UV), <type> is character program data indicating EMF or PD and <status> is a program mnemonic indicating whether the RF output is ON or

OFF

:RFLV:UNITS DBM:TYPE PD:VALUE -103.5; INC 2.0; ON Examples: :RFLV:UNITS DBV:TYPE EMF: VALUE -83.2: INC 0.5:ON

Modulation mode (source-specific)

MODE

Set modulation mode

Data type :

Character Program Data (valid combinations of AM, FM, PM, FSK2L,

FSK4L or PULSE. See table below.)

Allowed suffices : Default suffix :

Examples:

MODE AM, FM MODE FM, PULSE

VALID MODE COMBINATIONS TABLE

AM [,PULSE] FM (,PULSE) PM (,PULSE) AM,FM (,PULSE) AM,PM [,PULSE] FSK2L [,PULSE] FSK4L (,PULSE)

Note...

Order is not important, for example AM,FM is equivalent to FM,AM. Pulse modulation can be used with any of the

AM,FM,PM,FSK2L and FSK4L modes.

FSK2L and FSK4L parameters are controlled using the FM

commands

MODE?

Prepares message containing information on Modulation Mode in the

following format: :MODE <mode>

<mode> is character program data indicating the modulation

mode settings

: MODE AM, FM Example:

Modulation control (source-specific)

MOD

[not used alone]

:ON

Turn modulation globally ON

:OFF

Turn modulation globally OFF

Examples:

MOD: ON MOD: OFF

MOD?

Prepares message containing information on Modulation Control in the

following format: :MOD:<status>

<status> is a program mnemonic indicating whether the

Modulation is globally ON or OFF

Example: #MOD: ON

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Frequency modulation (and FSK) (source-specific)

FM or FM1 or FM2 Set FM Deviation (short form)

:DEVN Set FM Deviation :INC Set FM step size

> Data type : Decimal Numeric Program Data Allowed suffices: Any one of: GHZ, MHZ, KHZ or HZ

Default suffix:

Select modulation source where <src> is any one of: INT, EXTAC, EXTALC. :<\$f0>

or EXTDC

Turn FM ON (locally) :ON :OFF Turn PM OFF (locally) :UP Go UP one step :DN Go DOWN one step :RETN Return to original setting

:XFER Transfer current value to be the new setting

> Data type : None Allowed suffices: None Default suffix: None

> > Examples:

FM:DEVN 25KHZ;INT;ON FM1:DEVN 15KHZ;INC 1KHZ;EXTDC

:MODF Set FM modulation oscillator frequency (short form)

:VALUE Set FM modulation oscillator frequency Set FM modulation oscillator frequency step size :INC

> Data type: Decimal Numeric Program Data Allowed suffices: Any one of: GHZ, MHZ, KHZ or HZ

Default suffix :

:UP Go UP one step Go DOWN one step :DN Return to original setting :RETN

:XFER Transfer current value to be the new setting

Select sinusoidal waveform :SIN :TRI Select triangle waveform :SQR Select square waveform

> Data type: Allowed suffices: None

Default suffix :

:PHASE Set phase offset of modulation oscillator relative to current phase

> Data type : Decimal Numeric Program Data

Allowed suffices: DEG Default suffix : DEG

> FM2:MODF:VALUE 1.5KH2;SIN FM:MODF:PHASE 1.2DEG Examples:

DCFMNL

Perform DC FM null operation

Data type: None Allowed suffices: None Default suffix :

> Example: DCFMNL

FM? or FM1? or FM2?

Prepares message containing information on FM setting in one of the

following formats:

:FM:DEVN <nr2>;<src>;<status>;INC <ar2> :FM1:DEVN <nr2>;<src>;<status>;ENC <nr2> :FM2:DEVN <nr2>;<src>;<status>;INC <nr2>

<src> is a program nunemonic representing the source of the

modulation signal and <status> is a program moemonic indicating whether the frequency modulation is locally ON or

Example:

:PM1:DEVN 25000.0;INT;ON;INC 1000.0

FM:MODF? or FM1:MODF? or FM2:MODF?

Prepares message containing information on FM modulation oscillator setting

in one of the following formats:

:FM:MODF:VALUE <nr2>;<shape>;INC <nr2> :FM1:MODF:VALUE <nr2>;<shape>;INC <nr2> :FM2:MODF:VALUE <nr2>;<shape>;INC <nr2>

<shape> is a program mnemonic representing the waveform

shape

Example: :FM1:MODF:VALUE 5750.00;SIN;INC 1000.00

Phase modulation (source-specific)

PM or PM1 or PM2 Set Phase Modulation Deviation (short form)

:DEVN Set Phase Modulation Deviation Set Phase Modulation step size :INC

> Data type : Decimal Numeric Program Data

Allowed suffices : RAD Default suffix :

:<src> Select modulation source where <src> is any one of: INT, EXTAC, EXTALC,

or EXTDC

:ON Turn PM QN (locally) Turn PM OFF (locally) :OFF :UP Go UP one step :DN Go DOWN one step :RETN Return to original setting

Transfer current value to be the new setting :XFER

> Data type : Allowed suffices: None Default suffix :

> > Examples:

PM:DEVN 2.38RAD;INT;ON PM1:DEVN 1.5RAD;INC 0.1RAD;EXTAC

:MODF Set PM modulation oscillator frequency (short form)

:VALUE Set PM modulation oscillator frequency :INC Set PM modulation oscillator frequency step size

> Decimal Numeric Program Data Data type :

Any one of: GHZ, MHZ, KHZ or HZ Allowed suffices:

Default suffix :

:UP Go UP one step :DN Go DOWN one step :RETN Return to original setting

:XFER Transfer current value to be the new setting

SIN Select sinusoidal waveform :TBI Select triangle waveform SOB Select square waveform

None Data type:

Allowed suffices: Default suffix :

:PHASE Set phase offset of modulation oscillator relative to current phase

> Examples: PM1:MODF:VALUE 10.5KHZ; SQR PM2:MODF:PHASE 2.0DEG

PM? or PM1? or PM2? Prepares message containing information on Phase Modulation setting in one

of the following formats:

:PM:DEVN <nr2>;<src>;<status>;INC <nr2> :PM1:DEVN enr25:esrc5:estatus5:INC enr25 :PM2:DEVN <nr2>;<src>;<status>;INC <nr2>

<src> is a program mnemonic representing the source of the modulation signal and <status> is a program ranemonic indicating whether the phase modulation is locally ON or OFF

:PM2:DEVN 2.30;INT;OFF;INC 0.05

PM:MODE? or PM1:MODE? or PM2:MODF?

Prepares message containing information on PM modulation oscillator setting in one of the following formats:

:PM:MODF:VALUE <nr2>;<shape>;INC <nr2> :PM1:MODF:VALUE <nr2>;<shape>;INC <nr2> :PM2:MODF:VALUE <nr2>;<shape>;INC <nr2>

<shape> is a program mnemonic representing the waveform

shape

Example: :PM2:MODF:VALUE 2500.00:TRI:INC 500.00

Amplitude modulation (source-specific)

AM or AM1 or AM2 Set AM Depth (short form)

Set AM Depth OFPTH Set AM step size :INC

> Data type : Decimal Numeric Program Data

Allowed suffices: Default suffix :

:<src> Select modulation source where <src> is any one of: INT, EXTAC, EXTALC,

or EXTIDC

Turn AM ON (locally) ·ON :OFF Turn AM OFF (locally) :UP Go UP one step Go DOWN one step :DN Return to original setting **RETN**

:XFER Transfer current value to be the new setting

> Data type: None Allowed suffices: Default suffix:

> > AM:DEPTH 30.5PCT;EXTAC;ON AM1:DEPTH 40PCT;INT;OFF Examples:

Set AM modulation oscillator frequency (short form) :MODF

:VALUE Set AM modulation oscillator frequency INC Set AM modulation oscillator árequency step size

> Decimal Numeric Program Data Data type : Allowed suffices: Any one of: GHZ, MHZ, KHZ or HZ

Default suffix :

:UP Go UP one step :DN Go DOWN one step :RÉTN Return to original setting

:XFER Transfer current value to be the new setting

:SIN Select sinusoidal waveform :TRI Select triangle waveform :SQA Select square waveform

> Data type: Allowed suffices: None Default suffix :

:PHASE Set phase offset of modulation oscillator relative to current phase

> AM2:MODF:VALUE 15.5KH2;TRI;INC 500H2 AM:MODF:PHASE 5DEG Examples:

AM? or AM1? or AM2?

Prepares message containing information on Amplitude Modulation setting in

one of the following formats:

:AM:DEPTH <nr2>;<src>;<status>;INC <nr2>
:AM1:DEPTH <nr2>;<src>;<status>;INC <nr2>
:AM2:DEPTH <nr2>;<src>;<status>;INC <nr2>

where

<src> is a program mnemonic representing the source of the modulation signal and <status> is a program mnemonic indicating whether the amplitude modulation is locally ON or

OFF

Example:

:AM1:DEPTH 56.6; INT; ON; INC 5.0

AM:MODE? or AM1:MODE? or AM2:MODE?

Prepares message containing information on AM modulation oscillator setting

in one of the following formats:

:AM:MODF:VALUE <nr2>;<shape>;INC <nr2>
:AMi:MODF:VALUE <nr2>;<shape>;INC <nr2>
:AM2:MODF:VALUE <nr2>;<shape>;INC <nr2>

where: <shape> is a program mnemonic representing the waveform

shape

Example: :AM:MODF:VALUE 5000.00;TRI;INC 1000.00

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Pulse modulation (source-specific)

(not used alone)

Turn Pulse modulation ON

:QFF

Turn Pulse modulation OFF

Data type: None Allowed suffices : None Default suffix : None

Examples:

PULSE: ON PULSE: OFF

PULSE?

Prepares message containing information on Pulse Modulation setting in the

following format:

:PULSE:<status>

where: <status> is a program mnemonic indicating whether the pulse modulation is ON or OFF

Examples:

:PULSE:ON :PULSE:OFF

Memory - store

:RAM

STO [not used alone]

Carrier Freq Store 0-99 :CFRQ :FULL Pull Store 0-99 RAM Store 0-99

> Data type: Decimal Numeric Program Data

Allowed suffices: None Default suffix : None

> STO:FULL 45 STO:CFRQ 16 Examples:

Memory - recall

RCL [not used alone]

Recall Carrier Freq Store 0-99 CFRQ Recall Full Store 0-99 :FULL Recall RAM Store 0-99 :RAM

> Data type : Decimal Numeric Program Data

Allowed suffices: None Default sulfix :

> RCL:FULL 7 RCL:RAM 83 Examples:

Memory - erase

ERASE [not used alone]

:CFRQ Erase all Carrier Freq Stores (0-99) :FULL Erase all Full Stores (0-99) Erase all RAM Stores (0-99) :RAM

Erase all Stores (Carrier, Full and RAM stores) :ALL

> Data type : None Allowed suffices: None Default suffix:

> > ERASE: FULL ERASE: ALL Examples:

Memory - protection

MPROT [not used alone]

:CFRQ [not used alone]

Set the start of the Carrier Freq Stores memory block which is to be :START

protected/unprotected.

:STOP Set the end of the Carrier Freq Stores memory block which is to be

protected/unprotected.

Data type : Decimal Numeric Program Data

Allowed suffices : None Default suffix :

:ON

Set memory protection ON (i.e. write-protected) for the selected Carrier Freq

Stores memory block.

Set memory protection OFF (i.e. not write-protected) for the selected Carrier :OFF

Freq Stores memory block.

Data type : Allowed suffices: Default suffix :

[not used alone] :FULL

Set the start of the Full Stores memory block which is to be START

protected/unprotected.

Set the end of the Full Stores memory block which is to be :STOP

protected/unprotected.

Decimal Numeric Program Data Data type :

Allowed suffices :

Default suffix :

:ON Set memory protection ON (i.e. write-protected) for the selected Full Stores

memory block.

:OFF Set memory protection OFF (i.e. not write-protected) for the selected Full

Stores memory block.

Data type : Allowed suffices: None Default suffix : None

:RAM

START

Set the start of the RAM Stores memory block which is to be

protected/improtected.

:STOP Set the end of the RAM Stores memory block which is to be

protected/anprotected.

Data type : Decimal Numeric Program Data

Allowed suffices : Default suffix :

:ON Set memory protection ON (i.e. write-protected) for the selected RAM Stores

:OFF Set memory protection OFF (i.e. not write-protected) for the selected RAM

Stores memory block.

Data type : Allowed suffices: None Default suffix :

> MPROT:CFRQ:START 50;STOP 99;ON MPROT:FULL:OFF Examples:

Sweep operation

SWEEP [not used alone]

:CFRQ Optional command (may be omitted)

START Set Start Frequency :STOP Set Stop Frequency

:tNC Set Carrier Frequency sweep step size

> Decimal Numeric Program Data Data type :

Allowed suffices: Any one of: GHZ, MHZ, KHZ or HZ

Default suffix :

:TIME Select time per sweep step

> Data type: Decimal Numeric Program Data

Allowed suffices: MS, S Default suffix :

> SWEEP: CFRQ: START 100KHZ; STOP 500KHZ; INC Example:

100HZ; TIME 60MS

SWEEP:CFRQ? Prepares message containing information on Carrier Frequency Sweep

settings in the following format:

:SWEEP:CFRQ:START <nr2>;STOP <nr2>;INC <nr2>;TIME <nr2>

:SWEEP:CFRQ:START 1230000.0;STOP 1330000.0;INC 100.0;TIME 20.0 Example:

Sweep mode

Note that for triggering the order of priority is as follows:

FSK logic input Memory recall Sweep trigger

Therefore ensure that FSK is not enabled, otherwise selecting sweep triggering will have no effect.

SWEEP [not used alone]

:SOURCE Select swept source (source A or B or sweep DISABLED)

> Character Program Data (either A or B or DISABLED) Data type :

Allowed suffices: None Default suffix: None

Example: SWEEP: SOURCE B

:MODE Select Mode of operation for Sweep generator (single or continuous)

Data type: Character Program Data (either SNGL or CONT)

Allowed suffices: None Default suffix : None

Example: SWEEP: MODE SNGL

:TRIG Select trigger mode

Character Program Data (any one of OFF, START, STARTSTOP, STEP) Data type:

Allowed suffices : None Default suffix:

> Example: SWEEP: TRIG STARTSTOP

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SWEEP?

Prepares message containing information on Sweep Source, Mode and

Trigger in the following format:

:SWEEP:SOURCE <source>;MODE <mode>;TRIG <mig>

where-

<source> is character program data indicating the sweep source selection, <mode> is character program data indicating the sweep mode selected, and <trig> is character program data

indicating the trigger type selected.

Example: :SWEEP:SOURCE A; MODE CONT; TRIG STEP

Sweep control

SWEEP [not used alone] :GO Commence Sweep Pause Sweep :HALT :CONT Continue Sweep :RESET Reset sweep to Start Value :RETN Return to original setting :XFER Transfer current value as the new setting :UP Go UP one sweep step while paused Go DOWN one sweep step while paused :DN

Data type: None
Allowed suffices: None
Default suffix: None

Examples: SWEEP: GO

SWEEP:GO SWEEP:RESET

Miscellaneous commands (source-specific)

RPP

Reset reverse power protection trip (short form)

:RESET

Reset RPP trip for current source.

Data type: None
Allowed suffices: None
Default suffix: None

Example: RPP:RESET

RPP:TRIPPED?

Prepares message containing information on whether the RPP Circuitry of the

current source is currently tripped in the following format:

oml>

(0 = not mipped, 1 = tripped)

Example: 1

RPP:COUNT?

Prepares message containing information on the number of times the RPP

Circuitry of the current source has tripped in the following format: <nr1>

Example: 3

ATTEN

[not used alone]

:LOCK

Lock the Attenuators of the current source.

:UNLOCK

Unlock the Attenuators of the current source.

Data type : None
Allowed suffices : None
Default suffix : None

.....

ATTEN: LOCK

ATTEN?

Prepares message containing information on whether the Attenuators of the

current source are locked or unlocked in the following format:

:ATTEN:<smmis>

where --- <status> is a program mnemonic indicating whether the attenuators

are locked or unlocked

Example: :AT

:ATTEN:LOCK

Miscellaneous commands (not source-specific)

ERROR? Prepares message relating to the next error in the error queue in the following

format:

Where <string> is a descriptive error message. The numeric value returned is that of the next error number, or 0 if the queue is empty, or 399 if the queue is full. Errors with numbers in the range 1000-1999 are specific to source A, and 2000-2999 to source B. Error numbers between 0 and 999 are not source-

specific.

Example: 1100, *Carrier limic*

GPIB

Set the GPIB Address (between 0 and 30 inclusive)

Data type: Decimal Numeric Program Data

Allowed suffices: None Default suffix :

> Example: GPIB 7

IMPEDANCE

Set 50 Ω or 75 Ω adapter mode for all sources.

Data type : Character program data (Z50R or Z75R)

Allowed suffices: None Default suffix : None

Example: IMPEDANCE 275R

IMPEDANCE?

Prepares message containing information on which adapter mode is selected

in the following format:

:IMPEDANCE <char>

:IMPEDANCE 275R Example:

FSTD

Select internal or external frequency standard

Character program data (any one of INT, EXT10DIR, EXT1IND, EXT10IND

or INT100UT)

Allowed suffices: None Default suffix: None

Data type :

Examples:

FSTD INT

FSTD EXTIGIND

FSTD?

Prepares message containing information on frequency standard selection in

the format:

:FSTD <char>

Example: :PSTD EXTIDIND

BLANK

(not used alone)

:ON

Blank the following display parameters: Carrier Frequency, RF Level.

Modulation Depth and Deviations, and Modulation Frequency

:OFF

Turn the blanking off,

Data type : None Allowed suffices: None Default suffix : None

Examples:

BLANK: ON

BLANK: OFF

BLANK? Prepares message containing information on the display blanking setting in

the following format:

:BLANK:<state>

where: <state> is program mnemonic indicating whether the blanking is ON

or OFF

Example: BLANK:OFF

CONTRAST Sets the LCD contrast, over a scale of 0 to 31.

Data type: Decimal Numeric Program Data

Allowed suffices: none
Default suffix: none

Example: CONTRAST 16

CONTRAST? Prepares message containing information on LCD contrast setting in the

following format:

:CONTRAST <artis

Example: :CONTRAST 23

BRIGHTNESS Sets the LCD brightness to DBM, MEDIUM or BRIGHT.

Data type: Character Program Data

Allowed suffices : None
Default suffix : None

Example: BRIGHTNESS MEDIUM

BRIGHTNESS? Prepares message containing information on LCD brightness setting in the

following format:

:BRIGHTNESS <brightness>

where:

data indicating the brightness

level.

Example: :BRIGHTNESS BRIGHT

ELAPSED

:RESET Reset elapsed operating hours to zero

Data type: None
Allowed suffices: None
Default suffix: None

Example: ELAPSED: RESET

ELAPSED? Prepares message containing information on elapsed operating hours since

last reset. Fractional part is in 15 minute intervals (0.25, 0.50, 0.75). Format is

s follows:

<nr2>

Example: 454.50

OPER? Prepares message containing information on total operating hours. Fractional

part is in 15 minute intervals (0.25, 0.50, 0.75). Format is as follows::

<nr2>

Example: 1453.00

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POWUP

(not used alone)

:MODE

Select the power up mode. The instrument can power up in either the factory

preset mode or from a full store.

Data type : Allowed suffices : Character program data (FACTORY or MEMORY) None

Default suffix: None

:FULL

Set the FULL store memory location for a memory power up.

Data type : Decimal Numeric Program Data

Allowed suffices: None Default suffix : None

Example:

POWUP: MODE MEMORY POWUP: FULL 54

POWUP?

Prepares message containing information on the instrument power up

selection in the following format::

:POWUP:MODE <mode>;FULL, <nrl>

where: <mode> is character program data indicating the power up mode.

Example: : POWUP: MODE MEMORY; FULL 27

Status byte

The Status Byte provides information about events and conditions within the instrument. It may be read by a conventional Serial Poll or its value obtained as a response to the *STB? query. Bits 0 to 5 and bit 7 are each single bit Summary Messages which may be of two types (or not used at all).

- Query Status a '1' indicates that an associated Queue is non-empty and has data available to be read.
- Status Register Summary reports the occurrence of an enabled event monitored by a Status Register Structure.

The Service Request Enable Register determines which of the bits can generate an SRQ, this register may be set by *SRE or read by *SRE?. If the bitwise -AND of the Status Byte and the Enable Register is non-zero the Flag Master Summary Status (<mss>) is True. Bit 6 of the Status byte value read by *STB? holds <mss>. However bit 6 of the Status Byte when Serial Polled is the Request For Service bit used to determine which device on the Bus has asserted SRQ, and is cleared by a Serial Poll.

The IEEE 488.2 Standard defines bit 4 as Message Available (<mav>), the Queue Summary for the Output Buffer, indicating whether any part of a Response Messages is available to be read. Bit 5 is the Event Summary Bit (<esb>), the Summary Message from the Standard Event Status Register.

In 2026Q, bit 7 is a Queue Summary for the Error Queue. Bits 1, 2, and 3 are Status summaries for the Instrument Status, Coupling Status and Hardware Status Registers. Bit 0 is unused.

The following is an explanation of how the Hardware Event Registers operate. Note that the Coupling and Instrument Event Registers operate in a similar fashion, albeit the Instrument Transition Filter uses negative-going transitions.

Each source (A and B) has its own Hardware Condition Register, Transition Filter, Hardware Status Register and Hardware Status Enable Register.

For a particular source, the status of the hardware is continuously monitored by the Hardware Condition Register. The Transition Filter determines which transition of the Hardware Condition Register data bits will set the corresponding bit in the Hardware Status Register. In the case of the Hardware Registers, a positive-going transition will set the bits.

The bits in the Hardware Status Register are latched. Once set they remain set, regardless of subsequent changes in the associated condition bit until the Hardware Status Register is cleared by being read (i.e. SOURCE B HSR?) or by the *CLS common command. Once cleared, a Hardware Status Register bit will only be set again if a positive-going change in the Hardware Condition bit occurs.

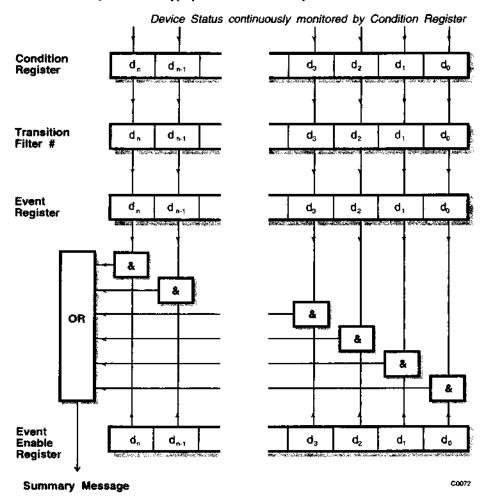
The Hardware Status Enable Register may be written to and read from. This register is bitwise-ANDed with the Hardware Status Register and if the result is non-zero the Summary Message is true, otherwise the Summary Message is false. The Hardware Status Enable Register is not affected by *CLS but is however clear at power-on.

The Summary Messages of each source are logically ORed, resulting in a combined Summary Message. This combined Summary Message is reported in the Status Byte.

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Status data structure - register model

Below is a generalised model of the Register Set which funnels the monitored data into a single summary bit to set the appropriate bit in the Status Byte.



Note

The Device Status is continuously monitored by the Condition Register. If a Query to read a Condition Register is provided, the Response represents the Status of the instrument at the moment the Response is generated. A Condition Register cannot be written to.

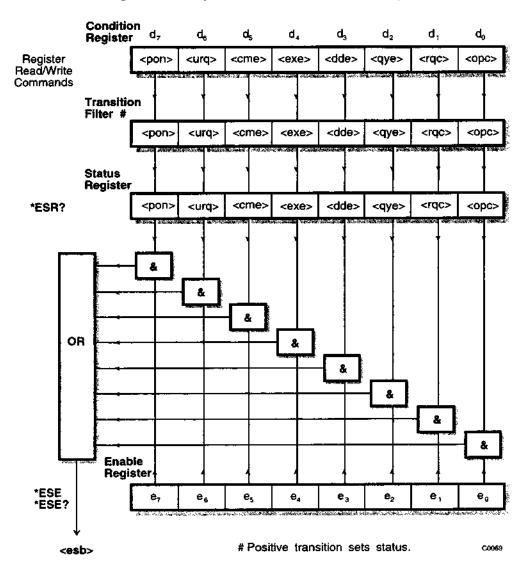
The Transition Filter determines which transition of the Condition Register data bits will set the corresponding bit in the Event Register. Either positive-going, negative-going or both transitions can set bits in an Event Register. But in the 2026Q the Transition Filters are pre-set as either Positive or Negative, as described in the following pages.

The bits in an Event Register are "latched". Once set they remain set, regardless of subsequent changes in the associated condition bit until the Event Register is cleared by being read or by the *CLS common command. Once cleared, an Event Register bit will only be set again if the appropriate change in the Condition bit occurs.

The Event Enable Register may be both written to and read from. It is bitwise AND-ed with the Event Register and if the result is non-zero the Summary Message is true, otherwise the Summary Message is false. Enable Registers are not affected by *CLS but are however clear at power-on.

Standard event registers

This Register is defined by IEEE 488.2 and each bit has the meaning shown below:-

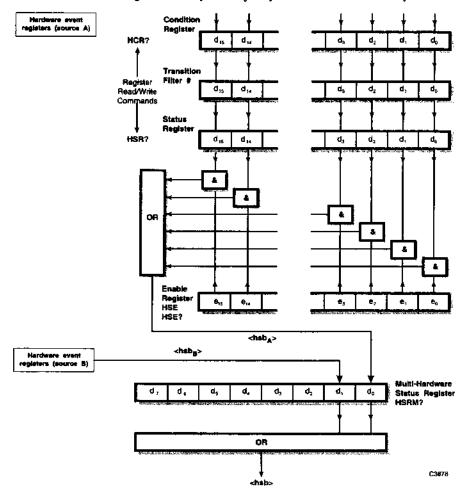


<pon></pon>	power on
<urq></urq>	user request - used by screen edit facility
<cme></cme>	command error
<exe></exe>	execution error
<dde></dde>	device dependent error
<qye></qye>	query error
<rqc></rqc>	request control - not implemented in this product
<opc></opc>	operation complete - set in response to the *OPC command for synchronisation.
<esb></esb>	standard event register summary bit

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Hardware event registers

These are device dependant registers and the bits have meanings as shown in the list at the bottom of the page. Each source (A and B) has its own set of registers, from which its respective hardware event register summary bits are jointly summarized in the Status Byte.



Positive transition sets status

\mathbf{d}_0	reverse power protection tripped	dg	filter unlevelled
d ₁	fractional-n loop low	49	output unleveiled
d_2	fractional-n loop high	d ₁₀	high power amplifier failed
d_3	external standard missing	d _{ll}	alc too high
$\mathbf{d_4}$	external standard frequency too low	d ₁₂	alc too low
d ₅	external standard frequency too high	d ₁₃	dsp not responding
d_6	vxo loop low	d ₁₄	rf level uncalibrated
d ₇	vxo loop high	d ₁₅	not used

<hsb_A>,<hsb_B> hardw

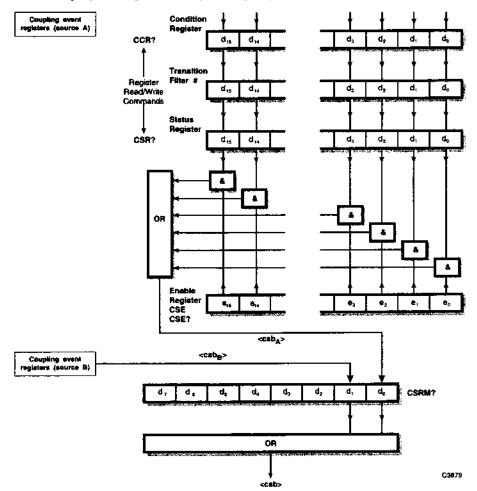
hardware event register summary bits for each source (A and B)

<hsb> hardware event register summary bit (summarizes both sources).

To return status of d_3 , d_4 , d_5 when source selected is B, source A hardware status enable register HSE<nrf> must be set.

Coupling event registers

These are device dependant registers and the bits have meanings as shown in the list at the bottom of the page. Each source (A and B) has its own set of registers, from which its respective coupling event register summary bits are jointly summarized in the Status Byte.



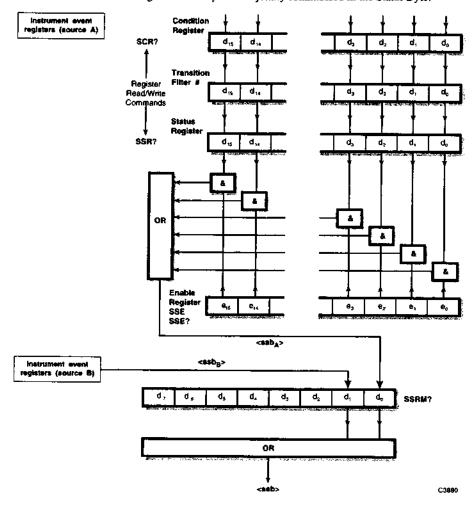
Positive transition sets status

d_0	rf level restr	icted by requested AM depth	d ₈	not used
ď	not used		dg	not used
d_2	not used		dio	carrier limited by coupling
d ₃	am2 depth n	estricted by requested am I depth	dil	offset limited by harmonic
d_4	fm2 deviation	n restricted by requested fm1 deviation	d ₁₂	offset limited by sub-harmonic
à ₅	pm2 deviation	on restricted by requested pm1 deviation	d_{13}	harmonic limited by offset
d ₆	number of s	weep steps restricted by other parameters	d ₁₄	sub-harmonic limited by offset
d 7	not used		d ₁₅	not used
<csb<sub>2</csb<sub>	\>, <csb<sub>B></csb<sub>	coupling event register summary bits	for each	source (A and B)
<csb></csb>	<csb> compling event register summary bit (summarizes both sources).</csb>			zes both sources).

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Instrument event registers

These are device dependant registers and the bits have meanings as shown in the list at the bottom of the page. Each source (A and B) has its own set of registers, from which its respective instrument event register summary bits are jointly summarized in the Status Byte.

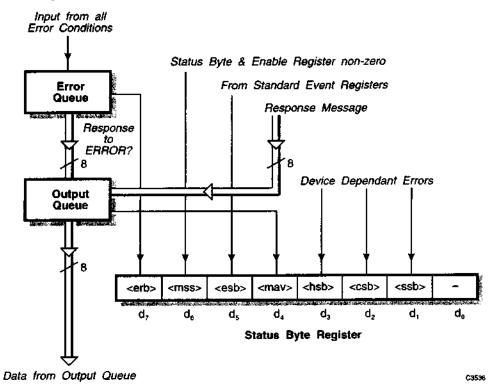


Negative transition sets status

\mathbf{d}_0	sweep in prog	gress	end of sweep
d ₁	not used		not used
d_2	selfcal in pro	gress	selfcal completed
d3	dc fm null in progress		de fm null completed
d_4 . d	15 not used		not used
<ssb<sub>A>,<ssb<sub>B> coup</ssb<sub></ssb<sub>		coupling event register summary	bits for each source (A and B)
<ssb> cou</ssb>		coupling event register summary	bit (summarizes both sources).

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Queue flag details

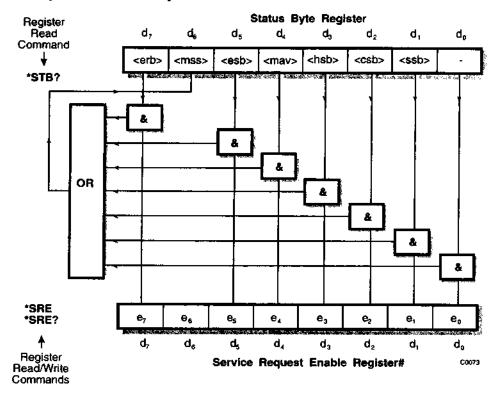


The <mav> status bit is set when one or more bytes are available to be read from the Output Queue.

The <erb> status bit is set when one or more errors are present in the Error Queue. The ERROR? query will place a nr1 response message in the Output Queue representing the Error at the head of the queue, if the queue is empty then this message will be 0.

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Status byte when read by *stb?



#Bit 6 in this register ignores data sent by *SRE and always returns 0 in response to *SRE?

<rqs>, <esb> and <mav> are defined in IEEE 488.2

<erb> is a device defined queue summary bit indicating that the error queue is non-empty.

<mss> is true when (Status Byte) AND (Enable register) > 0.

<esb> is the standard event register summary bit.

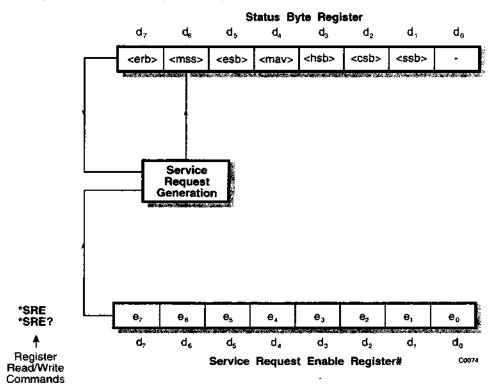
<may> is 'message available' indicating that the output queue is non-empty.

<hsb> is 'hardware status' summary bit
<csb> is 'coupling status' summary bit
<ssb> is 'instrument status' summary bit

Note

The Status Byte Register is Not cleared by the *STB? query.

Status byte when read by serial poll



Bit 6 in this register ignores data sent by *SRE and always returns 0 in response to *SRE?

<erb> is a device defined queue summary bit indicating that the error queue is non-empty.

<rqs> is set by a request for service and is cleared by the poll.

<esb> is the standard event register summary bit.

<mav> is 'message available' indicating that the output queue is non-empty.

<hsb> is 'hardware status' summary bit <csb>

is 'coupling status' summary bit

<ssb> is 'instrument status' summary bit

<rqs>, <esb> and <mav> are defined in IEEE 488.2

<rg>> (request for service) will produce an SRQ at the controller. It is set by a change to either the Status Byte or the Service Enable Register that results in a New Reason for Service. It is cleared when <mss> goes FALSE (i.e. no reason for service) or by Serial Poll.

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Chapter 6 BRIEF TECHNICAL DESCRIPTION

Introduction

The 2026Q CDMA Interferer MultiSource generator consists of two synthesized RF signal sources with both independent and combined RF outputs. The combined RF output provides a path to and from the radio under test and an appropriate CDMA test set. Each source is a fully functional RF signal generator with AM, FM, Φ M and pulse modulation capability. Each source covers the frequency range of 10 kHz to 2.4 GHz while the combined output covers the range 800 MHz to 2 GHz. Output levels range from -137 dBm to +24 dBm. A block schematic for the instrument is shown in Fig. 6-1.

The block diagram shows the internal circuits of one of the sources, the A source, in detail. The B source has the same configuration. Data from the AUXILIARY PORT and the instrument frequency standard are fed to both sources. RF output from each source is switched either directly to its individual RF OUTPUT socket or to the combiner then out to the CONNECTION TO RADIO connector. A third input to the combiner is provided by the INPUT FROM RADIO TEST SET socket on the rear panel. This input may also be used by an external signal generator.

Modulation

The carrier frequency of each signal source can be frequency, phase or amplitude modulated from internal or external modulation sources. The internal modulation source can be the sum of two signals and used in combination with an external modulation source connected to the front panel EXT MOD INPUT connector. In addition to analogue FM, 2-level and 4-level FSK signals are generated from external logic inputs to the AUXILIARY PORT connector.

Frequency generation

A voltage controlled oscillator (VCO) in each signal source covering the frequency range 400 to 533 MHz is phase locked to a 10 MHz oven controlled crystal oscillator (OCXO) using a fractional-N synthesizer system. Additional frequency coverage is achieved by means of frequency division or multiplication. Low frequencies are generated by a beat frequency oscillator (BFO) system.

Display

The display is a high definition dot matrix liquid crystal panel with backlighting to cater for variations in ambient light conditions. The display contrast can be adjusted.

Control

The 2026Q is a menu-driven instrument. Main menus are displayed by the use of hardkeys, and parameters are changed by means of soft keys which change as the menu changes. Internal control of the instrument is achieved by a microprocessor which receives data from the various controls and sends instructions via an internal 8-bit data bus to the signal processing circuits.

The instruments can also be controlled by either the built-in General Purpose Interface Bus (GPIB) or the RS-232 interface. The interfaces enable the instrument to be used both as a manually operated bench mounted instrument and as part of a fully automated test system. The RS-232 interface can also be used to reprogram the internal flash memory.

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Chapter 7 ACCEPTANCE TESTING

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Introduction

The test procedures in this chapter enable you to verify that the electrical performance of the signal generator complies with the Performance Data given in Chapter 1. For convenience, the test equipment and specification for each test are summarized before the test procedure.

Apart from the UUT, (Unit Under Test), no specific set-up procedures will be included for the test equipment unless the measurement is dependant on specific instrument settings or special measurement techniques.

Test precautions

To ensure minimum errors and uncertainties when making measurements, it is important to observe the following precautions:-

- (1) Always use recently calibrated test equipment, with any correction figures taken into account, so as to establish a known traceable limit of performance uncertainty. This uncertainty must be allowed for in determining the accuracy of measurements.
- (2) A common external frequency standard, with an accuracy of ±1 part in 10⁹ should be used for any frequency controlled test equipment.
- (3) Use the shortest possible connecting leads.
- (4) Some areas of the specification which are labelled typical rather than having clearly defined limits are not tested.

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Recommended test equipment

The test equipment recommended for acceptance testing is shown below. Alternative equipment may be used provided it complies with the stated minimum specification.

Recommended test equipment

Description	Minimum specification	Example
Power meter	±0.1 dB from 10 kHz to 2.4 GHz	Marconi 6960B with 6912, 6920 and 6932 Senson
Measuring receiver	0 dBm to -127 dBm; 2.5 MHz to 2.4 GHz Capable of measuring residual FM less than 2 Hz and SSB phase noise <-124 dBc/Hz at 20 kHz offset from a 1 GHz carrier	HP 8902A with Option 037* and 11722A Sensor and 11793A Down Converter
Signal generator	+8 dBm from 32.5 MHz to 2.43 GHz	Marconi 2041
Frequency counter	10 Hz to 2.4 GHz	EIP 535B or Marconi 2440
Audio analyser	Capable of measuring THD of 0.01% from 100 Hz to 20 kHz	Rhode & Schwa UPA3
Spectrum analyser	DC to 7.2 GHz, 3 Hz resolution bandwidth	Anritsu MS2602 or Marconi 2386
Modulation meter	AM, FM and ФM 50 kHz to 2.4 GHz, Accuracy ±1% at 1 kHz modulation frequency	Marconi 2305 plus Distortion Option **
Function generator	DC to 100 kHz sine, ±0.6 dB flatness, 100 kHz square wave	HP 3325B
Digital voltmeter	DC voltage measurement	Solartron 7150+
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinsche M1404N
2-turn loop	25 mm diameter	
Oscilloscope	100 MHz bandwidth	Tektronix TAS 465

^{*} Option 037 is necessary to measure SSB phase noise.

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[#] If the receiver and down converter are not available, an alternative procedure to ensure attenuator pad accuracy using a power meter is given.

^{**} The distortion option of the 2305 Modulation Meter allows modulation distortion tests to be carried out with greater ease. If a 2305 with the distortion option is not available, the audio analyser may be connected to the modulation meter LF output and set to measure distortion.

Test procedures

Each test procedure relies on the UUT being set to its power-up conditions. To avoid switching the instrument off and back on, reset the UUT by selecting:

[MEM] [Factory Recall]

At the end of this chapter are a set of results tables which give all the test points for each of the tests. These tables should be photocopied and used to record the results of all the measurements taken.

Tests for the options, where necessary, are included with the tests for the standard instrument.

RF output

Individual sources

Specification

Level range: -137 dBm to +24 dBm for carrier frequencies up to 1.2 GHz,

-137 dBm to +20 dBm for carrier frequencies above 1.2 GHz

Accuracy: For output levels from -127 dBm to +6 dBm and over a temperature

range of 17°C to 27°C:

±0.8 dB to 1.2 GHz ±1.6 dB to 2.4 GHz

For output levels above +6 dBm:

±1 dB 30 kHz to 1.2 GHz ±2 dB to 2.4 GHz

Temperature coefficient <±0.02 d8/°C to 1.2 GHz and <±0.04 dB/°C to

2.4 GHz

Output impedance: 50Ω

VSWR <1.5:1 to 1.2 GHz

<1.7:1 to 2.4 GHz (for output levels less than -5 d8m)

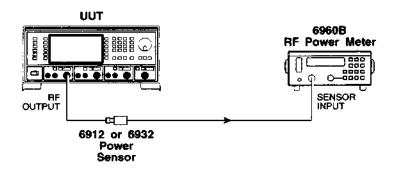
Test equipment

Description	Minimum specification	Example
Power meter	±0.1 dB from 10 kHz to 2.4 GHz	Marconi 6960B 6912 and 6932
Measuring receiver	0 dBm to -127 dBm; 2.5 MHz to 2.4 GHz	HP 8902A with 11722A Sensor and 11793A Down Converter
Signal generator	+8 dBm from 32.5 MHz to 2.43 GHz	Marconi 2041

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RF level frequency response

Test procedure



C3491

Fig. 7-1 RF output test set-up

- (1) Perform AUTO ZERO and AUTO CAL on the power meter.
- (2) Connect the test equipment as shown in Fig. 7-1.
- (3) On the UUT set source A to:

(Carr Freq) (RF Level) 30 [kHz] 0 [dB]

- (4) Record the output level measured by the power meter against each of the carrier frequencies shown in Table 7-1 checking that the results are within specification.
- (5) Set the UUT RF level to +6 dBm and repeat (4) using Table 7-2.
- (6) Set the UUT RF level to +13 dBm and repeat (4) using Table 7-3.
- (7) Change the 6912 sensor for the 6932 sensor when measuring levels greater than +20 dBm. Set the UUT RF level to +24 dBm and repeat (4) using Table 7-4.
- (8) Repeat (1) to (7) for source B.

ALC linearity

Test procedure

- (1) Perform AUTO ZERO and AUTO CAL on the power meter.
- (2) Connect the test equipment as shown in Fig. 7-1.
- (3) On the UUT set source A to:

[Carr Freq]
[RF Level]

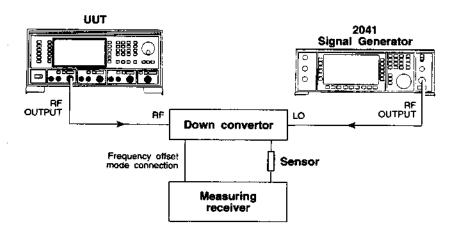
2.5 (MHz) -4 (dB)

- (4) Record the output level measured by the power meter against each of the steps shown in Table 7-5 checking that the results are within specification. Change the 6912 sensor for the 6932 sensor when measuring levels greater than +20 dBm.
- (5) Set the UUT carrier frequency to 500 MHz and repeat (4) using Table 7-6.
- (6) Set the UUT carrier frequency to 2400 MHz and repeat (4) using Table 7-7.
- (7) Repeat (1) to (6) for source B.

Attenuator accuracy

The following test will confirm that the attenuator performs to the published performance specification. In the event of the receiver/down-converter not being available, an alternative method to functionally test the individual pads is also suggested. (See 'Alternative attenuator functional test')

Test procedure



C3493

Fig. 7-2 Attenuator accuracy test set-up

- (1) Connect the test equipment as shown in Fig. 7-2.
- (2) On the UUT set source A to:

[Carr Freq] 2.6 [MHz]
[RF Level] 0 [dB]
[Total Δ]
[RF Level Shift] 11 [dB]

- (3) Tune the receiver to 2.6 MHz and record the output level measured in Table 7-8 checking that the result is within specification.
- (4) Set the UUT RF level to -4.1 dBm. Measure the received level and record the result in Table 7-8 checking that the result is within specification.
- (5) Decrement the UUT, using the [+10 ¹] key, in 11 dB steps down to an RF level of -103.1 dBm measuring the received level at each step shown in Table 7-8. Check that the results are within specification.
- (6) Set the UUT to carrier frequency 540 MHz and repeat (2) to (5) using Table 7-9.
- (7) Set the UUT to carrier frequency 1140 MHz and repeat (2) to (5) using Table 7-10.
- (8) Set the local oscillator to +8 dBm at a carrier frequency of 62 MHz less than the test frequency (i.e. 1678 MHz.)
- (9) On the receiver, enter the local oscillator frequency followed by the test frequency.
- (10) Set the UUT to carrier frequency 1740 MHz and repeat (2) to (5) using Table 7-11.
- (11) Set the UUT to carrier frequency 2400 MHz and repeat (2) to (5) using Table 7-12.
- (12) Repeat (2) to (11) for source B.

Alternative attenuator functional test

- (1) Connect the test equipment as shown in Fig. 7-1.
- (2) Perform AUTO ZERO and AUTO CAL on the power meter.

(3) On the UUT set source A to:

[Carr Freq]
[RF Level]

10 [MHz] 13 [dB]

(4) Use the knob to select 'RF Board Shift-Reg 1'.

- (5) Set a reference on the power meter such that 0 dB is indicated.
- (6) On the UUT, use [Cursor Left] to move the cursor to the MSB and press [Toggle Bit]. (01111101).

This will enable the first 33 dB pad.

- (7) Record the relative level measured on the power meter in Table 7-13. Note that this is a nominal value since no software correction figures are applied to the attenuator when performing this test.
- (8) On the UUT, press [Toggle Bit] to disable the first 33 dB pad.
- (9) Repeat (6) to (8) for the next four MSBs using [Cursor Right]; the 22 dB, 33 dB, 11 dB and 33 dB pads respectively.
- (10) Repeat (2) to (9) for source B.

Note

A 50 Ω termination should be fitted to OUTPUT TO RADIO TEST SET and the chained termination fitted on the rear panel INPUT FROM RADIO TEST SET before completing these tests.

Combined RF output

Specification

Level range per tone:

-127 dBm to -13 dBm for carrier frequencies from 865 MHz to 895 MHz and 1750 MHz to 1990 MHz. Usable from 800 MHz to 2 GHz.

Output power is uncalibrated above 0 dBm for frequencies above

1.2 GHz.

Accuracy:

For output levels between -20 dBm and -35 dBm and over a

temperature range of 17°C to 27°C;

865 to 895 MHz and 1750 to 1990 MHz

±0.75 dB.

Output impedance:

50 Ω.

VSWR

<1.6:1 from 865 to 895 MHz and 1750 to 1990 MHz.

Test equipment

Description	Minimum specification	Example
Power meter	±0.1 dB from 10 kHz to 2.4 GHz	Marconi 6960B and 6920

RF level frequency response

Test procedure

- Perform AUTO ZERO and AUTO CAL on the power meter.
- (2) Connect the test equipment as shown in Fig. 7-1 with the power sensor connected to the combined RF output.

(3) On the UUT set source A to:

[Carr Freq] [RF Level]

865 [MHz]

-20 (dB)

[SIG GEN]

(Combiner Setup) [A O/P $/\Sigma$] [EXIT] [SIG GEN]

- (4) Record the output level measured by the power meter against each of the carrier frequencies shown in Table 7-14 checking that the results are within specification.
- (5) Set the UUT RF level to -35 dBm and repeat (4) using Table 7-15.
- (6) Repeat (1) to (5) for source B ensuring that only one source at a time is routed to the combiner.

INPUT FROM RADIO TEST SET to CONNECTION TO RADIO path loss

Specification

Path loss to radio

-14 dB typical (865 MHz to 895 MHz),

-15 dB typical (1930 MHz to 1990 MHz). Measured figures supplied with instrument.

Accuracy

±0.25 dB plus ±0.1 dB frequency response.

Maximum input level

0 dBm.

Reverse isolation

>40 dB.

Test equipment

Description	Minimum specification	Example
Power meter	-40 dBm to -20 dBm	Marconi 6960B
Power sensor	-40 dBm to -20 dBm	Marconi 6920
Calibrated attenuator pad	30 dB (for power meter cal')	
Calibrated termination	50 Ω	
N-type or SMA- type cable	1.5 m long	
N-type and SMA- type adapters	N-type female to N-type female (for N-type and SMA-type cable)	
	N-type male to SMA-type male (for N-type cable)	
	N-type male to SMA-type female (for SMA-type cable)	

- (1) Reset the instrument.
- (2) Ensure the calibrated 50 Ω termination is connected to OUTPUT TO RADIO TEST SET.
- (3) Connect the cable between A RF OUTPUT and the power meter.
- (4) Set source A level to -20 dBm.
- (5) At the frequencies shown in the table below, record the levels measured.
- (6) Connect the power meter to CONNECTION TO RADIO.
- (7) Connect the cable between A RF OUTPUT and INPUT FROM RADIO TEST SET on the rear panel.
- (8) At the frequencies shown in Table 7-16 record the levels measured.

(9)	Take the figure in the top row from the figure in the next row, and record the result in the
	Path loss box. Record the average of the path loss figures for each band in the next row.

(10) Tick the box if the path loss figures are all within 0.1 dB of the average for both	- 1
bands.	- 1

CONNECTION TO RADIO to OUTPUT TO RADIO TEST SET path loss

Specification

Maximum reverse power

2 W (+33 dBm).

Path loss from radio

<-13.5 dB typical.

Test equipment

As above.

- (1) Reconnect the chained 50 Ω termination to INPUT FROM RADIO TEST SET on the rear panel.
- (2) Connect the cable between RF OUTPUT from tray A and CONNECTION TO RADIO.
- (3) Connect the power meter to OUTPUT FROM RADIO TEST SET.
- (4) Set source A to 1 GHz, -10 dBm and record the level measured.

Power	meter	reading:	dBπ

Tick the box if the figure above is between $-22~\mathrm{dBm}$ and $-25~\mathrm{dBm}$.

Carrier frequency accuracy

This check provides a conventional method of checking the signal generator frequency locking circuitry. It will confirm correct operation of phase locked loops and dividers. Overall accuracy is determined by the instrument's internal reference standard.

Specification

Frequency range:

10 kHz to 2.4 GHz

Accuracy:

Determined by the frequency standard accuracy

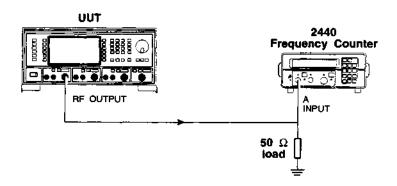
Resolution:

1 Hz

Test equipment

Description	Minimum specification	Example
Frequency counter	10 kHz to 2.4 GHz	EIP 535B or Marconi 2440
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N

Test procedure



C3503

Fig. 7-3 Carrier frequency accuracy test set-up

- (1) Connect the test equipment as shown in Fig. 7-3.
- (2) Connect the internal frequency standard from the UUT to the external standard input on the counter.
- (3) On the UUT set source A to:

[Carr Freq]
[RF Level]

10 [kHz] 0 [dB]

- (4) Record the frequency measured by the counter against each of the carrier frequencies shown in Table 7-17. (Since the two instruments' frequencies are locked together, the limit is ±1 digit on the counter display.)
- (5) At 1200 MHz disconnect the UUT internal frequency standard from the counter and instead apply the external reference. Check the result against the limits.

Notes

The test limits quoted are for guidance and assume that the internal frequency standard has recently been adjusted. Aging and stability have to be considered when establishing the real test limits. (See 'Performance data' in Chapter 1).

Where necessary disconnect the 50 Ω load and reconnect the UUT RF OUTPUT to the B input.

(6) Repeat (2) to (5) for source B.

Spectral purity

Individual sources

Harmonics:

Typically better than -30 dBc for RF Levels up to +6 dBm

Typically -25 dBc for RF levels up to +18 dBm (+14 dBm above 2 GHz)

Non harmonics:

Better than -70 dBc for carrier frequencies up to 1 GHz Better than -64 dBc for carrier frequencies above 1 GHz Better than -60 dBc for carrier frequencies above 2 GHz

Residual FM:

Less than 4.5 Hz RMS in a 300 Hz to 3.4 kHz bandwidth at a carrier

frequency of 1 GHz

SSB phase noise:

Better than -124 dBc/Hz at 20 kHz offset from a 470 MHz carrier Typically less than -121 dBc/Hz at 20 kHz offset from a 1 GHz carrier

RF leakage:

Less than 0.5 μV at the carrier frequency into a two-turn 25 mm loop

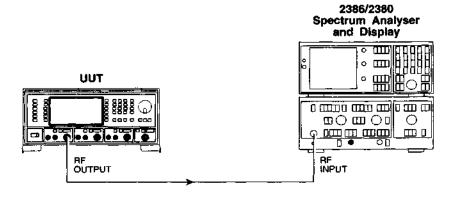
25 mm away from the surface of the signal generator

Test equipment

Description	Minimum specification	Example
Spectrum analyser	DC to 7.2 GHz frequency coverage	Anritsu MS2602A or Marconi 2386
Measuring receiver	0 dBm to -127 dBm; 2.5 MHz to 2.4 GHz Capable of measuring residual FM less than 2 Hz and SSB phase noise <-124 dBc/Hz at 20 kHz offset from a 1 GHz carrier	HP 8902A with Option 037
Signal generator	+8 dBm from 32.5 MHz to 2.43 GHz	Marconi 2041
50 Ω load	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschei M1404N
2-turn loop	25 mm diameter	

Harmonics

Test procedure



C3497

Fig. 7-4 Carrier harmonics and non-harmonics test set-up

- (1) Press CAL on the spectrum analyser.
- (2) Connect the test equipment as shown in Fig. 7-4.
- (3) On the UUT set source A to:

[Carr Freq] [RF Level] 10 [kHz] -4 [dB]

- (4) Measure the level of the second and third harmonics on the spectrum analyser at each of the carrier frequencies shown in Table 7-18 checking that the results are within specification.
- (5) Set the UUT RF level to 0 dBm and repeat (4) using Table 7-19.
- (6) Set the UUT RF level to +7 dBm and repeat (4) using Table 7-20.
- (7) Set the UUT RF level to +18 dBm and repeat (4) using Table 7-21.
- (8) Repeat (3) to (7) for source B.

Non-harmonics

Test procedure

- Press CAL on the spectrum analyser.
- Connect the test equipment as shown in Fig. 7-4.
- On the UUT set source A to: (3)

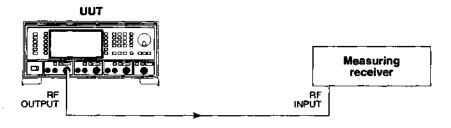
[Carr Freq] [RF Level]

1201 [MHz] 0 [dB]

- Measure the level of the non-harmonics on the spectrum analyser at each of the carrier frequencies shown in Table 7-22 checking that the results are within specification.
- Repeat (3) to (4) for source B. (5)

Residual FM

Test procedure



C3498

Fig. 7-5 Residual FM test set-up

- Connect the test equipment as shown in Fig. 7-5.
- On the UUT set source A to: (2)

[Carr Freq]

1 [GHz]

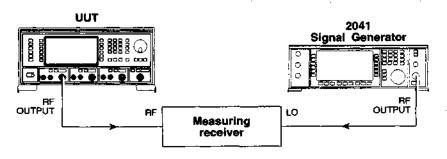
[RF Level]

0 [dB]

- On the measuring receiver, select FM, 300 Hz high-pass filter, 3.4 kHz low-pass filter and (3) enable averaging.
- Measure the residual FM checking that the result is within the specification shown in Table 7-23.
- Repeat (3) to (4) for source B.

S\$B phase noise

Test procedure



C349

Fig. 7-6 SSB phase noise test set-up

- (1) Connect the test equipment as shown in Fig. 7-6.
- (2) On the UUT set source A to:

[Carr Freq]
[RF Level]

470 [MHz] 0 [dB]

(3) On the measuring receiver:

Tune the receiver to 470 MHz.

Select 24.0 SPCL to enter selective power measurement mode.

Select 23.1 SPCL to set the LO to external.

- (4) Set the signal generator to a carrier frequency of 470.455 MHz, RF level 0 dBm.
- (5) On the measuring receiver:

Select 24.5 SPCL to establish the IF reference value (in volts).

Select 24.6 SPCL to set the reference to 0 dBm.

- (6) Fine tune the signal generator frequency until a maximum value is displayed on the measuring receiver.
- (7) On the measuring receiver:

Reselect 24.5 SPCL to establish the IF reference value (in volts).

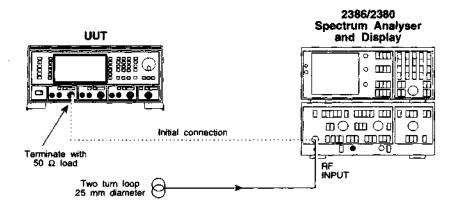
Reselect 24.6 SPCL to set the reference to 0 dBm.

Select 24.7 SPCL to normalize the measurement for a 1 Hz bandwidth.

- (8) Offset the signal generator by 20 kHz.
- (9) Measure the level on the receiver (the SSB phase noise in a 1 Hz bandwidth) checking that the result is within the specification shown in Table 7-24.
- (10) Repeat (2) to (9) for source B.

RF leakage

Test procedure



C3496

Fig. 7-7 RF leakage test set-up

- (1) Press PRESET then CAL on the spectrum analyser.
- (2) Connect the test equipment as shown in Fig. 7-7.
- (3) On the UUT set source A to:

[Carr Freq] 469.03 [MHz] [RF Level] -30 [dB]

(4) If using the 2386 Spectrum Analyser select

MKR 1 SET REF FREQ

REF FREQ 469.03 MHz SPAN/DIV 10 Hz PEAK FIND

- (5) Disconnect the cable from the UUT RF output socket and place a 25 mm 2-turn loop on the end of the cable.
- (6) Connect a 50 Ω sealed load to the UUT RF output.
- (7) If using the 2386 Spectrum Analyser select:

VOLTS/DIV

REF LEVEL

0.1 µV

2nd FUNCT

RF ATTEN \$\psi\$ (to set 0 dB input attenuation)

- (8) Hold the 2-turn loop not less than 25 mm from the UUT at various points around its case ensuring that the worst case leakage indicated on the spectrum analyser does not exceed that shown in Table 7-25.
- (9) Repeat (3) to (8) for each of the carrier frequencies shown in Table 7-25.
- (10) Repeat (3) to (9) for source B.

CONNECTION TO RADIO output

Specification

Harmonics:

Typically better than -25 dBc for RF levels up to +4 dBm (0 dBm above

1.2 GHz).

Isolation:

Isolation between any non-selected individual output and the combined

output is better than -60 dB,

Isolation between any two individual outputs is better than -80 dBm, Isolation between the combined output and any individual output while

selected is better than -35 dBm.

2-tone intermodulation:

At an RF level output of 0 dBm on the combiner: From 1 MHz to 1 GHz, better than -80 dBc. From 1 GHz to 2.4 GHz, better than -75 dBc.

Test equipment

Description	Minimum specification	Example
50 Ω load	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N
Spectrum analyser	DC to 2.4 GHz frequency coverage	Anritsu MS2602A

Intermodulation

Test procedure

 Connect the test equipment as shown in Fig. 7-4 with the spectrum analyser connected to the combined RF output.

880 [MHz]

(2) On the UUT set source A to:

[Carr Freq]

[RF Level] --14 [dB]

Set source B to:

[Carr Freq] 880,007 [MHz] (7 kHz spacing)

[RF Level] --14 [dB]

[SIG GEN]

[Combiner set-up]

[A O/P / E]

- [A O/P /\(\bar{L}\)]

 [B O/P /\(\bar{L}\)]

 [Exit]

 [SIG GEN]
- (3) Measure the level of the third order intermodulation products on the spectrum analyser at the frequencies shown in Table 7-26.
- (4) Repeat (2) to (3) for each of the carrier frequencies shown in Table 7-26.

Isolation

Test procedure

This procedure tests the isolation between any individual output set to 0 dBm and the combined output. The other areas of the isolation specification are tested implicitly by this procedure.

- Connect the test equipment as shown in Fig. 7-4 with the spectrum analyser connected to the combined RF output.
- (2) On the UUT set source A to:

[Carr Freq] [RF Level] 800 [MHz] 0 [dB]

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Terminate source A with the 50 Ω termination.

Ensure source B is turned off or set to -137 dBm.

- (3) Set the spectrum analyser to 800 MHz.
- (4) Measure the isolation on the spectrum analyser at the carrier frequencies shown in Table 7-27 checking that the results are within specification.
- (5) Repeat (2) to (4) for source B, terminating source B with 50 Ω, disabling source A using Table 7-27.

Internal FM

Specification

Deviation range:

0 to 100 kHz

Resolution:

3 digits or 1 Hz

Bandwidth (1 dB):

DC to 100 kHz (DC coupled) 10 Hz to 100 kHz (AC coupled)

20 Hz to 100 kHz (AC coupled with ALC)

Accuracy:

±5% at 1 kHz modulation rate

Carrier error:

Less than 1% of the set frequency deviation when DC coupled

Distortion:

Less than 1% at 1 kHz rate for deviations up to 100 kHz. (Less than 3% for carrier frequencies less than 50 MHz Typically 0.3% at 1 kHz rate for deviations up to 10 kHz

External modulation input:

1 V RMS for set deviation

Modulation ALC:

Levels the applied external modulation over the range 0.75 to 1.25 V

RMS.

FSK:

Accepts logic level inputs (1 or 2) to produce an unfiltered FSK

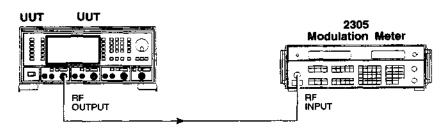
modulated output

Test equipment

Description	Minimum specification	Example
Modulation meter	FM accuracy ±1% at 1 kHz modulation frequency	Marconi 2305 with Distortion Option
DVM	DC voltage measurement	Solartron 7150+
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N
Audio analyser	Capable of measuring THD of 0.01% from 100 Hz to 20 kHz	Rhode & Schwarz UPA3
Function generator	DC to 100 kHz sine, ±0.6 dB flatness	HP 3325B

FM deviation and distortion

Test procedure



C3488

Fig. 7-8 Internal modulation and modulation distortion test set-up

- (1) Connect the test equipment as shown in Fig. 7-8.
- (2) On the UUT set source A to:

 [Carr Freq]
 10 [MHz]

 [RF Level]
 0 [dB]

 [FM Devn]
 100 [kHz]

 [FM ON/OFF]

- (3) On the modulation meter, select CAL, FM, 50 Hz \Rightarrow 15 kHz filter.
- (4) Measure the FM accuracy and distortion at the carrier frequencies shown in Table 7-28 checking that the results are within specification.
- (5) Repeat (2) to (4) for source B.

FM scale shape

Test procedure

- (i) Connect the test equipment as shown in Fig. 7-8.
- (2) On the UUT set source A to:

 [Carr Freq]
 15 [MHz]

 [RF Level]
 0 [dB]

 [FM Devn]
 100 [kHz]

 [FM ON/OFF]

- (3) On the modulation meter, select CAL, FM, 50 Hz \Rightarrow 15 kHz filter.
- (4) Measure the FM accuracy at the deviations shown in Table 7-29 checking that the results are within specification.
- (5) Repeat (2) to (4) for source B.

Carrier error

Test procedure

- (1) Connect the test equipment as shown in Fig. 7-8.
- (2) On the UUT set source A to:

[Carr Freq] 1200 [MHz] [RF Level] 0 [dB]

(3) On the modulation meter select CARRIER ERROR. The FREQUENCY display will read 0.00 kHz.

```
(4)
     On the UUT set source A to:
                                              100 [kHz]
           [FM Devn]
           [FM ON/OFF]
           (UTIL)
           [Mod'n Mode]
```

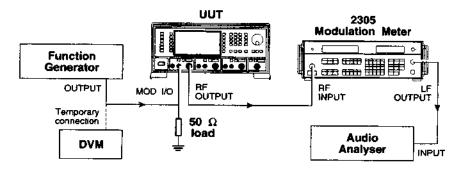
Press [Down] until "FM external" can be selected

[Select Mode] [EXIT] [SIG GEN] [Select Coupling] [Ext DC Coupling] [DCFM Nulling] [EXIT]

- (5) On the modulation meter, measure the carrier frequency error displayed in the FREQUENCY window checking that the result is within the specification shown in Table 7-30.
- Repeat (2) to (5) for source B.

External FM frequency response (ALC off, DC coupled)

Test procedure



C3501

Fig. 7-9 External modulation and modulation distortion test set-up

30 Hz to 100 kHz

- Connect the test equipment as shown in Fig. 7-9.
- On the UUT set source A to:

```
[Carr Freq]
                                  15 [MH2]
[RF Level]
                                  0 [dB]
[FM Devn]
                                  100 [kHz]
[FM ON/OFF]
[UTIL]
[Mod'n Mode]
```

Press [Down] until "FM external" can be selected [Select Mode] [EXIT] [SIG GEN]

[Select Coupling] [Ext DC Coupling] [DCFM Nulling] [EXIT]

- (3) Set the function generator to give 1 V RMS, 1 kHz sine wave.
- (4) On the modulation meter, select CAL, FM, 10 Hz \Rightarrow 300 kHz filter.
- On the modulation meter, check that the FM reading is between 47.5 kHz and 52.5 kHz, then set a reference using the relative function.

- (6) Set the function generator to each of the frequencies shown in Table 7-31 checking that the relative readings on the modulation meter are within specification.
- (7) At those frequencies indicated in Table 7-31, set the modulation meter LF output control to mid-position and measure the AF distortion on the audio analyser, checking that the results are within specification.

0 Hz (DC)

Note than to measure the FM deviation at DC, it will be necessary to use the DC offset facility on the function generator proceeding as follows:

- (8) Set the function generator to +1.4142 V DC (temporarily connect the function generator output to the DVM and set this voltage as close as possible to +1.4142 V).
- (9) Press CARRIER ERROR on the modulation meter.
- (10) Set the function generator to -1.4142 V DC (temporarily connect the function generator output to the DVM and set this voltage as close as possible to -1.4142 V).
- (11) Measure the frequency indicated on the modulation meter carrier frequency window.
- (12) Reset the function generator to 1 V RMS, 1 kHz sine wave and measure the FM deviation. FM2
- (13) Using the following formula, calculate the change in response checking that the result is within the specification shown against 0 Hz in Table 7-31.

20log₁₀ <u>FM2</u> FM1

(14) Repeat (2) to (13) for source B.

External FM frequency response (ALC on)

Test procedure

- (1) Connect the test equipment as shown in Fig. 7-9.
- (2) On the UUT set source A to:

[Carr Freq] 15 [MHz]
[RF Level] 0 [dB]
[FM Devn] 100 [kHz]
[FM ON/OFF]
[UTIL]
[Mod'n Mode]

Press [Down] until "FM external" can be selected

[Select Mode] [EXIT] [SIG GEN] [Select Coupling] [Ext ALC Coupling] [EXIT]

- (3) Set the function generator to give 0.75 V RMS, I kHz sine wave.
- (4) On the modulation meter, select CAL, FM, 10 Hz ⇒ 300 kHz filter.
- (5) On the modulation meter, check that the FM reading is between 9.5 kHz and 10.5 kHz, then set a reference using the relative function.
- (6) Set the function generator to each of the frequencies shown in Table 7-32 checking that the relative readings on the modulation meter are within specification.
- (7) Set the function generator to 1.25 V RMS and repeat (4) to (6) using Table 7-33, also measuring the AF distortion on the audio analyser at those frequencies indicated.
- (8) Repeat (2) to (7) for source B.

Phase modulation

Specification

Range:

0 to 10 radians

Resolution:

3 digits or 0.01 radians

Bandwidth (3 dB):

10 Hz to 10 kHz

Accuracy:

±5% at 1 kHz modulation rate

Distortion:

Less than 3% at 10 radians at 1 kHz modulation rate

Test equipment

Description	Minimum specification	Example
Modulation meter	ΦM and FM accuracy ±2% at 1 kHz modulation frequency	Marconi 2305 with Distortion Option

Phase modulation

Test procedure

Connect the test equipment as shown in Fig. 7-8.

(2) On the UUT set source A to:

[Carr Freq] 10.5 [MHz] [RF Level] 0 [dB] [ΦM] [ΦM Devn] 10 [rad] [ΦM ON/OFF]

- (3) On the modulation meter, select CAL, ΦM.
- (4) Measure the ΦM accuracy and distortion checking that the results are within the specification shown in Table 7-34.
- (5) Repeat (2) to (4) for source B.

Phase modulation flatness

Test procedure

For this test, the phase modulation figures are calculated from readings taken with the modulation meter set to FM. No allowances need to be made for the modulation source frequency accuracy since it is derived from the reference oscillator in the UUT.

- (1) Connect the test equipment as shown in Fig. 7-8.
- (2) On the UUT set source A to:

 [Carr Freq]
 15 [MHz]

 [RF Level]
 0 [dB]

 [ФМ] [ФМ Devn]
 10 [rad]

 [ФМ ON/OFF]

- (3) On the modulation meter, select CAL, FM, 50 Hz \Rightarrow 15 kHz LF filter.
- (4) Measure the deviation on the modulation meter and calculate the phase modulation using the formula:

 $\Phi M = FM \underline{\text{dev}}$ (Hz)

mod freq (Hz)

- (5) On the UUT set [DMod Freq] to each of the frequencies shown in Table 7-35, measure the deviation on the modulation meter and calculate the phase modulation for each step using the formula in (4).
- (6) Using the figure recorded in (4) as a reference, calculate the change in response at each modulation frequency using the formula:

20log₁₀ Figure recorded in (5) Figure recorded in (4)

Check that the results are within the specifications shown in Table 7-35.

(7) Repeat (2) to (6) for source B.

Amplitude modulation

Specification

Range:

0 to 99.9%

Resolution:

0.1%

Carrier frequency range:

<500 MHz, usable to 1.5 GHz

Bandwidth (1 dB):

DC to 30 kHz (DC coupled) 10 Hz to 30 kHz (AC coupled)

20 Hz to 30 kHz (AC coupled with ALC)

Accuracy:

±5% of set depth at 1 kHz modulation rate for output levels not

exceeding +14 d8m (0 d8m at combiner output).

Distortion:

For modulation depths up to 80%, less than 2.5% at 1 kHz rate For modulation depths up to 30%, less than 1.5% at 1 kHz rate

ΦM on AM:

Typically 0.1 radians at 30% depth at 470 MHz

Test equipment

Description	Minimum specification	Example
Modulation meter	AM accuracy ±1% at 1 kHz modulation frequency	Marconi 2305 with Distortion Option
DVM	DC voltage measurement	Solartron 7150+
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N
Audio analyser	Capable of measuring THD of 0.01% from 100 Hz to 20 kHz	Rhode & Schwarz UPA3
Function generator	DC to 30 kHz sine, ±0.6 dB flatness	HP 3325B

AM depth and distortion

Test procedure

(1) Connect the test equipment as shown in Fig. 7-8.

(2) On the UUT set source A to:

[Carr Freq] 1.5 [MHz]
[RF Level] -4 [dB]
[AM] [AM Depth] 30 [%]

[AM ON/OFF]

(3) On the modulation meter, select CAL, AM, 300 Hz \Rightarrow 3.4 kHz LF filter.

7-22

- (4) Measure the AM accuracy and distortion at the frequencies shown in Table 7-36 checking that the results are within specification.
- (5) Set the UUT to [AM Depth] 80% and repeat (4).
- (6) Set the UUT to [RF Level] 0 dBm and repeat (4) to (5) using Table 7-37.
- (7) Set the UUT to [RF Level] +7 dBm and repeat (4) to (5) using Table 7-38.
- (8) Set the UUT to [RF Level] +14 dBm and repeat (4) to (5) using Table 7-39.
- (9) Repeat (2) to (8) for source B.

AM scale shape

Test procedure

- (1) Connect the test equipment as shown in Fig. 7-8.
- (2) On the UUT set source A to:

```
      {Carr Freq}
      100 [MHz]

      {RF Level}
      0 [dB]

      [AM] [AM Depth]
      1 [%]

      [AM] ON/OFF]
```

- (3) On the modulation meter, select CAL, AM, 300 Hz \Rightarrow 3.4 kHz LF filter.
- (4) Measure the AM accuracy at the depths shown in Table 7-40 checking that the results are within specification.
- (5) Repeat (2) to (4) for source B.

External AM frequency response (ALC off, DC coupled)

Test procedure

100 Hz to 30 kHz

- Connect the test equipment as shown in Fig. 7-9.
- (2) On the UUT set source A to:

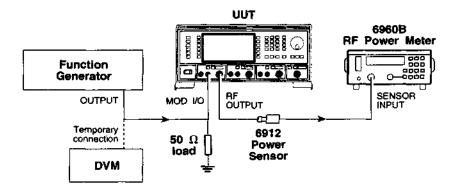
```
[Carr Freq] 400 [MHz]
[RF Level] -4 [dB]
[AM] [AM Depth] 80 [%]
[AM ON/OFF]
[UTIL]
[Mod'n Mode]
```

Press [Down] until "AM external" can be selected

```
[Select Mode] [EXIT]
[SIG GEN]
[Select Coupling] [EXI DC Coupling] [EXIT]
```

- (3) Set the function generator to give 1 V RMS, 1 kHz sine wave.
- (4) On the modulation meter, select CAL, AM, $10 \text{ Hz} \Rightarrow 300 \text{ kHz}$ filter.
- (5) On the modulation meter, check that the AM reading is between 76% and 84%, then set a reference using the relative function. Record the absolute reading for use in the formula in (17).
- (6) Set the function generator to each of the frequencies shown in Table 7-41 checking that the relative readings on the modulation meter are within specification.
- (7) Set the UUT RF level to +6 dBm and repeat (3) to (6) using Table 7-42.
- (8) Repeat (2) to (7) for source B.

0 Hz (DC)



C3480

Fig. 7-10 External AM and distortion test set-up

To measure the AM depth at DC, it will be necessary to use the DC offset facility on the function generator proceeding as follows:

- (9) Connect the test equipment as shown in Fig. 7-10.
- (10) Set the UUT RF level to -4 dBm.
- (11) Set the function generator to +1.4142 V DC (temporarily connect the function generator output to the DVM and set this voltage as close as possible to +1.4142 V).
- (12) Measure the power on the power meter. P1
- (13) Set the function generator to -1.4142 V DC (temporarily connect the function generator output to the DVM and set this voltage as close as possible to -1.4142 V).
- (14) Measure the power on the power meter. P2
- (15) Subtract P2 from P1 (= x).
- (16) Calculate the modulation depth using the formula:

$$AM(\%) = \underbrace{1 \cdot 10^{(-x/20)}}_{1+10^{(-x/20)}}$$

(17) Calculate the 0 Hz response relative to 1 kHz using the following formula, recording the result in Table 7-41:

> 20log₁₀ Figure recorded in (5) Figure recorded in (14)

- (18) Set the UUT RF level to +6 dBm and repeat (11) to (18) using Table 7-42.
- (19) Repeat (10) to (18) for source B.

Pulse modulation

Specification

Carrier frequency range:

32 MHz to 2.4 GHz, usable to 10 MHz

RF level range:

Maximum guaranteed output is reduced to +5 d8m when pulse

modulation is selected

RF level accuracy:

Maximum additional uncertainty is ±0.5 dB

On/off ratio:

Better than 40 dB

Better than 45 dB below 1.2 GHz

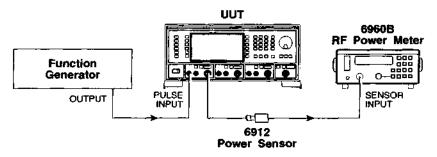
Rise and fall time:

Less than 10 µs

Test equipment

Description	Minimum specification	Example
Power meter	±0.1 dB from 10 kHz to 2.4 GHz	Marconi 6960B and 6912
Spectrum analyser	Frequency coverage 32 MHz to 2.4 GHz	Marconi 2386 or 2383
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N
Oscilloscope	100 MHz bandwidth	Tektronix TAS 465
Function generator	DC to 10 kHz square wave	HP 3325B

Pulse modulation RF level frequency response



C3489

Fig. 7-11 Pulse modulation test set-up

Test procedure

- (1) Perform AUTO ZERO and AUTO CAL on the power meter.
- (2) Connect the test equipment as shown in Fig. 7-11.
- (3) On the UUT set source A to:

[Carr Freq] [RF Level] [UTIL] 32 [MHz]

-7 [dB]

[Mod'n Mode] [Pulse Enab/Dis] [EXIT] [SIG GEN] [Pulse ON/OFF]

- (4) Set the function generator to provide +5 V DC. The RF output will now be enabled.
- (5) Record the output level measured by the power meter against each of the carrier frequencies shown in Table 7-43 checking that the results are within specification.
- (6) Set the UUT RF level to +4 dBm and repeat (5) using Table 7-44.
- (7) Repeat (3) to (6) for source B.

Pulse modulation on/off ratio

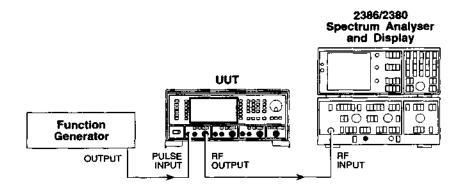


Fig. 7-12 Pulse modulation on/off ratio test set-up

Test procedure

- (1) Press CAL on the spectrum analyser.
- (2) Connect the test equipment as shown in Fig. 7-12.
- (3) On the UUT set source A to:

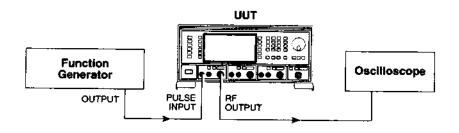
[Carr Freq] 32 [MHz]
[RF Level] 0 [dB]
[UTIL]
[Mod'n Mode] [Pulse Enab/Dis] [EXIT] [SIG GEN]
[Pulse ON/OFF]

- (4) Set the function generator to provide +5 V DC. The RF output will now be enabled.
- (5) Tune the spectrum analyser to the same frequency as the signal generator.
- (6) Press PEAK FIND on the spectrum analyser and note the output level.
- (7) Apply a short circuit to the PULSE INPUT socket on the rear panel.
- (8) Again note the output level measured by the spectrum analyser.
- (9) The difference between the levels recorded in (6) and (8) is the pulse mod on/off ratio. Check that the ratio is within specification using Table 7-45.
- (10) Repeat (5) to (9) for each of the frequencies shown in Table 7-45.
- (11) Repeat (3) to (10) for source B.

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Pulse modulation rise and fall time



C3494

Fig. 7-13 Pulse modulation rise and fall time test set-up

Test procedure

- Connect the test equipment as shown in Fig. 7-13.
- (2) On the UUT set source A to:

{Carr Freq} 50 [MHz] [RF Level] +7 [dB] [UTIL] [Mod'n Mode] (Pulse Enab/Dis) [EXIT] [SIG GEN] [Pulse ON/OFF]

- (3) Set the function generator to produce 10 kHz, 0 V to +5 V square wave.
- (4) Adjust the oscilloscope controls such that the rise time of the envelope can be measured.
- (5) Measure the rise time between the 10% to 90% points checking that it is within the specification shown in Table 7-46.
- (6) Repeat (4) to (5) for the fall time of the envelope.

Modulation oscillator

Specification

Frequency range: 0.01 Hz to 20 kHz

Resolution: 0.01 Hz to 100 Hz

0.1 Hz to 1 kHz 1 Hz to 20 kHz

Distortion: Less than 0.1% at 1 kHz

Sine wave frequency response: Typically 1 dB, DC to 20 kHz

Waveforms: Sine (to 20 kHz), triangle or square wave (to 3 kHz)

Square wave jitter <6 µs on any edge

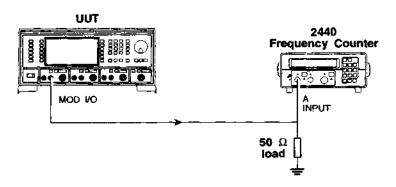
Output. 2 V RMS EMF from a 600 Ω source impedance

Test equipment

Description	Minimum specification	Example
Frequency counter	10 kHz to 2.4 GHz	Marconi 2440
50 Ω load (termination)	1 W, 50 Ω nominal impedance, DC to 2.4 GHz	Lucas Weinschel M1404N
Audio analyser	Capable of measuring THD of 0.01% at 1 kHz	Rohde & Schwarz UPA3

Modulation oscillator frequencies

Test procedure



C3502

Fig. 7-14 Modulation oscillator frequency test set-up

- (1) Connect the test equipment as shown in Fig. 7-14.
- (2) On the UUT set source A to:

 [MOD ON/OFF] (To enable modulation source)

 [FM Mod Freq] 10 Hz
- (3) Record the frequency measured by the counter against each of the modulation oscillator frequencies shown in Table 7-47.
- (4) Repeat (2) to (3) for source B.

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Modulation oscillator distortion and LF output flatness

Test procedure

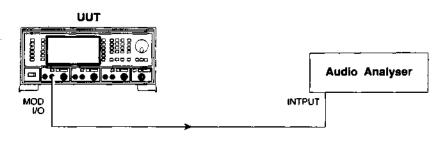


Fig. 7-15 Modulation oscillator distortion test set-up

- (1) Connect the test equipment as shown in Fig. 7-15.
- (2) On the UUT set source A to:

 [MOD ON/OFF] (To enable modulation source)

 [FM Mod Freq] 1 kHz
- (3) Measure the distortion on the audio analyser checking that the result is within the specification shown in Table 7-48.
- (4) Measure the absolute level on the audio analyser (in dBm) and record this level as a reference.
- (5) Set the UUT mod source to each of the frequencies shown in Table 7-48. Subtract the level measured on the audio analyser at each frequency from that recorded in (4) checking that the results are within specification.
- (6) Repeat (2) to (5) for source B.

External frequency standard input

Specification

input levels:

Requires an input of 220 mV RMS to 1.8 V RMS into 1 $k\Omega$

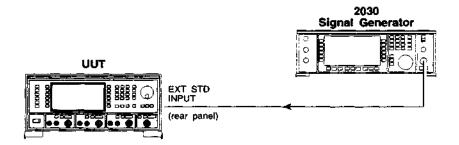
Input frequencies:

1 MHz or 10 MHz

Test equipment

Description	Minimum specification	Example
Signal generator	220 mV to 1.8 V RMS, 1 MHz to 10 MHz	MI 2030 or 2040 series

Test procedure



C3492

RF OUTPUT

Fig. 7-16 External standard test set-up

- (1) Connect the test equipment as shown in Fig. 7-16.
- (2) On the UUT set source A to:

(UTIL) {Freq Standard} {1MHz Ext Ind}

- (3) Set the signal generator to RF level 220 mV EMF, carrier frequency 1 MHz.
- (4) Using Table 7-49, check that no external standard error messages are displayed on the UUT.
- (5) Set the signal generator to 1.8 V EMF and repeat (4).
- (6) On the UUT select [10MHz Ext Ind].
- (7) Set the signal generator to carrier frequency 10 MHz and repeat (4).
- (8) Set the signal generator to 220 mV and repeat (4).

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Acceptance test results tables

For 2026Q signal generator, serial number ____/__

Table 7-1 RF output at 0 dBm

Carrier frequency (MHz)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
0.03	-0.8		+0.8
0.33	-0.8		+0.8
60	-0.8		+0.8
180	-0.8		+0.8
300	-0.8		+0.8
420	-0.8		+0.8
540	-0.8		+0.8
660	-0.8		+0.8
780	-0.8		+0.8
900	-0.8		+0.8
1020	-0.8		+0.8
1140	-0.8		+0.8
1200	-0.8		+0.8
1201	-1.6		+1.6
1260	-1.6		+1.6
1380	-1.6		+1.6
1500	-1.6		+1.6
1620	-1.6		+1.6
1740	-1.6		+1.6
1860	-1.6		+1.6
1980	-1.6		+1.6
2220	-1.6		+1.6
2340	-1.6		+1.6
2400	-1,6		+1.6

Table 7-2 RF output at +6 dBm

Carrier frequency (MHz)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
		 _	<u> </u>
0.03	+6		+8
0.33	+6		+8
60	+6		+8
180	+6		+8
300	+6		+8
420	+6		+8
540	+6		+8
660	+6		+8
780	+6		+8
900	+6		+8
1020	+6		+8
1140	+6		+8
1200	+6		+8
1201	+5		+9
1260	+5		+9
1380	+5		+9
1500	+5		+9
1620	+5		+9
1740	+5		+9
1860	+5		+9
1980	+5		+9
2220	+5		+9
2340	+5	<u> </u>	+9
2400	+5		+9
			İ

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Table 7-3 RF output at +13 dBm

Carrier frequency (MHz)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
0.03	+12	-	+14
0.33	+12		+14
60	+12		+14
180	+12		+14
300	+12		+14
420	+12		+14
540	+12		+14
660	+12		+14
780	+12		+14
900	+12		+14
1020	+12		+14
1140	+12		+14
1200	+12	 	+14
1201	+11	 -	+15
1260	+11		+15
1380	+11		+15
1500	+11		+15
1620	+11		+15
1740	+11		+15
1860	+11		+15
1980	+11		+15
2220	+11	<u> </u>	+15
2340	+11		+15
2400	+11		+15

Table 7-4 RF output at +24 dBm

Carrier frequency (MHz)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
0.03	+23	<u> </u>	+25
0.33	+23		+25
60	+23		+25
180	+23		+25
300	+23		+25
420	+23		+25
540	+23		+25
660	+23		+25
780	+23		+25
900	+23		+25
1020	+23	_	+25
1140	+23		+25
1200	+23		+25
	+20 di	3m	
1201	+18		+22
1260	+18		+22
1380	+18		+22
1500	+18		+22
1620	+18		+22
1740	+18		+22
1860	+18		+22
1980	+18		+22
2220	+18		+22
2340	+18		+22
2400	+18		+22

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Table 7-5 ALC linearity at 2.5 MHz

RF level (dBm)	RF level min. (dBm)	Result (dBm) src A src B	RF ievel max. (dBm)
-4	-4.8		-3.2
-3	-3.8		-2.2
-2	-2.8		-1.2
-1	-1.8		0.2
0	-0.8		+0.8
1	0.2		+1.8
2	+1,2		+2.8
3	+2.2		+3.8
4	+3.2		+4.8
5	+4.2		+5.8
6	+5.2		+6.8
7	+6		+8
8	+7		+9
9	+8		+10
10	+9		+11
11	+10		+12
12	+11		+13
12.1	+11.1		+13.1
12.2	+11.2		+13.2
12.3	+11,3		+13.3
12.4	+11.4		+13.4
12.5	+11.5		+13.5
12.6	+11.6		+13.6
12.7	+11.7		+13.7
12.8	+11.8		+13.8
12.9	+11.9		+13.9
13	+12		+14
14	 +13		+15
15	+14		+16
16	+15		+17
17	+16		+18
18	+17		+19
19	+18		+20
20	+19		+21
21	+20		+22
22	+21		+23
23	+22		+24
20			,

Table 7-6 ALC linearity at 500 MHz

,,,				
RF level (dBm)	RF level min. (dBm)	Result (dBm) arc A arc B	RF level max. (dBm)	
1		,		
-4	-4.8		-3.2	
-3	-3.8		-2.2	
-2	-2.8	_ 	-1.2	
-1	-1.8		0.2	
0	-0.8		+0.8	
1	0.2		+1.8	
2	+1.2		+2.8	
3	+2.2		+3.8	
[4	+3.2		+4.8	
5	+4.2		+5.8	
6	+5.2	_ 	+6.8	
7	+6	<u> </u>	+8	
8	+7		+9	
9	+8	<u> </u>	+10	
10	+9		+11	
11	+10		+12	
12	+11	<u> </u>	+13	
12.1	+11.1	<u> </u>	+13.1	
12.2	+11.2	<u> </u>	+13.2	
12.3	+11.3		+13.3	
12.4	+11.4		+13.4	
12.5	÷11.5		+13.5	
12.6	+11,6		+13.6	
12.7	+11.7		+13.7	
12.8	+11.8		+13.8	
12.9	+11.9		+13.9	
13	+12		+14	
14	+13		+15	
15	+14		+16	
16	+15		+17	
17	+16		+18	
18	+17		+19	
19	+18		+20	
20	+19		+21	
21	+20	· -	+22	
22	+21		+23	
23	+22		+24	
24	+23		+25	

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Table 7-7 ALC linearity at 2400 MHz

RF level (dBm)	RF tevel min. (dBm)	Result (dBm) src A src B	RF level max (dBm)
-4	-5.6		-2.4
-3	-4.6		-1.4
-2	-3.6		-0.4
-1	-2.6		+0.6
0	-1.6		+1.6
1	-0.6		+2.6
2	0.4		+3.6
3	+1.4		+4.6
4	+2.4		+5.6
5	+3.4		+6.6
6	+4.4		+7.6
7	+5		+9
8	+6		+10
9	+7		+11
10	+8		+12
11	+9		+13
12	+10		+14
12.1	+10.1		+14.1
12.2	+10.2		+14.2
12.3	+10.3		+14.3
12.4	+10.4		+14.4
12.5	+10.5		+14.5
12.6	+10.6		+14.6
12.7	+10.7		+14.7
12.8	+10.8		+14.8
12.9	+10.9		+14.9
13	+11		+15
14	+12		+16
15	+13		+17
16	+14		+18
17	+15		+19
18	+16		+20
19	+17	·	+21

Table 7-8 Attenuator test at 2.6 MHz

RF level (dBm)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
		<u>-</u>	
0	-0.8	<u> </u>	+0.8
-4.1	-4.9		-3.3
-15.1	-15.9	<u> </u>	-14.3
-26.1	-26.9		-25.3
-37.1	-37.9		-36.3
-48.1	-48.9		-47.3
-59.1	-59.9		-58.3
-70.1	-70.9		-69.3
-81.1	-81.9		-80.3
-9 2.1	-92.9		-91.3
-103.1	-103.9		-102.3
	<u> </u>		<u> </u>

Table 7-9 Attenuator test at 540 MHz

RF level (dBm)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
·· ··-			
0	-0.8		+0.8
-4.1	-4.9		-3.3
-15.1	-15.9		-14.3
-26.1	-26.9		-25.3
-37.1	-37.9		-36.3
-48.1	-48.9		-47.3
-59.1	-59.9		-58.3
-70.1	-70.9		-69.3
-81.1	-81.9		-80.3
-92.1	-92.9		-91.3
-103.1	-103.9		-102.3

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Table 7-10 Attenuator test at 1140 MHz

RF level (dBm)	RF ieve! min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
o	-0.8		+0.8
-4.1	-4.9		-3.3
-15.1	-15.9		-14.3
-26.1	-26.9		-25.3
-37.1	-37.9		-36.3
-48.1	-48.9		-47.3
-59.1	-59.9		-58.3
-70.1	-70.9		-69.3
-81.1	-81.9		-80.3
-92.1	-92.9	<u> </u>	-91.3
-103.1	-103.9	!	-102.3
		·	İ

Table 7-11 Attenuator test at 1740 MHz

AF level (dBm)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)	
o	-1.6	<u> </u>	+1.6	
-4,1	-5.7		-2.5	
-15.1	-16.7	<u> </u>	-13.5	
-26.1	-27.7		-24.5	
-37.1	-38.7		-35.5	
- 48.1	-49.7		-46.5	
- 59.1	-60.7		-57.5	
- 70.1	-71.7		-68.5	
-81.1	-82.7		-79.5	
-92,1	-93.7		-90.5	
-103.1	-104.7		-101.5	
			<u> </u>	

Table 7-12 Attenuator test at 2400 MHz

RF level (dBm)	RF level min. (dBm)	Result (dBm) RF level max src A src B (dBm)		
0	-1.6	<u> </u>	+1.6	
-4.1	-5.7		-2.5	
-15.1	-16.7		∙13.5	
-26.1	-27.7		-24.5	
-37.1	-38.7	l	-35.5	
-48.1	-49.7	<u> </u>	-46.5	
-59.1	-60.7	<u> </u>	-57.5	
-70.1	-71.7		-68.5	
-81.1	-82.7		-79.5	
-92.1	-93.7		-90.5	
-103.1	-104.7		-101.5	
			<u></u>	

Table 7-13 Alternative attenuator functional test at 10 MHz

Attenuator pad	Measured value (dB) src A src B
33 dB	
22 dB	
33 dB	l <u> </u>
11 dB	
33 dB	
)	

Table 7-14 CONNECTION TO RADIO output at -20 dBm

Carrier frequency	RF level min.	Result (di	RF level max.	
(MHz)	(dBm)	source A	source B	(dBm)
86 5	-20.75			-19.25
880	-20.75	<u> </u>		-19,25
895	-20.75			-19.25
1930	-20.75	 _		-19.25
1960	-20.75		<u></u>	-19.25
1990	-20.75			-19.25
			İ	

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Table 7-15 CONNECTION TO RADIO output at -35 dBm

Carrier frequency	RF level min.	Result (dB	RF level max. (dBm)	
(MHz)	(dBm)	source A	source 8	(08111)
865	-35.75			-34.25
880	-35.75			~34.25
895	-35.75			-34.25
1930	-35.75			-34.25
1960	-35.75			-34.25
1990	-35.75	1		-34.25
		,		1

Table 7-16 CONNECTION TO RADIO output at +0 dBm

Frequency	BAND 1		BAND 2			
	865 MHz	880 MHz	895 MHz	1930 MHz	1960 MHz	1990 MHz
Source A output level (inc. cable)						
CONNECTION TO RADIO output level						
Path loss						-
Average path loss			IF			

Table 7-17 Carrier frequency tests

Frequency (MHz)	Frequency min. (MHz)	Result (MHz) src A src B	Frequency max. (MHz)
0.01	-		-
1	·		-
9.99999	-		-
18.75			-
37.5	-		-
75	- 1		-
150	j -		-
300	.		
600	-		-
1200	1199.999988		1200.000012
1200.000001			
1230	i - i		-
1250	-		_
1260			-
1320	-		
1350	_		-
1500			_
1599,999999	1 - 1		-
2400] .]		_

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Table 7-18 Carrier harmonic tests at -4 dBm

Carrier frequency (MHz)	2nd harmonic max. level (dBc)	Result (dBc) src A src B	3rd harmonic max. level (dBc)	Result (dBc) src A src B
		······································		
0.01	-30		-30	<u> </u>
0.1	-30		-30	
1	-30		-30	
9.9	-30		-30	
10	-30		-30	
18.7	-30		-30	<u>.</u>
18.8	-30		-30	_ _
37.4	-30		-30	
37.6	-30		-30	
74.9	-30		-30	
75.1	-30		-30	_
150	-30		-30	
151	-30		-30	
300	-30		-30	
301	-30		-30	
600	-30		-30	
601	-30		-30	
750	-30		-30	
950	-30		-30	
1200	-30		-30	i
1201	-30		-30	
1500	-30		-30	
1900	-30		-30	
2400	-30		-30	

Table 7-19 Carrier harmonic tests at 0 dBm

Carrier frequency (MHz)	2nd harmonic max. level (dBc)	Result (dBc) src A src B	3rd harmonic max, level (dBc)	Result (dBc) src A src B
0.01	-30		-30	
0.1	-30	 - 	-30	
1	-30		-30	
9.9	-30		-30	
10	-30		-30	
18.7	-30		-30	
18.8	-30	_ _	-30	
37.4	-30		-30	_
37.6	-30		-30	 _
74.9	-30		-30	
75.1	-30		-30	
150	-30		-30	
151	-30		-30	
300	-30		-30	
301	-30	_ 	-30	
600	-30		-30	
601	-30		-30	
750	-30		+30	
950	-30		-30	
1200	-30		-30	
			-30	
1201	-30			
1500	-30		-30	 -
1900	-30		-30	
2400	-30		-30	

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Table 7-20 Carrier harmonic tests at +7 dBm

Carrier frequency (MHz)	2nd harmonic max. level (dBc)	Result (dBc) src A src B	3rd harmonic max. level (dBc)	Result (dBc) src A src B
		<u> </u>		···
0.01	-25		-25	
0.1	-25		-25	 - -
1	-25		-25	
9.9	-25		-25	
10	-25		-25	
18.7	-25		-25	
18.8	-25		-25	
37.4	-25		-25	
37.6	-25		-25	
74.9	-25		-25	
75.1	-25		-25	
150	-25		-25	
151	-25		-25	
300	-25		-25	
301	-25		-25	
600	-25		-25	i
601	-25		-25	
750	-25		-25	
950	-25		-25	
1200	-25		-25	
1201	-25		-25	
1500	-25		-25	
1900	-25	_ _	-25	
2400	-25		-25	

Table 7-21 Carrier harmonic tests at +18 dBm

Carrier frequency (MHz)	2nd harmonic max. level (dBc)	Result (dBc) src A src B	3rd harmonic max. level (dBc)	Result (dBc) src A src B
0.01	-25		-25	. — —
0.1	-25		-25	
1	-25		-25	·
9.9	-25		-25	
10	-25		-25	
18.7	-25		-25	
18.8	-25		-25	
37.4	-25		-25	
37.6	-25		-25	
74.9	-25		-25	
75.1	-25		-25	
150	-25		-25	
151	-25		-25	
300	-25		-25	
301	-25		-25	
600	-25		-25	
601	-25		-25	_ _
750	-25		-25	
950	-25		-25	
1200	-25		-25	
	<u> </u>	·	<u></u>	
		+13 dBm		
1201	-25		-25	
1500	-25		-25	<u></u>
1900	-25		-25	!
2400	-25		-25	
			[•

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Table 7-22 Carrier non-harmonic tests

	Sub-harmonic output			Sul	o-harmonic c	utput
Carrier frequency (MHz)	Non- harmonic frequency (MHz)	Non- harmonic level (dBc)	Result (dBc) src A src B	Non- harmonic frequency (MHz)	Non- harmonic level (dBc)	Result (dBc) src A src B
1201	800.6667	-64		1601.3333	-64	
1201	400.3333	-64		2001.6667	-64	
1599	1066	-64		2132	-64	!
1599	533	-64		2665	-64	
1601	1200.75	-64		2001.25	-64	
1601	800.5	-64		2401.5	-64	
1999	1499.25	-64		2498.75	-64	
1999	999.5	-64		2998.5	-64	
2001	1600.8	-60		2401.2	-60	
2001	1200.6	-60		2801.4	-60	<u> </u>
2400	1920	-60		2880	-60	
2400	1440	-60		3360	-60	
9.9	100.000032	-70		109.900036	-70	-

Table 7-23 Residual FM test

Carrier frequency	Residual FM	Measured value (Hz RMS) src A src B
1 GHz	<4.5 Hz RMS	

Table 7-24 SSB phase noise test

Carrier frequency	SSB phase noise at 20 kHz offset	Measured value (dBc Hz) src A src B
470 MHz	<-124 dBc/Hz	

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Table 7-25 RF leakage test

Carrier frequency (MHz)	RF leakage	Measured value (dBm) arc A arc B
469	<0.5 μV	<u> </u>
929	<0.5 μV	<u> </u>
1349	<0.5 μV	
2399	<0.5 μV	
		<u> </u>

Table 7-26 Sources A/B intermod test

RF level	Source A frequency	Source B frequency	Spacing	Lower IP frequency	Upper IP frequency	Max. IP level	Result	(dBc)
(dBm)	(MHz)	(MHz)	(kHz)	(MHz)	(MHz)	(dBc)	Upper	Lower
-14	880,000	880.007	7	879.993	880.014	-75		
-14	1960.000	1960.007	7	1959.993	1960.014	-75		

Table 7-27 Isolation tests

Frequency (MHz)	Isolation level (dBm)	Src B	Src A
800	-60		i —
1200	-60		İ —
1600	-60		

Table 7-28 Internal FM deviation and distortion tests at 100 kHz deviation

	FM Deviation			1	Distortion
Carrier frequency (MHz)	FM deviation min. (kHz)	Result (kHz) src A src B	FM deviation max. (kHz)	Distortion (%)	Result (%) src A src B
10	95		105	<3%	
10.144	95		105	<3%	
10.292	95		105	<3%	
10.441	95		105	<3%	
10.592	95		105	<3%	
10.746	95		105	<3%	
10.901	95		105	<3%	
11.059	95		105	<3%	
11.22	95		105	<3%	
11.382	95		105	<3%	
11.547	95		105	<3%	
11.714	95		105	<3%	
11.884	95		105	<3%	
12.056	95		105	<3%	
12.23	95		105	<3%	
12.5	95		105	<3%	
12.587	95		105	<3%	
12.77	95		105	<3%	
12.995	95		105	<3%	
13.143	95		105	<3%	
13.333	95		105	<3%	

Table 7-29 FM scale shape tests at 15 MHz carrier

ភាin. (kHz)	Result (kHz) src A src B	FM deviation max. (kHz)
	-	
95		105
67.45		74.55
53.2		58.8
41.8		46.2
32.3		35.7
25.65		28.35
19.95		22.05
15.2		16.8
12.35		13.65
10.45		11.55
9.5		10.5
0.95		1.05
0.095		0.105
	67.45 53.2 41.8 32.3 25.65 19.95 15.2 12.35 10.45 9.5	67.45 53.2 41.8 32.3 25.65 19.95 15.2 12.35 10.45 9.5 0.95

Table 7-30 Carrier error test at 1.2 GHz, FM deviation 100 kHz

Carrier error	Result (kHz) src A src B
<1 k Hz	

Table 7-31 External FM frequency response (ALC off, DC coupled), 50 kHz deviation

Modulation frequency (kHz)	Response level min. (dB)	Result (dB) src A src B	Response level max. (dB)	Distortion (%)	Result (%) src A src B
0	-1		+1	} <u> </u>	•
0.03	-1		+1	.	•
0.1	-1		+1	<3	
0.3	-1		+1	.	-
1	•	reference	-	<3	
3	-1		+1	' -	-
5	-1		+1	<3	
10	-1		+1	i -	-
20	-1		+1	<3	
50	-1		+1	.	•
100	-1		+1	. !	•
ļ				! .	

Table 7-32 External FM frequency response (ALC on), 10 kHz deviation, 0.75 V input

Modulation frequency (kHz)	Response level min. (dB)	Result (dB) arc A arc B	Response level max. (dB)
0.02	-1		+1
0.1	-1		∔1
0.3	-1		+1
1	- 1	reterence	_
3	-1	<u> </u>	+1
10	-1		+1
30	-1		+1
100	-1		+1

Table 7-33 External FM frequency response (ALC on), 10 kHz deviation, 1.25 V input

Modulation frequency (kHz)	Response level min. (dB)	Result (dB) src A src B	Response level max. (dB)	Distortion (%)	Result (%) src A src B
	, 1				
0.02	-1		+1		•
0.1	-1		+1	<3	
0.3	-1		+1		-
1	-	reference		<3	
3	-1		+1	- 1	-
5	-1		+1	<3	
10	-1		+1	-	-
20	-1		+1	<3	
30	-1		+1	-	•
100	-1		+1	- !	
	·	··			

Table 7-34 Internal ΦM and distortion test at 10.5 MHz carrier, 10 rad deviation

	ΦM deviation	Distortion		
ΦM deviation min. (rad)	Result (rad) src A src B	ФМ deviation max. (rad)	Distortion (%)	Result (%) src A src B
9.5		10.5	<3%	

Table 7-35 Internal ΦM flatness test

Modulation frequency (kHz)	Response level min. (dB)	Result (dB) src A src B	Response level max. (dB)
0.1	-3		+3
0.3	-3		+3
1 1	-	reference	-
3	-3		+3
10	-3		+3
	_		

Table 7-36 Internal AM depth and distortion tests at -4 dBm

		AM depth 30%			AM depth 80%		Distortion	
Carr. freq. min. (MHz) (%)	Result (%) src A src B	max (%)	min. (%)	Result (%) src A src B	max (%)	Result at 30% depth (<1.5%) src A src B	Result at 80% depth (<2.5%) arc A src B	
1,5	28.5		31.5	76		84		
5	28.5		31.5	76		84	_ 	·
9	28.5		31.5	76		84		
11	28.5		31.5	76		84		
20	28.5	- 	31.5	76		84		
50	28.5		31.5	76		84		
100	28.5		31.5	76		84		
200	28.5		31.5	76		84		
500	28.5		31.5	76		84		
300	20.5		31.3	, 3				

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Table 7-37 Internal AM depth and distortion tests at 0 dBm

	AM depth 30%				AM depth 80%	i	Distortion	
	min. (%)	Result (%) src A src B	max. (%)	min. (%)	Result (%) src A src B	max. (%)	Result at 30% depth (<1.5%) src A src B	Result at 80% depth (<2.5%) src A src B
1.5	28.5	i	31.5	76		84		
				[]		1 -		
5	28.5		31.5	76		84		l
9	28.5		31.5	76		84		
11	28.5		31.5	76		84		
20	28.5		31.5	76		84		
50	28.5		31.5	76		84		l
100	28.5		31.5	76		84		
200	28.5		31.5	76		84		
500	28.5		31.5	76		84		
500	26.5		31.3	("		64		

Table 7-38 Internal AM depth and distortion tests at +7 dBm

, ,							Distortion	
(min. (%)	Result (%) src A src B	max. (%)	min. (%)	Result (%) src A src B	max. (%)	Result at 30% depth (<1.5%) arc A arc B	Result at 80% depth (<2.5%) src A src B
1,5 28	8.5		31.5	76		84		
1	8.5		31.5	76			<u> </u>	
	· ·		-	1 1		84		
9 28	28.5		31.5	76		84		
11 28	8.5		31,5	76		84		l _ _
20 28	8.5		31.5	76		84		
50 28	8.5		31.5	76		84		
100 28	8.5		31.5	76		84		l
200 28	8.5		31.5	76		84		
· '	8.5		31.5	76		84	_ 	
300 20	.0.5		5,.5	/		54		

Table 7-39 Internal AM depth and distortion tests at +14 dBm

		AM depth 30%			AM depth 80%		Distortion	
Carr. freq. (MHz)	ள்n. (%)	Result (%) src A src B	max. (%)	min. (%)	Result (%) src A src B	max. (%)	Result at 30% depth (<1.5%) arc A arc B	Result at 80% depth (<2.5%) arc A arc B
1.5	28.5		31.5	76		84		
5	28.5		31.5	76		84		
9	28.5		31.5	76		84		
11	28.5		31.5	76		84		
20	28.5		31.5	76		84		i — —
50	28.5		31.5	76		84		
100	28.5		31.5	76		84		<u> </u>
200	28.5		31.5	76		84	 . —	l — —
500	28.5		31.5	76		84		

Table 7-40 AM scale shape test

AM depth min. (%)	Result (%) src A src B	AM depth max. (%)
		1
9.5		10.5
19		21
28.5		31.5
38		42
47.5		52.5
57		63
66.5		73.5
76		84
80.75		89.25
	9.5 19 28.5 38 47.5 57 66.5	9.5

Table 7-41 External AM frequency response (ALC off, DC coupled), RF level -4 dBm

Modulation frequency (kHz)	Response leve! min. (dB)	Result (dB) src A src B	Response level max. (dB)
0	-1		+1
0.1 0.3	-1 -1		+1 +1
1 10	-1	reference	+1
20	-1		+1
30	-1		+1

Table 7-42 External AM frequency response (ALC off, DC coupled), RF level +6 dBm

Modulation frequency (kHz)	Response level min. (dB)	Result (dB) src A src B	Response level max. (dB)
_	_		
0	-1		+1
0.1	-1		+1
0.3	-1		+1
1 1	•	reference	-
10	-1		+1
20	-1		+1
30	-1		+1

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Table 7-43 Pulse mod. RF output at -7 dBm

Carrier frequency (MHz)	RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
		<u> </u>	
32	-8.3		+5.7
60	-8.3		+5.7
180	-8.3		+5.7
300	-8.3		+5.7
420	-8.3		+5.7
540	-8.3		+5.7
660	-8.3		+5.7
780	-8.3		+5.7
900	-8.3		+5.7
1020	-8.3		+5.7
1140	-8.3		+5.7
1200	-8.3		+5.7
1201	-9.1		+4.9
1260	-9.1		+4.9
1380	-9.1		44.9
1500	-9.1		+4.9
1620	-9.1	<u> </u>	+4.9
1740	-9.1		+4.9
1860	-9.1		+4.9
1980	-9.1		+4.9
2220	-9.1		+4.9
2340	-9.1		+4.9
2400	-9.1		+4.9

Table 7-44 Pulse mod. RF output at +4 dBm

RF level min. (dBm)	Result (dBm) src A src B	RF level max. (dBm)
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7	_ _	+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+2.7		+5.3
+1.9	_	+6.1
+1.9		+6.1
+1.9		+6.1
		+6.1
+1.9		+6.1
+1.9		+6.1
+1.9		+6.1
+1.9		+6.1
÷1.9		+6.1
+1.9		+6.1
+1.9		+6.1
	+2.7 +2.7 +2.7 +2.7 +2.7 +2.7 +2.7 +2.7	(dBm) src A src B +2.7

Table 7-45 Pulse modulation on/off ratio test

Carrier frequency (MHz)	Pulse mod. on/off ratio (dB)	Measured value (dB) src A src B
32	>45	
100	>45	
320	>45	
1000	>45	
1200	>45	
1500	>40	
1800	>40	
2100	>40	
2400	>40	<u> </u>

Table 7-46 Pulse modulation rise and fall time test

		Result (µs) src A src B
Rise time Fall time	×40 بد عبر 10>	

Table 7-47 Modulation oscillator frequency tests

Frequency (Hz)	Result (Hz) src A src B
10	
100	
1000	
20000	

Table 7-48 Modulation oscillator distortion and LF output tests

Mod. oscillator frequency (Hz)	Response level min. (dB)	Result src A src B	Response level max. (dB)	Distortion (%)	Result (%)
10	-1		+1	•	-
20	-1		+1	-	-
50	-1		+1	-	•
100	-1		+1	-	•
200	-1		+1	-	-
500	-1		+1	-	-
1000	-1	reference	- 	<0.1%	
2000	-1		+1	-	-
5000	-1		+1	. !	-
10000	-1		+1	-	•
20000	-1		+1	-	-

Table 7-49 External frequency standard tests

External signal	Locked [✓]	
1 MHz. 220 mV	[]	
1 MHz, 1.8 V	()	
10 MHz, 220 mV	[]	
10 MHz, 1.8 V	[]	

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